



## FM0+ S6E1C Series Microcontroller Datasheet

### 40 MHz ARM Cortex-M0+ MCU with 35 $\mu$ A/CoreMark Score

The FM0+ family of Flexible Microcontrollers is the industry's most energy-efficient 32-bit ARM<sup>®</sup> Cortex<sup>®</sup>-M0+ based MCUs. This family of MCUs is designed for ultra-low-power and cost-sensitive applications such as white goods, sensors, meters, HMI systems, power tools and Internet of Things (IoT) battery-powered or wearable devices.

This family of ultra-low-power MCUs features an industry-leading 35  $\mu$ A/CoreMark<sup>®</sup> score and 40 $\mu$ A/MHz Active Power consumption.

The S6E1C Series is a series of highly integrated 32-bit microcontrollers designed for embedded controllers aiming at low power consumption and low cost. This series has the ARM Cortex-M0+ Processor with on-chip Flash memory and SRAM, and consists of peripheral functions such as various timers, ADC and communication interfaces (UART, CSIO (SPI), I<sup>2</sup>C, I<sup>2</sup>S, Smart Card, and USB). The products which are described in this data sheet are placed into TYPE3-M0+ product categories in "FM0+ Family Peripheral Manual".

## Features

### Ultra Low Power MCU Subsystem

- 40 MHz ARM Cortex-M0+ CPU with 1.65 V to 3.6 V operating voltage
- Maximum operating frequency: 40.8 MHz
- Nested Vectored Interrupt Controller (NVIC): 1 non-maskable interrupt (NMI) and 24 peripheral interrupt with 4 selectable interrupt priority levels
- 24-bit System timer (Sys Tick): System timer for OS task management
- Up to 128 KB Flash, 16 KB SRAM
- Descriptor System Transfer Controller (DSTC)
- Industry's most efficient 35  $\mu$ A/CoreMark Score
- Ultra-low-power consumption: Active – 40  $\mu$ A/MHz and Standby – 0.6  $\mu$ A
- Fast wake-up from standby mode (execute from Flash): 20  $\mu$ s (Typ)

### Digital Subsystem

- Up to 8x Base Timers
- 1x Dual Timer, 1x Watch Counter
- Up to 6x Multi-Function Serial (MFS) interfaces configurable as SPI, UART, I<sup>2</sup>C
- 1x USB, 1x I<sup>2</sup>S, up to 2x HDMI-CEC, up to 1x Smart Card interfaces

### Analog Subsystem

- 1x 12-bit, 1-Msps ADCs with an 8-channel multiplexer input
- 1% high precision internal oscillator

### Package Options

- 32-/48-/64-pin LQFP
- 32-/48-/64-pin QFN

### Low-Power Consumption Modes

- This series has six low-power consumption modes:
  - Sleep
  - Timer
  - RTC
  - Stop
  - Deep standby RTC (selectable between keeping the value of RAM and not)
  - Deep standby Stop (selectable between keeping the value of RAM and not)

### Ecosystem for Cypress FM0+ MCUs

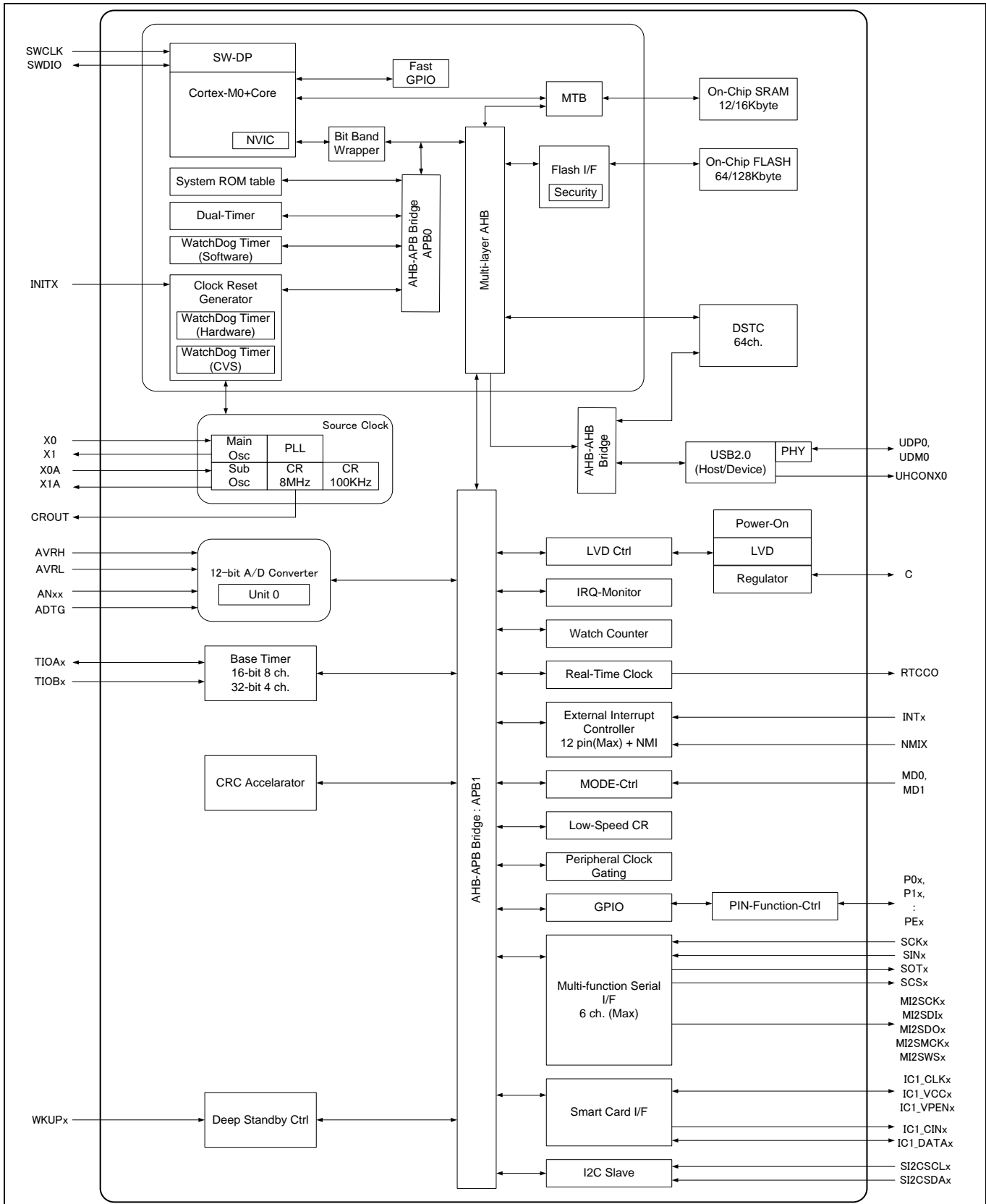
Cypress provides a wealth of data at [www.cypress.com](http://www.cypress.com) to help you to select the right MCU for your design, and to help you to quickly and effectively integrate the device into your design. Following is an abbreviated list for FM0+ MCUs:

- Overview: [Product Portfolio](#), [Product Roadmap](#)
- Product Selectors: [FM0+ MCUs](#)
- Application notes: Cypress offers a large number of FM0+ application notes covering a broad range of topics, from basic to advanced level. Recommended application notes for getting started with FM0+ family of MCUs are:
  - [AN210985 – FM0+ Getting Started with FM0+ Development](#): AN210985 introduces you to the FM0+ family of 32-bit general-purpose microcontrollers. The FM0+ family is based on the ARM® Cortex®-M0+ processor core, ideal for ultra-low-power designs. This note provides an overview of hardware features and capabilities, firmware development, and the multitude of technical resources available to you. This application note uses the FM0+ S6E1B8-Series Starter Kit as an example.
  - [AN203277 - FM 32-Bit Microcontroller Family Hardware Design Considerations](#): This application note reviews several topics for designing a hardware system around FM0+, FM3, and FM4 family MCUs. Subjects include power system, reset, crystal, and other pin connections, and programming and debugging interfaces.
  - [AN205535 - FM0+ S6E100X Power Meter Demo Board](#) : This document covers the S6E100X power meter demo board solution and configuration. At the same time, the AN also provides source code for secondary development.
  - [AN205411 – FM0+ IEC60730 Class B Self-Test Library](#) : This document covers how to use and implement the library functions provided. It will first show the requirement of IEC60730 Class B, and then explain how it can be implemented. At last an example is given to show how to integrate test functions into a real system.
  - [AN202487 - Differences Among FM0+, FM3, and FM4 32-Bit Microcontrollers](#): Highlights the peripheral differences in Cypress's FM family MCUs. It provides dedicated sections for each peripheral and contains lists, tables, and descriptions of peripheral feature and register differences.
  - [AN204438 - How to Setup Flash Security for FM0+, FM3 and FM4 Families](#): This application note describes how to setup the Flash Security for FM0+, FM3, and FM4 devices
- Development kits:
  - [FM0-V48-S6E1A1 ARM® Cortex®-M0+ FM0+ MCU Evaluation Board](#)
  - [FM0-100L-S6E1B8 - ARM® Cortex®-M0+ MCU Starter Kit with USB and SD Card Interface](#)
  - [FM0-64L-S6E1C3 - ARM® Cortex®-M0+ MCU Starter Kit with USB and Digital Audio Interface](#)
- [Peripheral Manuals](#)

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# 1. Block Diagram



## 2. Product Lineup

### Memory Size

| Product name         | S6E1C11<br>S6E1C31 | S6E1C12<br>S6E1C32 |
|----------------------|--------------------|--------------------|
| On-chip Flash memory | 64 Kbytes          | 128 Kbytes         |
| On-chip SRAM         | 12 Kbytes          | 16 Kbytes          |

### Function

| Function Name                            | S6E1C1                  | S6E1C3        |
|--|-------------------------|---------------|
| CPU                                      | Cortex-M0+              |               |
| Frequency                                | 40.8 MHz                |               |
| Power supply voltage range               | 1.65 V to 3.6 V         |               |
| USB2.0 (Device/Host)                     |                         | 1 unit        |
| DSTC                                     | 64 ch.                  |               |
| Base Timer<br>(PWC/Reload timer/PWM/PPG) | 8 ch. (Max)             |               |
| Dual Timer                               | 1 unit                  |               |
| Real-time Clock                          | 1 unit                  |               |
| Watch Counter                            | 1 unit                  |               |
| CRC Accelerator                          | Yes                     |               |
| Watchdog timer                           | 1 ch. (SW) + 1 ch. (HW) |               |
| CSV (Clock Supervisor)                   | Yes                     |               |
| LVD (Low-voltage Detection)              | 2 ch.                   |               |
| Built-in CR                              | High-speed              | 8 MHz (Typ)   |
|  | Low-speed               | 100 kHz (Typ) |
| Debug Function                           | SW-DP                   |               |
| Unique ID                                | Yes                     |               |

**Note:**

- Because of package pin limitations, not all functions within the device can be brought out to external pins. You must carefully work out the pin allocation needed for your design. You must use the port relocate function of the I/O port according to your function use.
- See "11. Electrical Characteristics 11.4 AC Characteristics 11.4.3 Built-in CR Oscillation Characteristics" for accuracy of built-in CR.

**2.1 Package Dependent Features**

| Feature  | Package  |  |   |
|--|--|--|---|
|  | 32 LQFP<br>32 QFN  | 48 LQFP<br>48 QFN  | 64 LQFP<br>64 QFN   |
| Pin count  | 32   | 48   | 64  |
| Multi-function Serial Interface<br>(UART/CSIO/I <sup>2</sup> C/I <sup>2</sup> S) | 4 ch. (Max)<br>Ch.0/1/3 without<br>FIFO<br>Ch. 6 with FIFO | 6 ch. (Max)<br>Ch.0/1/3 without FIFO<br>Ch.4/6/7 with FIFO | 6 ch. (Max)<br>Ch.0/1/3 without<br>FIFO<br>Ch.4/6/7 with FIFO |
|  | I <sup>2</sup> S: No                                       | I <sup>2</sup> S: 1 ch (Max)<br>Ch. 6 with FIFO            | I <sup>2</sup> S: 2 ch (Max)<br>Ch. 4/6 with FIFO             |
| External Interrupt   | 7 pins (Max),<br>NMI x 1                                   | 9 pins (Max),<br>NMI x 1                                   | 12 pins (Max),<br>NMI x 1                                     |
| I/O port   | 24 pins (Max)  | 38 pins (Max)  | 54 pins (Max)   |
| 12-bit A/D converter   | 6 ch. (1 unit)   | 8 ch. (1 unit)   | 8 ch. (1 unit)  |
| I <sup>2</sup> C Slave   | No   |  | 1 ch (Max)  |
| Smart Card Interface   | No   |  | 1 ch (Max)  |
| HDMI-CEC/ Remote Control<br>Receiver   | 1 ch.(Max)<br>Ch.1   | 2 ch (Max)<br>Ch.0/1                                       |   |

**2.2 Packages**

| Package \ Package Suffix        | B0A | C0A | D0A |
|---------------------------------|-----|-----|-----|
| LQFP: LQB032 (0.80 mm pitch)    | ○   | -   | -   |
| QFN: WNU032 (0.50 mm pitch)     | ○   | -   | -   |
| LQFP: LQA048-02 (0.50 mm pitch) | -   | ○   | -   |
| QFN: WNY048 (0.50 mm pitch)     | -   | ○   | -   |
| LQFP: LQD064-02 (0.50 mm pitch) | -   | -   | ○   |
| QFN: WNS064 (0.50 mm pitch)     | -   | -   | ○   |

○: Available

**Note:**

- See "14. Package Dimensions" for detailed information on each package.

### 3. Product Features in Detail

#### 32-bit ARM Cortex-M0+ Core

- Maximum operating frequency: 40.8 MHz
- Nested Vectored Interrupt Controller (NVIC): 1 NMI (non-maskable interrupt) and 24 peripheral interrupt with 4 selectable interrupt priority levels
- 24-bit System timer (Sys Tick): System timer for OS task management

#### Bit Band Operation

Compatible with Cortex-M3 bit band operation.

#### On-Chip Memory

- Flash memory
  - Up to 128 Kbytes
  - Read cycle: 0 wait-cycle
  - Security function for code protection
- SRAM
 

The on-chip SRAM of this series has one independent SRAM.

  - Up to 16 Kbytes
  - 4Kbytes: can retain value in Deep standby Mode

#### USB Interface

USB interface is composed of Device and Host  
With Main PLL, USB clock can be generated by multiplication of Main clock.

- USB Device
  - USB 2.0 Full-Speed supported
  - Max 6 EndPoint supported
    - EndPoint 0 is control transfer
    - EndPoint 1, 2 can be selected Bulk-transfer, Interrupt-transfer or Isochronous-transfer
    - EndPoint 3 to 5 can select Bulk-transfer or Interrupt-transfer
    - EndPoint 1 to 5 comprise Double Buffer
    - The size of each EndPoint is according to the follows
    - EndPoint 0, 2 to 5 : 64 bytes
    - EndPoint 1 : 256 bytes
- USB host
  - USB 2.0 Full/Low-Speed supported
  - Bulk-transfer, Interrupt-transfer and Isochronous-transfer support
  - USB Device connected/disconnected automatically detect
  - IN/OUT token handshake packet automatically
  - Max 256-byte packet-length supported
  - Wake-up function supported

#### Multi-Function Serial Interface (Max 6channels)

- 3 channels with 64Byte FIFO (Ch.4, 6 and 7), 3 channels without FIFO (Ch.0, 1 and 3)
- The operation mode of each channel can be selected from one of the following.
  - UART
  - CSIO (CSIO is known to many customers as SPI)
  - I<sup>2</sup>C
- UART
  - Full duplex double buffer
  - Parity can be enabled or disabled.
  - Built-in dedicated baud rate generator
  - External clock available as a serial clock
  - Hardware Flow control\* : Automatically control the transmission by CTS/RTS (only ch.4)  
\* : S6E1C32B0A/S6E1C31B0A and S6E1C32C0A/S6E1C31C0A do not support Hardware Flow control.
  - Various error detection functions (parity errors, framing errors, and overrun errors)
- CSIO (also known as SPI)
  - Full duplex double buffer
  - Built-in dedicated baud rate generator
  - Overrun error detection function
  - Serial chip select function (ch1 and ch6 only)
  - Data length: 5 to 16 bits
- I<sup>2</sup>C
  - Standard-mode (Max: 100 kbps) supported / Fast-mode (Max 400 kbps) supported.
- I<sup>2</sup>S (MFS-I2S)
  - Using CSIO (Max 2 ch: ch.4, ch.6) and I<sup>2</sup>S clock generator
  - Supports two transfer protocol
    - I<sup>2</sup>S
    - MSB-justified
  - Master mode only

#### I<sup>2</sup>C Slave

- I<sup>2</sup>C Slave supports the slave function of I2C and wake-up function from Standby mode.

#### Descriptor System Data Transfer Controller (DSTC) (64 Channels)

- The DSTC can transfer data at high-speed without going via the CPU. The DSTC adopts the Descriptor system and, following the specified contents of the Descriptor that has already been constructed on the memory, can access directly the memory / peripheral device and performs the data transfer operation.
- It supports the software activation, the hardware activation, and the chain activation functions

## A/D Converter (Max: 8 Channels)

- 12-bit A/D Converter
  - Successive approximation type
  - Conversion time: 2.0  $\mu$ s @ 2.7 V to 3.6 V
  - Priority conversion available (2 levels of priority)
  - Scan conversion mode
  - Built-in FIFO for conversion data storage (for scan conversion: 16 steps, for priority conversion: 4 steps)

## Base Timer (Max: 8 Channels)

The operation mode of each channel can be selected from one of the following.

- 16-bit PWM timer
- 16-bit PPG timer
- 16/32-bit reload timer
- 16/32-bit PWC timer

## General-Purpose I/O Port

This series can use its pin as a general-purpose I/O port when it is not used for an external bus or a peripheral function. All ports can be set to fast general-purpose I/O ports or slow general-purpose I/O ports. In addition, this series has a port relocate function that can set to which I/O port a peripheral function can be allocated.

- All ports are Fast GPIO which can be accessed by 1 cycle
- Capable of controlling the pull-up of each pin
- Capable of reading pin level directly
- Port relocate function
- Up to 54 fast general-purpose I/O ports @64-pin package
- Certain ports are 5 V tolerant.  
See 5.List of Pin Functions and 6.I/O Circuit Type for the corresponding pins.

## Dual Timer (32-/16-bit Down Counter)

The Dual Timer consists of two programmable 32-/16-bit down counters. The operation mode of each timer channel can be selected from one of the following.

- Free-running mode
- Periodic mode (= Reload mode)
- One-shot mode

## Real-Time Clock

The Real-time Clock counts year/month/day/hour/minute/second/day of the week from year 00 to year 99.

- The RTC can generate an interrupt at a specific time (year/month/day/hour/minute/second/day of the week) and can also generate an interrupt in a specific year, in a specific month, on a specific day, at a specific hour or at a specific minute.
- It has a timer interrupt function generating an interrupt upon a specific time or at specific intervals.
- It can keep counting while rewriting the time.

- It can count leap years automatically.

## Watch Counter

The Watch Counter wakes up the microcontroller from the low power consumption mode. The clock source can be selected from the main clock, the sub clock, the built-in high-speed CR clock or the built-in low-speed CR clock.

Interval timer: up to 64 s (sub clock: 32.768 kHz)

## External Interrupt Controller Unit

- Up to 12 external interrupt input pins
- Non-maskable interrupt (NMI) input pin: 1

## Watchdog Timer (2 Channels)

The watchdog timer generates an interrupt or a reset when the counter reaches a time-out value.

This series consists of two different watchdogs, hardware watchdog and software watchdog.

The hardware watchdog timer is clocked by the built-in low-speed CR oscillator. Therefore, the hardware watchdog is active in any low-power consumption modes except RTC, Stop, Deep standby RTC and Deep standby Stop mode.

## CRC (Cyclic Redundancy Check) Accelerator

The CRC accelerator calculates the CRC which has a heavy software processing load, and achieves a reduction of the integrity check processing load for reception data and storage.

- CCITT CRC16 and IEEE-802.3 CRC32 are supported.
  - CCITT CRC16 Generator Polynomial: 0x1021
  - IEEE-802.3 CRC32 Generator Polynomial: 0x04C11DB7

## HDMI-CEC/Remote Control Receiver (Up to 2 Channels)

- HDMI-CEC transmitter
  - Header block automatic transmission by judging Signal free
  - Generating status interrupt by detecting Arbitration lost
  - Generating START, EOM, ACK automatically to output CEC transmission by setting 1 byte data
  - Generating transmission status interrupt when transmitting 1 block (1 byte data and EOM/ACK)
- HDMI-CEC receiver
  - Automatic ACK reply function available
  - Line error detection function available

## Remote control receiver

- 4 bytes reception buffer
- Repeat code detection function available

## Smart Card Interface (Max 1 Channel)

- Compliant with ISO7816-3 specification

## Card Reader only/B class card only

- Available protocols
  - Transmitter: 8E2, 8O2, 8N2
  - Receiver: 8E1, 8O1, 8N2, 8N1, 9N1
  - Inverse mode

- TX/RX FIFO integrated (RX: 16-bytes, TX:16-bytes)



## Clock and Reset

### ■ Clocks

A clock can be selected from five clock sources (two external oscillators, two built-in CR oscillator, and main PLL).

- Main clock: 8 MHz to 48 MHz
- Sub clock: 32.768 kHz
- Built-in high-speed CR clock: 8 MHz
- Built-in low-speed CR clock: 100 kHz
- Main PLL clock 8MHz to 16MHz (Input), 75MHz to 150MHz (Output)

### ■ Resets

- Reset request from the INITX pin
- Power on reset
- Software reset
- Watchdog timer reset
- Low-voltage detection reset
- Clock supervisor reset

## Clock Supervisor (CSV)

The Clock Supervisor monitors the failure of external clocks with a clock generated by a built-in CR oscillator.

- If an external clock failure (clock stop) is detected, a reset is asserted.
- If an external frequency anomaly is detected, an interrupt or a reset is asserted.

## Low-Voltage Detector (LVD)

This series monitors the voltage on the VCC pin with a 2-stage mechanism. When the voltage falls below a designated voltage, the Low-voltage Detector generates an interrupt or a reset.

- LVD1: monitor  $V_{CC}$  and error reporting via an interrupt
- LVD2: auto-reset operation

## Low Power Consumption Mode

This series has six low power consumption modes.

- Sleep
- Timer
- RTC
- Stop
- Deep standby RTC (selectable between keeping the value of RAM and not)
- Deep standby Stop (selectable between keeping the value of RAM and not)

## Peripheral Clock Gating

The system can reduce the current consumption of the total system with gating the operation clocks of peripheral functions not used.

## Debug

- Serial Wire Debug Port (SW-DP)
- Micro Trace Buffer (MTB)

## Unique ID

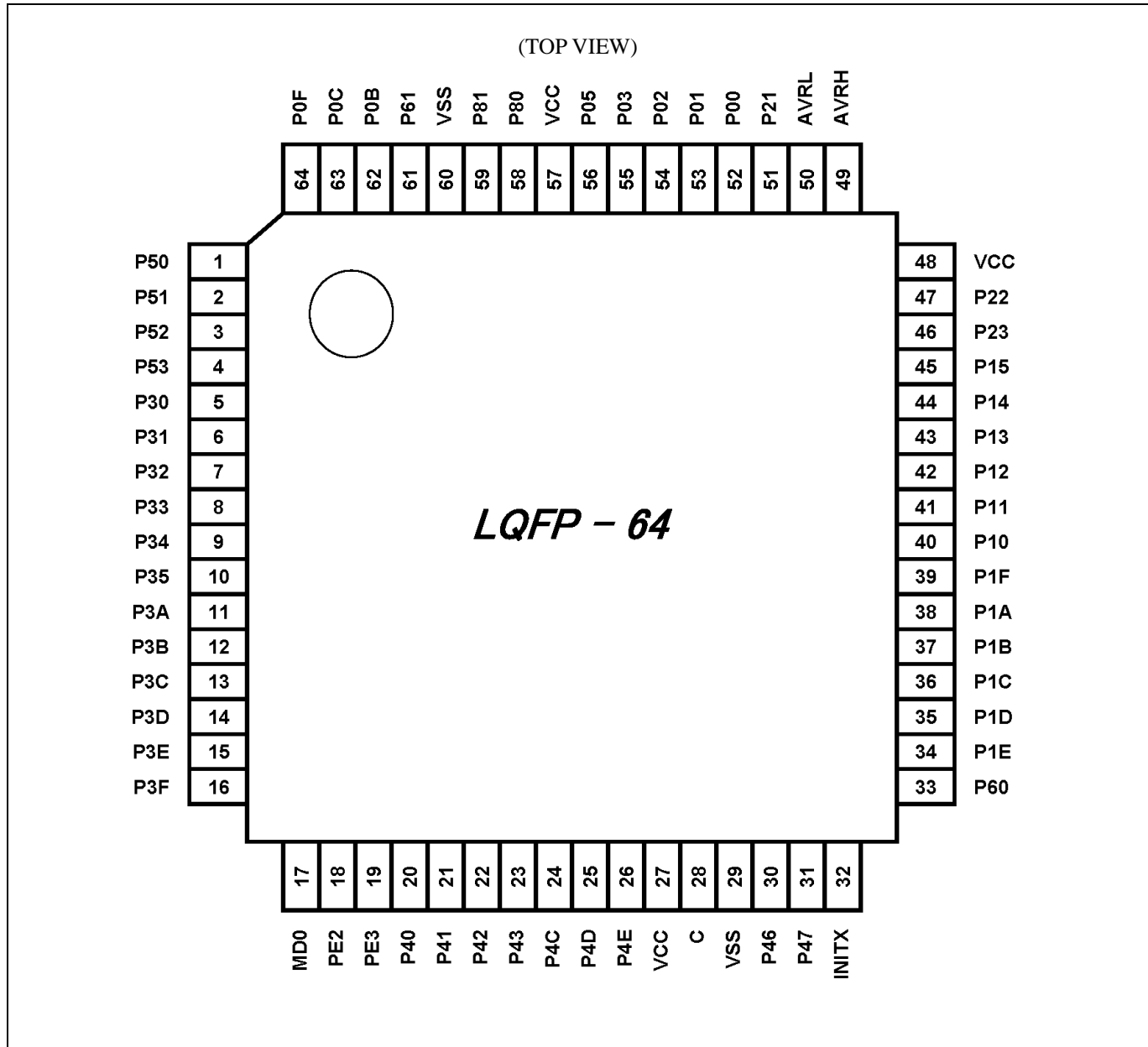
A 41-bit unique value of the device has been set.

## Power Supply

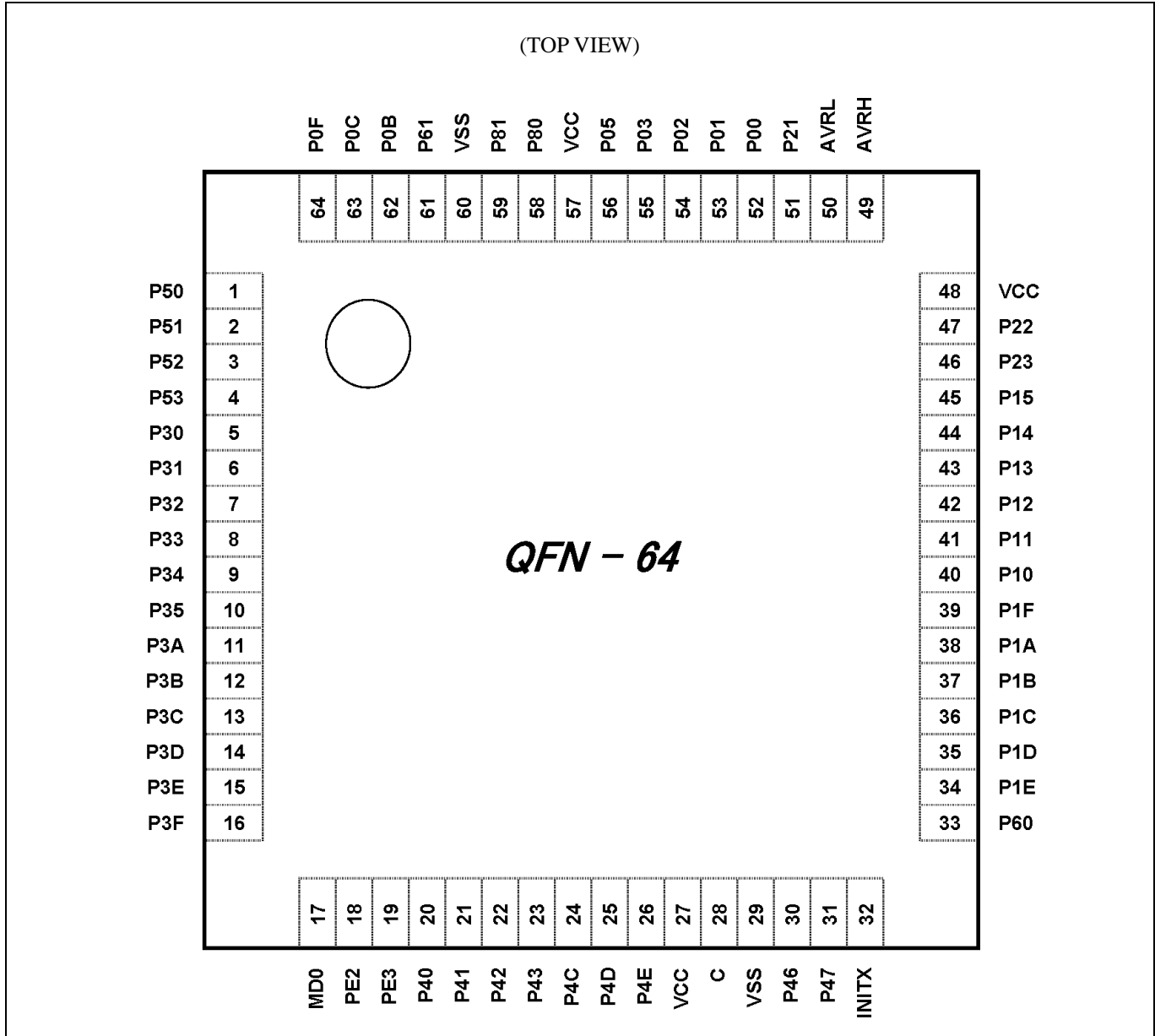
- Wide voltage range:
  - VCC = 1.65V to 3.6 V
  - VCC = 3.0V to 3.6V (when USB is used)

### 4. Pin Assignment

LQD064-02

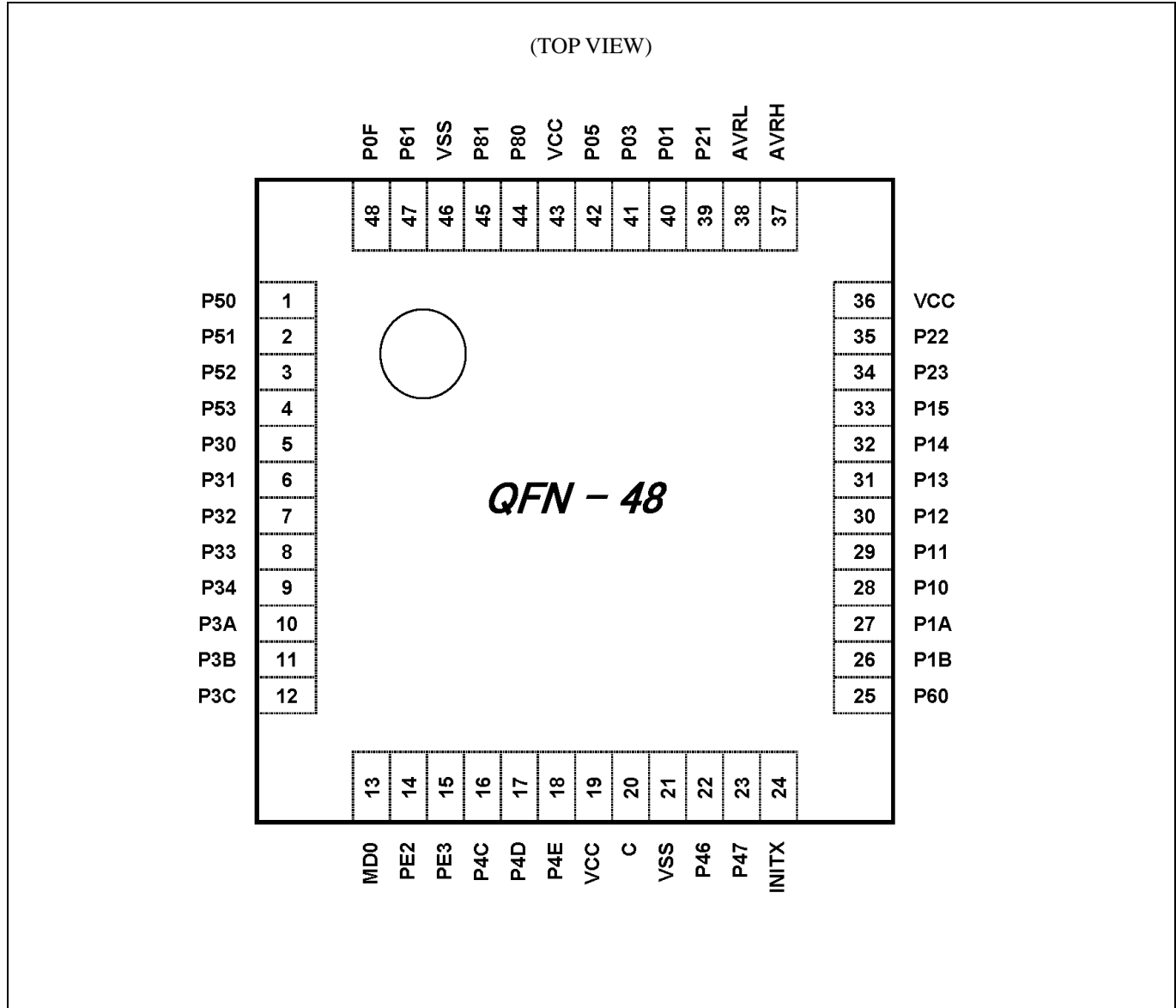


**WNS064**

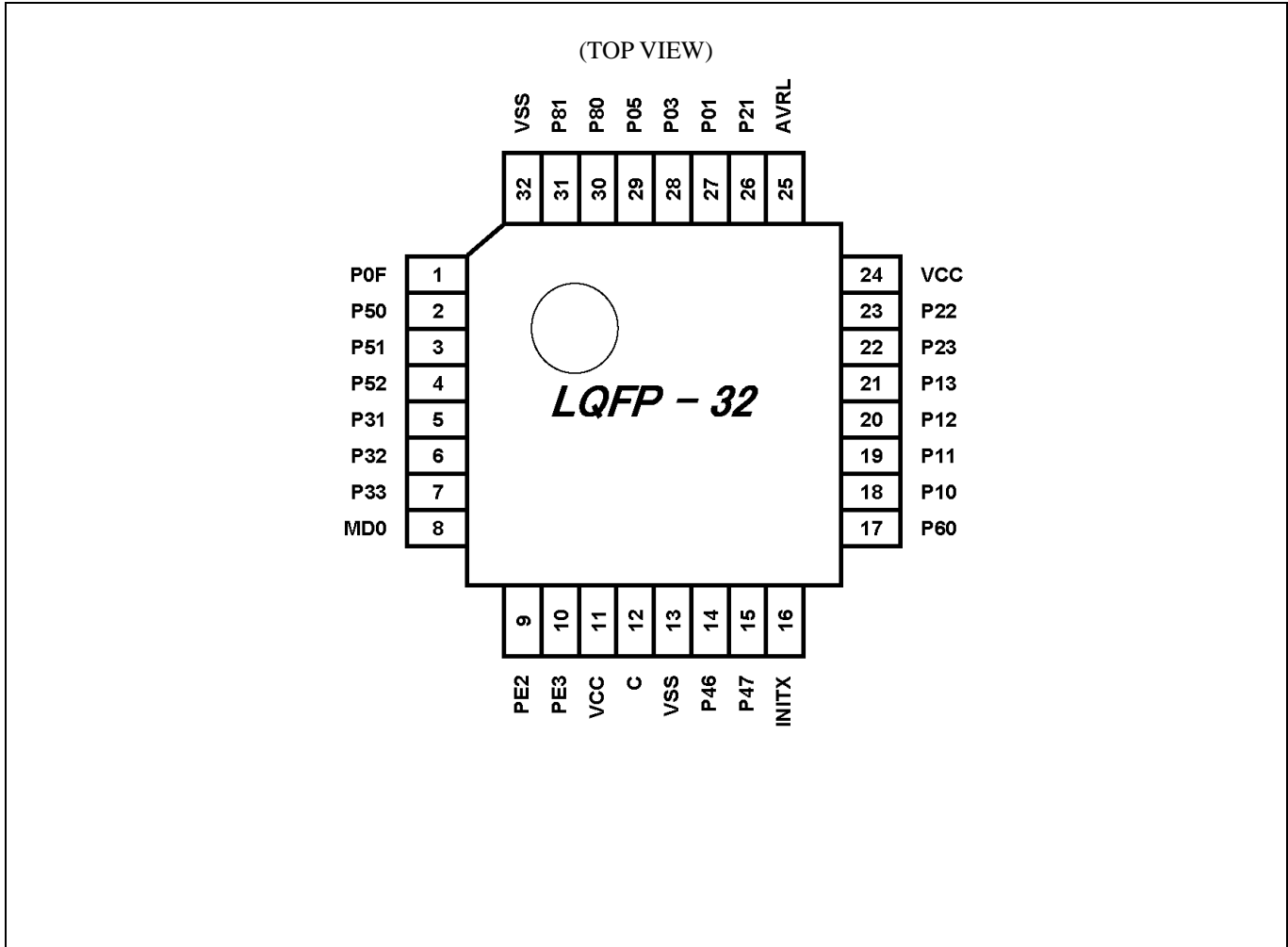




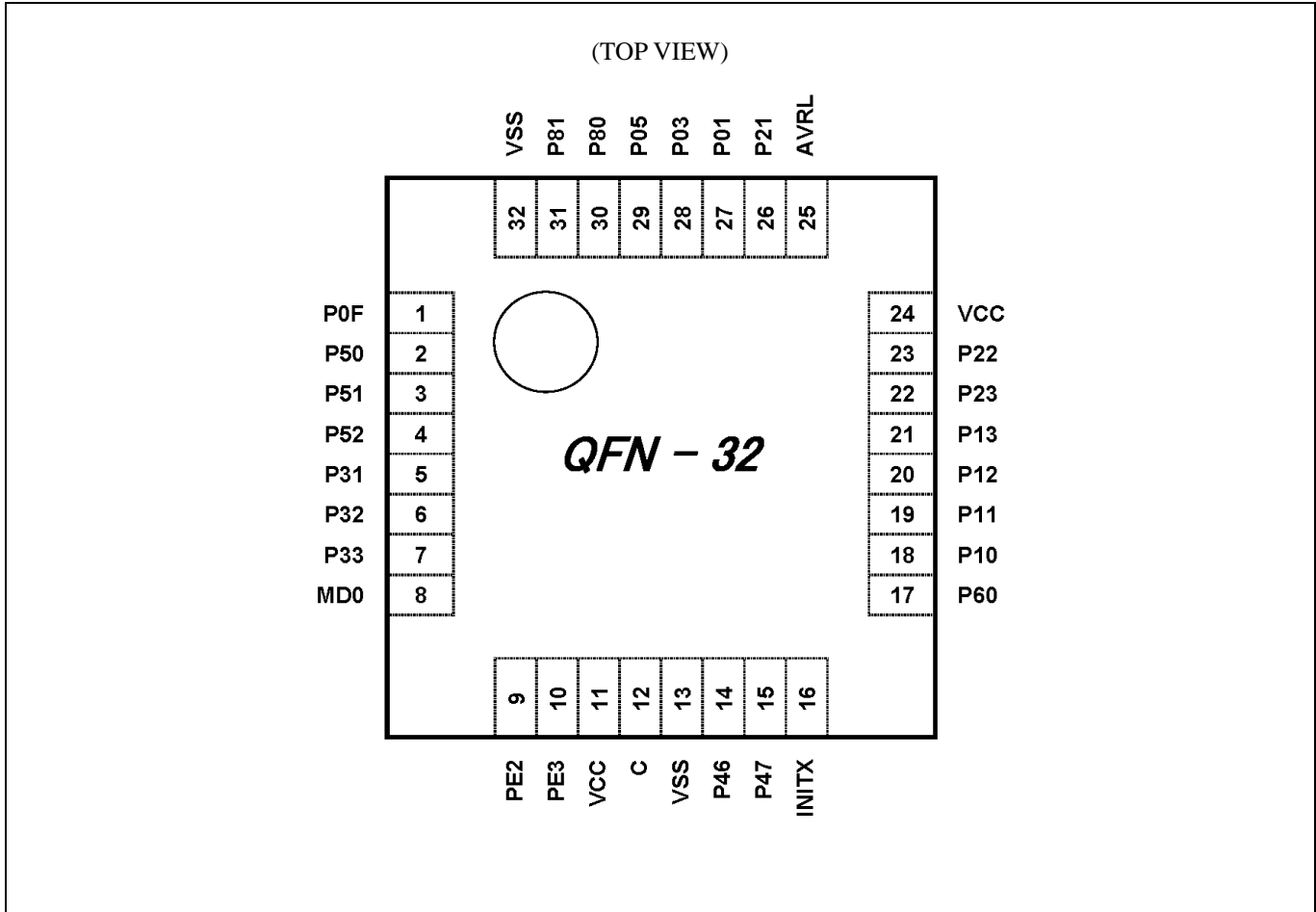
**WNY048**



**LQB032**



WNU032



## 5. List of Pin Functions

### List of Pin Numbers

The number after the underscore ("\_") in a pin name such as XXX\_1 and XXX\_2 indicates the relocated port number. The channel on such pin has multiple functions, each of which has its own pin name. Use the Extended Port Function Register (EPFR) to select the pin to be used.

| Pin No.        |                |                | Pin Name | Alternate Functions |            |            |           |           | I/O Circuit Type | Pin State Type |
|----------------|----------------|----------------|----------|---------------------|------------|------------|-----------|-----------|------------------|----------------|
| LQFP-64 QFN-64 | LQFP-48 QFN-48 | LQFP-32 QFN-32 |          |                     |            |            |           |           |                  |                |
| 1              | 1              | 2              | P50      | SIN3_1              | INT00_0    |            |           |           | D                | K              |
| 2              | 2              | 3              | P51      | SOT3_1              | INT01_0    |            |           |           | D                | K              |
| 3              | 3              | 4              | P52      | SCK3_1              | INT02_0    |            |           |           | D                | K              |
| 4              | 4              | -              | P53      | TIOA1_2             | INT07_2    |            |           |           | D                | K              |
| 5              | 5              | -              | P30      | SCS60_1             | TIOB0_1    | INT03_2    | MI2SWS6_1 |           | D                | K              |
| 6              | 6              | -              | P31      | SCK6_1              | SI2CSCL6_1 | INT04_2    | MI2SCK6_1 |           | H                | K              |
| -              | -              | 5              | P31      | SCK6_1              | SI2CSCL6_1 | INT04_2    |           |           | H                | K              |
| 7              | 7              | -              | P32      | SOT6_1              | SI2CSDA6_1 | TIOB2_1    | INT05_2   | MI2SDO6_1 | H                | K              |
| -              | -              | 6              | P32      | SOT6_1              | SI2CSDA6_1 | TIOB2_1    | INT05_2   |           | H                | K              |
| 8              | 8              | -              | P33      | ADTG_6              | SIN6_1     | INT04_0    | MI2SDI6_1 |           | H                | K              |
| -              | -              | 7              | P33      | ADTG_6              | SIN6_1     | INT04_0    |           |           | H                | K              |
| 9              | -              | -              | P34      | SCS61_1             | TIOB4_1    | MI2SMCK6_1 |           |           | D                | K              |
| -              | 9              | -              | P34      | SCS61_1             | MI2SMCK6_1 |            |           |           | D                | K              |
| 10             | -              | -              | P35      | SCS62_1             | TIOB5_1    | INT08_1    |           |           | D                | K              |
| 11             | -              | -              | P3A      | TIOA0_1             | INT03_0    | RTCCO_2    | SUBOUT_2  | IC1_CIN_0 | D                | K              |
| -              | 10             | -              | P3A      | TIOA0_1             | INT03_0    | RTCCO_2    | SUBOUT_2  |           | D                | K              |
| 12             | -              | -              | P3B      | TIOA1_1             | IC1_DATA_0 |            |           |           | D                | K              |
| -              | 11             | -              | P3B      | TIOA1_1             |            |            |           |           | D                | K              |
| 13             | -              | -              | P3C      | TIOA2_1             | IC1_RST_0  |            |           |           | D                | K              |
| -              | 12             | -              | P3C      | TIOA2_1             |            |            |           |           | D                | K              |
| 14             | -              | -              | P3D      | TIOA3_1             | IC1_VPEN_0 |            |           |           | D                | K              |
| 15             | -              | -              | P3E      | TIOA4_1             | IC1_VCC_0  |            |           |           | D                | K              |
| 16             | -              | -              | P3F      | TIOA5_1             | IC1_CLK_0  |            |           |           | D                | K              |
| 17             | 13             | 8              | MD0      |                     |            |            |           |           | I                | F              |
| 18             | 14             | 9              | PE2      | X0                  |            |            |           |           | A                | A              |
| 19             | 15             | 10             | PE3      | X1                  |            |            |           |           | A                | B              |
| 20             | -              | -              | P40      | TIOA0_0             | INT12_1    |            |           |           | D                | K              |
| 21             | -              | -              | P41      | TIOA1_0             | INT13_1    |            |           |           | D                | K              |
| 22             | -              | -              | P42      | TIOA2_0             |            |            |           |           | D                | K              |
| 23             | -              | -              | P43      | ADTG_7              | TIOA3_0    |            |           |           | D                | K              |
| 24             | -              | -              | P4C      | SCK7_1              | TIOB3_0    |            |           |           | D                | K              |
| -              | 16             | -              | P4C      | SCK7_1              |            |            |           |           | D                | K              |
| 25             | 17             | -              | P4D      | SOT7_1              |            |            |           |           | D                | K              |
| 26             | 18             | -              | P4E      | SIN7_1              | INT06_2    |            |           |           | D                | K              |
| 27             | 19             | 11             | VCC      |                     |            |            |           |           | -                | -              |
| 28             | 20             | 12             | C        |                     |            |            |           |           | -                | -              |
| 29             | 21             | 13             | VSS      |                     |            |            |           |           | -                | -              |
| 30             | 22             | 14             | P46      | X0A                 |            |            |           |           | C                | C              |
| 31             | 23             | 15             | P47      | X1A                 |            |            |           |           | C                | D              |



| Pin No.        |                |                | Pin Name          | Alternate Functions |            |         |           |         | I/O Circuit Type | Pin State Type |
|----------------|----------------|----------------|-------------------|---------------------|------------|---------|-----------|---------|------------------|----------------|
| LQFP-64 QFN-64 | LQFP-48 QFN-48 | LQFP-32 QFN-32 |                   |                     |            |         |           |         |                  |                |
| 32             | 24             | 16             | INITX             |                     |            |         |           |         | B                | E              |
| 33             | 25             | 17             | P60               | TIOA2_2             | INT15_1    | CEC1_0  |           |         | H                | K              |
| 34             | -              | -              | P1E               | RTS4_1              | MI2SMCK4_1 |         |           |         | D                | K              |
| 35             | -              | -              | P1D               | CTS4_1              | MI2SWS4_1  |         |           |         | D                | K              |
| 36             | -              | -              | P1C               | SCK4_1              | MI2SCK4_1  |         |           |         | D                | K              |
| 37             | -              | -              | P1B               | SOT4_1              | MI2SDO4_1  |         |           |         | D                | K              |
| -              | 26             | -              | P1B               | SOT4_1              |            |         |           |         | D                | K              |
| 38             | -              | -              | P1A               | SIN4_1              | INT05_1    | CEC0_0  | MI2SDI4_1 |         | H                | K              |
| -              | 27             | -              | P1A               | SIN4_1              | INT05_1    | CEC0_0  |           |         | H                | K              |
| 39             | -              | -              | P1F               | ADTG_5              |            |         |           |         | D                | K              |
| 40             | 28             | 18             | P10               | AN00                |            |         |           |         | F                | J              |
| 41             | 29             | 19             | P11               | AN01                | SIN1_1     | INT02_1 | WKUP1     |         | G                | J              |
| 42             | 30             | 20             | P12               | AN02                | SOT1_1     |         |           |         | F                | J              |
| 43             | 31             | 21             | P13               | AN03                | SCK1_1     | RTCCO_1 | SUBOUT_1  |         | F                | J              |
| 44             | 32             | -              | P14               | AN04                | SIN0_1     | SCS10_1 | INT03_1   |         | F                | J              |
| 45             | 33             | -              | P15               | AN05                | SOT0_1     | SCS11_1 |           |         | F                | J              |
| 46             | 34             | 22             | P23               | AN06                | SCK0_0     | TIOA7_1 |           |         | F                | J              |
| 47             | 35             | 23             | P22               | AN07                | TIOB7_1    |         |           |         | F                | J              |
| 48             | 36             | 24             | VCC               |                     |            |         |           |         | -                | -              |
| 49             | 37             | -              | AVRH <sup>1</sup> |                     |            |         |           |         | -                | -              |
| 50             | 38             | 25             | AVRL              |                     |            |         |           |         | -                | -              |
| 51             | 39             | 26             | P21               | INT06_1             | WKUP2      |         |           |         | E                | K              |
| 52             | -              | -              | P00               | WKUP4               |            |         |           |         | E                | K              |
| 53             | 40             | 27             | P01               | SWCLK               | SOT0_0     |         |           |         | D                | K              |
| 54             | -              | -              | P02               | WKUP5               |            |         |           |         | E                | K              |
| 55             | 41             | 28             | P03               | SWDIO               | SIN0_0     | TIOB7_0 |           |         | D                | K              |
| 56             | 42             | 29             | P05               | MD1                 | TIOA5_2    | INT00_1 | WKUP3     |         | E                | K              |
| 57             | 43             | -              | VCC               |                     |            |         |           |         | -                | -              |
| 58             | 44             | 30             | P80               | UDM0                |            |         |           |         | J                | G              |
| 59             | 45             | 31             | P81               | UDP0                |            |         |           |         | J                | G              |
| 60             | 46             | 32             | VSS               |                     |            |         |           |         | -                | -              |
| 61             | 47             | -              | P61               | UHCONX0             | TIOB2_2    |         |           |         | H                | K              |
| 62             | -              | -              | P0B               | TIOB6_1             | WKUP6      |         |           |         | E                | K              |
| 63             | -              | -              | P0C               | TIOA6_1             | WKUP7      |         |           |         | E                | K              |
| 64             | 48             | 1              | P0F               | NMIX                | WKUP0      | RTCCO_0 | SUBOUT_0  | CROUT_1 | E                | I              |

<sup>1</sup> In a 32-pin package, the AVRH pin is internally connected to the V<sub>CC</sub> pin.

**List of Pin Functions**

The number after the underscore ("\_") in a function name such as XXX\_1 and XXX\_2 indicates one of the relocate options to route that function to a different pin. Use the Extended Port Function Register (EPFR) to disable or select the desired relocate option.

| Pin Function | Pin Name | Function Description   | Pin No.           |                   |                   |
|--------------|----------|--|-------------------|-------------------|-------------------|
|              |          |  | LQFP-64<br>QFN-64 | LQFP-48<br>QFN-48 | LQFP-32<br>QFN-32 |
| ADC          | ADTG_5   | A/D converter external trigger input pin                     | 39                | -                 | -                 |
|              | ADTG_6   |  | 8                 | 8                 | 7                 |
|              | ADTG_7   |  | 23                | -                 | -                 |
| ADC          | AN00     | A/D converter analog input pin.<br>ANxx describes ADC ch.xx. | 40                | 28                | 18                |
|              | AN01     |  | 41                | 29                | 19                |
|              | AN02     |  | 42                | 30                | 20                |
|              | AN03     |  | 43                | 31                | 21                |
|              | AN04     |  | 44                | 32                | -                 |
|              | AN05     |  | 45                | 33                | -                 |
|              | AN06     |  | 46                | 34                | 22                |
|              | AN07     |  | 47                | 35                | 23                |
| Base Timer 0 | TIOA0_0  | Base timer ch.0 TIOA pin                                     | 20                | -                 | -                 |
|              | TIOA0_1  |  | 11                | 10                | -                 |
|              | TIOB0_1  | Base timer ch.0 TIOB pin                                     | 5                 | 5                 | -                 |
| Base Timer 1 | TIOA1_0  | Base timer ch.1 TIOA pin                                     | 21                | -                 | -                 |
|              | TIOA1_1  |  | 12                | 11                | -                 |
|              | TIOA1_2  |  | 4                 | 4                 | -                 |
| Base Timer 2 | TIOA2_0  | Base timer ch.2 TIOA pin                                     | 22                | -                 | -                 |
|              | TIOA2_1  |  | 13                | 12                | -                 |
|              | TIOA2_2  |  | 33                | 25                | 17                |
|              | TIOB2_1  | Base timer ch.2 TIOB pin                                     | 7                 | 7                 | 6                 |
|              | TIOB2_2  |  | 61                | 47                | -                 |
| Base Timer 3 | TIOA3_0  | Base timer ch.3 TIOA pin                                     | 23                | -                 | -                 |
|              | TIOA3_1  |  | 14                | -                 | -                 |
|              | TIOB3_0  | Base timer ch.3 TIOB pin                                     | 24                | -                 | -                 |
| Base Timer 4 | TIOA4_1  | Base timer ch.4 TIOA pin                                     | 15                | -                 | -                 |
|              | TIOB4_1  | Base timer ch.4 TIOB pin                                     | 9                 | -                 | -                 |
| Base Timer 5 | TIOA5_1  | Base timer ch.5 TIOA pin                                     | 16                | -                 | -                 |
|              | TIOA5_2  |  | 56                | 42                | 29                |
|              | TIOB5_1  | Base timer ch.5 TIOB pin                                     | 10                | -                 | -                 |
| Base Timer 6 | TIOA6_1  | Base timer ch.6 TIOA pin                                     | 63                | -                 | -                 |
|              | TIOB6_1  | Base timer ch.6 TIOB pin                                     | 62                | -                 | -                 |
| Base Timer 7 | TIOA7_1  | Base timer ch.7 TIOA pin                                     | 46                | 34                | 22                |
|              | TIOB7_0  | Base timer ch.7 TIOB pin                                     | 55                | 41                | 28                |
|              | TIOB7_1  |  | 47                | 35                | 23                |
| Debugger     | SWCLK    | Serial wire debug interface clock input pin                  | 53                | 40                | 27                |
|              | SWDIO    | Serial wire debug interface data input / output pin          | 55                | 41                | 28                |

| Pin Function       | Pin Name                                | Function Description                    | Pin No.           |                   |                   |
|--------------------|---|---|-------------------|-------------------|-------------------|
|                    |   |   | LQFP-64<br>QFN-64 | LQFP-48<br>QFN-48 | LQFP-32<br>QFN-32 |
| External Interrupt | INT00_0                                 | External interrupt request 00 input pin | 1                 | 1                 | 2                 |
|                    | INT00_1                                 |   | 56                | 42                | 29                |
|                    | INT01_0                                 | External interrupt request 01 input pin | 2                 | 2                 | 3                 |
|                    | INT02_0                                 | External interrupt request 02 input pin | 3                 | 3                 | 4                 |
|                    | INT02_1                                 |   | 41                | 29                | 19                |
|                    | INT03_0                                 | External interrupt request 03 input pin | 11                | 10                | -                 |
|                    | INT03_1                                 |   | 44                | 32                | -                 |
|                    | INT03_2                                 |   | 5                 | 5                 | -                 |
|                    | INT04_0                                 | External interrupt request 04 input pin | 8                 | 8                 | 7                 |
|                    | INT04_2                                 |   | 6                 | 6                 | 5                 |
|                    | INT05_1                                 | External interrupt request 05 input pin | 38                | 27                | -                 |
|                    | INT05_2                                 |   | 7                 | 7                 | 6                 |
|                    | INT06_1                                 | External interrupt request 06 input pin | 51                | 39                | 26                |
|                    | INT06_2                                 |   | 26                | 18                | -                 |
|                    | INT07_2                                 | External interrupt request 07 input pin | 4                 | 4                 | -                 |
|                    | INT08_1                                 | External interrupt request 08 input pin | 10                | -                 | -                 |
|                    | INT12_1                                 | External interrupt request 12 input pin | 20                | -                 | -                 |
|                    | INT13_1                                 | External interrupt request 13 input pin | 21                | -                 | -                 |
| INT15_1            | External interrupt request 15 input pin | 33                                      | 25                | 17                |                   |
| NMIX               | Non-Maskable Interrupt input pin        | 64                                      | 48                | 1                 |                   |
| GPIO               | P00                                     | General-purpose I/O port 0              | 52                | -                 | -                 |
|                    | P01                                     |   | 53                | 40                | 27                |
|                    | P02                                     |   | 54                | -                 | -                 |
|                    | P03                                     |   | 55                | 41                | 28                |
|                    | P05                                     |   | 56                | 42                | 29                |
|                    | P0B                                     |   | 62                | -                 | -                 |
|                    | P0C                                     |   | 63                | -                 | -                 |
|                    | P0F                                     |   | 64                | 48                | 1                 |
| GPIO               | P10                                     | General-purpose I/O port 1              | 40                | 28                | 18                |
|                    | P11                                     |   | 41                | 29                | 19                |
|                    | P12                                     |   | 42                | 30                | 20                |
|                    | P13                                     |   | 43                | 31                | 21                |
|                    | P14                                     |   | 44                | 32                | -                 |
|                    | P15                                     |   | 45                | 33                | -                 |
|                    | P1A                                     |   | 38                | 27                | -                 |
|                    | P1B                                     |   | 37                | 26                | -                 |
|                    | P1C                                     |   | 36                | -                 | -                 |
|                    | P1D                                     |   | 35                | -                 | -                 |
|                    | P1E                                     |   | 34                | -                 | -                 |
|                    | P1F                                     |   | 39                | -                 | -                 |
| GPIO               | P21                                     | General-purpose I/O port 2              | 51                | 39                | 26                |
|                    | P22                                     |   | 47                | 35                | 23                |
|                    | P23                                     |   | 46                | 34                | 22                |

| Pin Function               | Pin Name           | Function Description   | Pin No.           |                   |                   |
|----------------------------|--------------------|--|-------------------|-------------------|-------------------|
|                            |                    |  | LQFP-64<br>QFN-64 | LQFP-48<br>QFN-48 | LQFP-32<br>QFN-32 |
| GPIO                       | P30                | General-purpose I/O port 3   | 5                 | 5                 | -                 |
|                            | P31                |  | 6                 | 6                 | 5                 |
|                            | P32                |  | 7                 | 7                 | 6                 |
|                            | P33                |  | 8                 | 8                 | 7                 |
|                            | P34                |  | 9                 | 9                 | -                 |
|                            | P35                |  | 10                | -                 | -                 |
|                            | P3A                |  | 11                | 10                | -                 |
|                            | P3B                |  | 12                | 11                | -                 |
|                            | P3C                |  | 13                | 12                | -                 |
|                            | P3D                |  | 14                | -                 | -                 |
|                            | P3E                |  | 15                | -                 | -                 |
|                            | P3F                | 16   | -                 | -                 |                   |
| GPIO                       | P40                | General-purpose I/O port 4   | 20                | -                 | -                 |
|                            | P41                |  | 21                | -                 | -                 |
|                            | P42                |  | 22                | -                 | -                 |
|                            | P43                |  | 23                | -                 | -                 |
|                            | P46                |  | 30                | 22                | 14                |
|                            | P47                |  | 31                | 23                | 15                |
|                            | P4C                |  | 24                | 16                | -                 |
|                            | P4D                |  | 25                | 17                | -                 |
|                            | P4E                | 26   | 18                | -                 |                   |
| GPIO                       | P50                | General-purpose I/O port 5   | 1                 | 1                 | 2                 |
|                            | P51                |  | 2                 | 2                 | 3                 |
|                            | P52                |  | 3                 | 3                 | 4                 |
|                            | P53                |  | 4                 | 4                 | -                 |
| GPIO                       | P60                | General-purpose I/O port 6   | 33                | 25                | 17                |
|                            | P61                |  | 61                | 47                | -                 |
| GPIO                       | P80                | General-purpose I/O port 8   | 58                | 44                | 30                |
|                            | P81                |  | 59                | 45                | 31                |
| GPIO                       | PE2                | General-purpose I/O port E   | 18                | 14                | 9                 |
|                            | PE3                |  | 19                | 15                | 10                |
| Multi-function<br>Serial 0 | SIN0_0             | Multi-function serial interface ch.0 input pin   | 55                | 41                | 28                |
|                            | SIN0_1             |  | 44                | 32                | -                 |
|                            | SOT0_0<br>(SDA0_0) | Multi-function serial interface ch.0 output pin. This pin operates as SOT0 when used as a UART/CSIO/LIN pin (operation mode 0 to 3) and as SDA0 when used as an I <sup>2</sup> C pin (operation mode 4). | 53                | 40                | 27                |
|                            | SOT0_1<br>(SDA0_1) |  | 45                | 33                | -                 |
|                            | SCK0_0<br>(SCL0_0) | Multi-function serial interface ch.0 clock I/O pin. This pin operates as SCK0 when used as a CSIO pin (operation mode 2) and as SCL0 when used as an I <sup>2</sup> C pin (operation mode 4).            | 46                | 34                | 22                |

| Pin Function               | Pin Name           | Function Description   | Pin No.           |                   |                   |
|----------------------------|--------------------|--|-------------------|-------------------|-------------------|
|                            |                    |  | LQFP-64<br>QFN-64 | LQFP-48<br>QFN-48 | LQFP-32<br>QFN-32 |
| Multi-function<br>Serial 1 | SIN1_1             | Multi-function serial interface ch.1 input pin   | 41                | 29                | 19                |
|                            | SOT1_1<br>(SDA1_1) | Multi-function serial interface ch.1 output pin. This pin operates as SOT1 when used as a UART/CSIO/LIN pin (operation mode 0 to 3) and as SDA1 when used as an I <sup>2</sup> C pin (operation mode 4). | 42                | 30                | 20                |
|                            | SCK1_1<br>(SCL1_1) | Multi-function serial interface ch.1 clock I/O pin. This pin operates as SCK1 when used as a CSIO pin (operation mode 2) and as SCL1 when used as an I <sup>2</sup> C pin (operation mode 4).            | 43                | 31                | 21                |
|                            | SCS10_1            | Multi-function serial interface ch.1 serial chip select 0 input/output pin.  | 44                | 32                | -                 |
|                            | SCS11_1            | Multi-function serial interface ch.1 serial chip select 1 output pin.  | 45                | 33                | -                 |
| Multi-function<br>Serial 3 | SIN3_1             | Multi-function serial interface ch.3 input pin   | 1                 | 1                 | 2                 |
|                            | SOT3_1<br>(SDA3_1) | Multi-function serial interface ch.3 output pin. This pin operates as SOT3 when used as a UART/CSIO/LIN pin (operation mode 0 to 3) and as SDA3 when used as an I <sup>2</sup> C pin (operation mode 4). | 2                 | 2                 | 3                 |
|                            | SCK3_1<br>(SCL3_1) | Multi-function serial interface ch.3 clock I/O pin. This pin operates as SCK3 when used as a CSIO (operation mode 2) and as SCL3 when used as an I <sup>2</sup> C pin (operation mode 4).                | 3                 | 3                 | 4                 |
| Multi-function<br>Serial 4 | SIN4_1             | Multi-function serial interface ch.4 input pin   | 38                | 27                | -                 |
|                            | SOT4_1<br>(SDA4_1) | Multi-function serial interface ch.4 output pin. This pin operates as SOT4 when used as a UART/CSIO/LIN pin (operation mode 0 to 3) and as SDA4 when used as an I <sup>2</sup> C pin (operation mode 4). | 37                | 26                | -                 |
|                            | SCK4_1<br>(SCL4_1) | Multi-function serial interface ch.4 clock I/O pin. This pin operates as SCK4 when used as a CSIO (operation mode 2) and as SCL4 when used as an I <sup>2</sup> C pin (operation mode 4).                | 36                | -                 | -                 |
|                            | CTS4_1             | Multi-function serial interface ch4 CTS input pin  | 35                | -                 | -                 |
|                            | RTS4_1             | Multi-function serial interface ch4 RTS output pin   | 34                | -                 | -                 |

| Pin Function               | Pin Name           | Function Description   | Pin No.           |                   |                   |
|----------------------------|--------------------|--|-------------------|-------------------|-------------------|
|                            |                    |  | LQFP-64<br>QFN-64 | LQFP-48<br>QFN-48 | LQFP-32<br>QFN-32 |
| Multi-function<br>Serial 6 | SIN6_1             | Multi-function serial interface ch.6 input pin   | 8                 | 8                 | 7                 |
|                            | SOT6_1<br>(SDA6_1) | Multi-function serial interface ch.6 output pin. This pin operates as SOT6 when used as a UART/CSIO/LIN pin (operation mode 0 to 3) and as SDA6 when used as an I <sup>2</sup> C pin (operation mode 4). | 7                 | 7                 | 6                 |
|                            | SCK6_1<br>(SCL6_1) | Multi-function serial interface ch.6 clock I/O pin. This pin operates as SCK6 when used as a CSIO (operation mode 2) and as SCL6 when used as an I <sup>2</sup> C pin (operation mode 4).                | 6                 | 6                 | 5                 |
|                            | SCS60_1            | Multi-function serial interface ch.6 serial chip select 0 input/output pin.  | 5                 | 5                 | -                 |
|                            | SCS61_1            | Multi-function serial interface ch.6 serial chip select 1 output pin.  | 9                 | 9                 | -                 |
|                            | SCS62_1            | Multi-function serial interface ch.6 serial chip select 2 output pin.  | 10                | -                 | -                 |
| Multi-function<br>Serial 7 | SIN7_1             | Multi-function serial interface ch.7 input pin   | 26                | 18                | -                 |
|                            | SOT7_1<br>(SDA7_1) | Multi-function serial interface ch.7 output pin. This pin operates as SOT7 when used as a UART/CSIO/LIN pin (operation mode 0 to 3) and as SDA7 when used as an I <sup>2</sup> C pin (operation mode 4). | 25                | 17                | -                 |
|                            | SCK7_1<br>(SCL7_1) | Multi-function serial interface ch.7 clock I/O pin. This pin operates as SCK7 when used as a CSIO (operation mode 2) and as SCL7 when used as an I <sup>2</sup> C pin (operation mode 4).                | 24                | 16                | -                 |

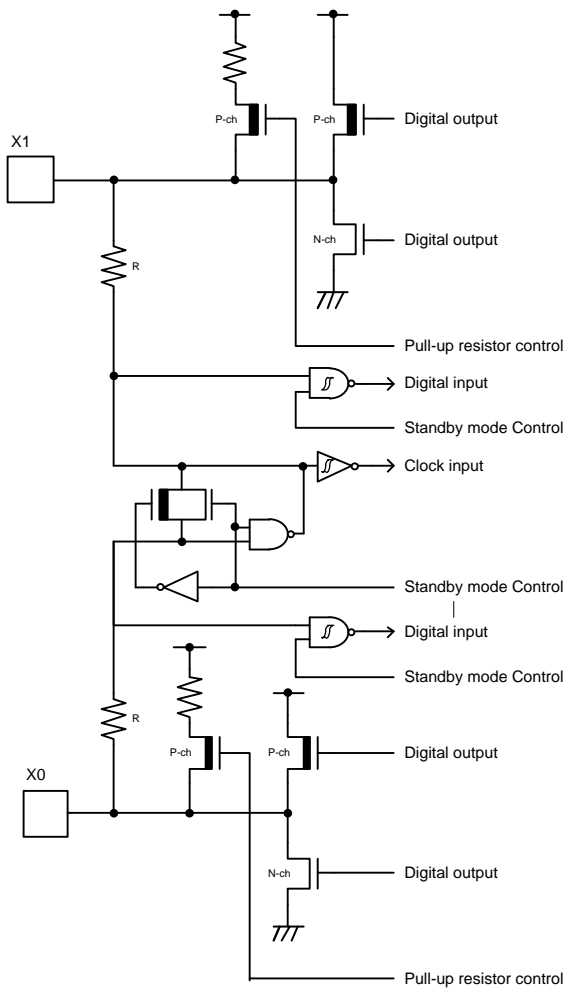
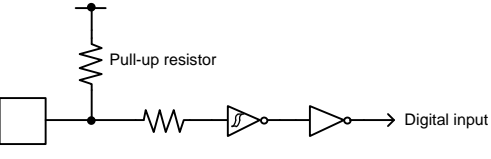
| Pin Function                      | Pin Name   | Function Description   | Pin No.           |                   |                   |
|-----------------------------------|------------|--|-------------------|-------------------|-------------------|
|                                   |            |  | LQFP-64<br>QFN-64 | LQFP-48<br>QFN-48 | LQFP-32<br>QFN-32 |
| I2S(MFS)                          | MI2SDI4_1  | I <sup>2</sup> S Serial Data Input pin (operation mode 2).         | 38                | -                 | -                 |
|                                   | MI2SDO4_1  | I <sup>2</sup> S Serial Data Output pin (operation mode 2).        | 37                | -                 | -                 |
|                                   | MI2SCK4_1  | I <sup>2</sup> S Serial Clock Output pin (operation mode 2).       | 36                | -                 | -                 |
|                                   | MI2SWS4_1  | I <sup>2</sup> S Word Select Output pin (operation mode 2).        | 35                | -                 | -                 |
|                                   | MI2SMCK4_1 | I <sup>2</sup> S Master Clock Input/output pin (operation mode 2). | 34                | -                 | -                 |
|                                   | MI2SDI6_1  | I <sup>2</sup> S Serial Data Input pin (operation mode 2).         | 8                 | 8                 | -                 |
|                                   | MI2SDO6_1  | I <sup>2</sup> S Serial Data Output pin (operation mode 2).        | 7                 | 7                 | -                 |
|                                   | MI2SCK6_1  | I <sup>2</sup> S Serial Clock Output pin (operation mode 2).       | 6                 | 6                 | -                 |
|                                   | MI2SWS6_1  | I <sup>2</sup> S Word Select Output pin (operation mode 2).        | 5                 | 5                 | -                 |
|                                   | MI2SMCK6_1 | I <sup>2</sup> S Master Clock Input/output pin (operation mode 2). | 9                 | 9                 | -                 |
| Smart Card Interface              | IC1_CIN_0  | Smart Card insert detection output pin                             | 11                | -                 | -                 |
|                                   | IC1_CLK_0  | Smart Card serial interface clock output pin                       | 16                | -                 | -                 |
|                                   | IC1_DATA_0 | Smart Card serial interface data input pin                         | 12                | -                 | -                 |
|                                   | IC1_RST_0  | Smart Card reset output pin  | 13                | -                 | -                 |
|                                   | IC1_VCC_0  | Smart Card power enable output pin                                 | 15                | -                 | -                 |
|                                   | IC1_VPEN_0 | Smart Card programming output pin                                  | 14                | -                 | -                 |
| USB                               | UDM0       | USB function/host D – pin  | 58                | 44                | 30                |
|                                   | UDP0       | USB function/host D + pin  | 59                | 45                | 31                |
|                                   | UHCONX0    | USB external pull-up control pin                                   | 61                | 47                | -                 |
| Real-time Clock                   | RTCCO_0    | 0.5 seconds pulse output pin of real-time clock                    | 64                | 48                | 1                 |
|                                   | RTCCO_1    |  | 43                | 31                | 21                |
|                                   | RTCCO_2    |  | 11                | 10                | -                 |
|                                   | SUBOUT_0   | Sub clock output pin   | 64                | 48                | 1                 |
|                                   | SUBOUT_1   |  | 43                | 31                | 21                |
|                                   | SUBOUT_2   |  | 11                | 10                | -                 |
| HDMI-CEC/Remote Control Reception | CEC0_0     | HDMI-CEC/Remote Control Reception ch.0 input/output pin            | 38                | 27                | -                 |
|                                   | CEC1_0     | HDMI-CEC/Remote Control Reception ch.1 input/output pin            | 33                | 25                | 17                |

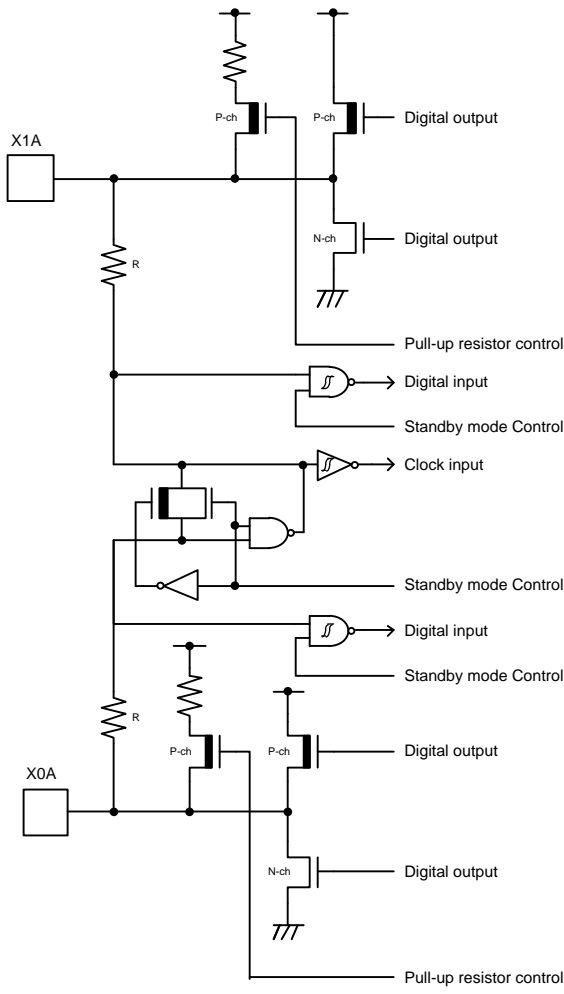
| Pin Function               | Pin Name          | Function Description  | Pin No.           |                   |                   |
|----------------------------|-------------------|---|-------------------|-------------------|-------------------|
|                            |                   |   | LQFP-64<br>QFN-64 | LQFP-48<br>QFN-48 | LQFP-32<br>QFN-32 |
| Low Power Consumption Mode | WKUP0             | Deep Standby mode return signal input pin 0   | 64                | 48                | 1                 |
|                            | WKUP1             | Deep Standby mode return signal input pin 1   | 41                | 29                | 19                |
|                            | WKUP2             | Deep Standby mode return signal input pin 2   | 51                | 39                | 26                |
|                            | WKUP3             | Deep Standby mode return signal input pin 3   | 56                | 42                | 29                |
|                            | WKUP4             | Deep Standby mode return signal input pin 4   | 52                | -                 | -                 |
|                            | WKUP5             | Deep Standby mode return signal input pin 5   | 54                | -                 | -                 |
|                            | WKUP6             | Deep Standby mode return signal input pin 6   | 62                | -                 | -                 |
|                            | WKUP7             | Deep Standby mode return signal input pin 7   | 63                | -                 | -                 |
| I2C Slave                  | SI2CSCL6_1        | I <sup>2</sup> C Clock Pin  | 6                 | 6                 | 5                 |
|                            | SI2CSDA6_1        | I <sup>2</sup> C Data Pin   | 7                 | 7                 | 6                 |
| RESET                      | INITX             | External Reset Input pin.<br>A reset is valid when INITX="L".   | 32                | 24                | 16                |
| MODE                       | MD0               | Mode 0 pin.<br>During normal operation, input MD0="L".<br>During serial programming to Flash memory, input MD0="H".                 | 17                | 13                | 8                 |
|                            | MD1               | Mode 1 pin.<br>During normal operation, input is not needed.<br>During serial programming to Flash memory, MD1 = "L" must be input. | 56                | 42                | 29                |
| CLOCK                      | X0                | Main clock (oscillation) input pin  | 18                | 14                | 9                 |
|                            | X0A               | Sub clock (oscillation) input pin   | 30                | 22                | 14                |
|                            | X1                | Main clock (oscillation) I/O pin  | 19                | 15                | 10                |
|                            | X1A               | Sub clock (oscillation) I/O pin   | 31                | 23                | 15                |
|                            | CROUT_1           | Built-in high-speed CR oscillation clock output port  | 64                | 48                | 1                 |
| POWER                      | VCC               | Power supply pin  | 27                | 19                | 11                |
|                            | VCC               |   | 48                | 36                | 24                |
|                            | VCC               |   | 57                | 43                | -                 |
| GND                        | VSS               | GND pin   | 29                | 21                | 13                |
|                            | VSS               |   | 60                | 46                | 32                |
| Analog Reference           | AVRH <sup>2</sup> | A/D converter analog reference voltage input pin  | 49                | 37                | -                 |
|                            | AVRL              | A/D converter analog reference voltage input pin  | 50                | 38                | 25                |
| C pin                      | C                 | Power supply stabilization capacitance pin  | 28                | 20                | 12                |

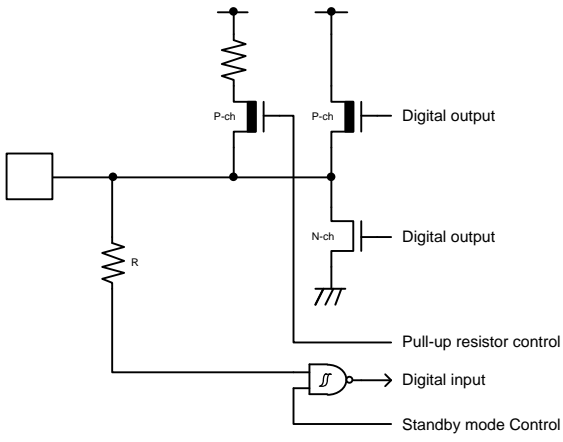
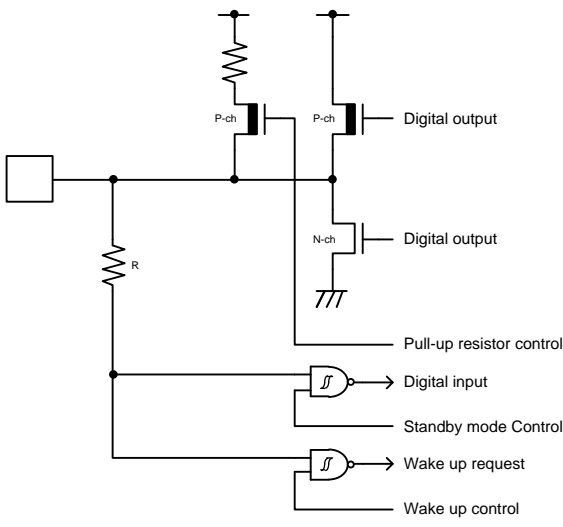
<sup>2</sup> In case of 32-pin package, AVRH pin is internally connected to the V<sub>CC</sub> pin.

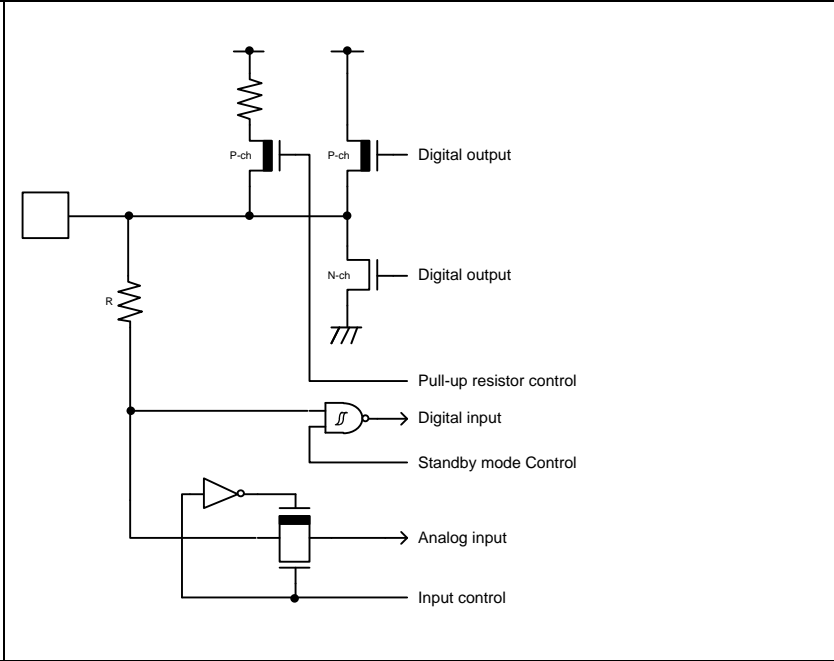
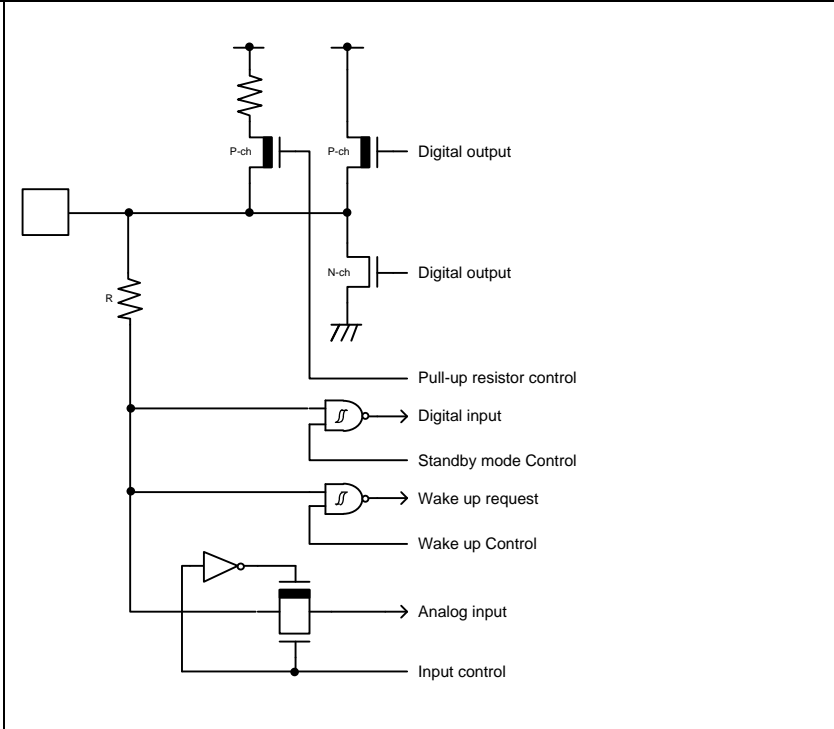


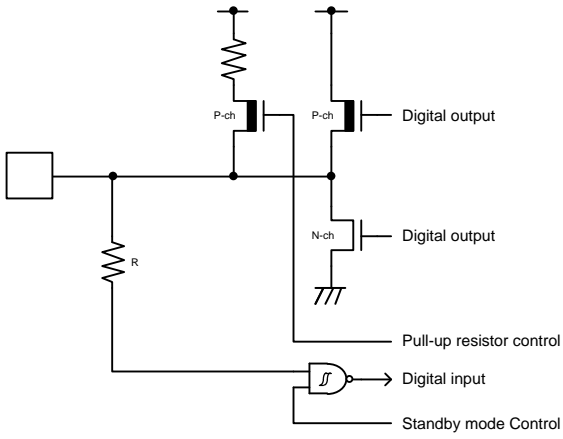
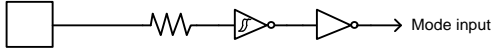
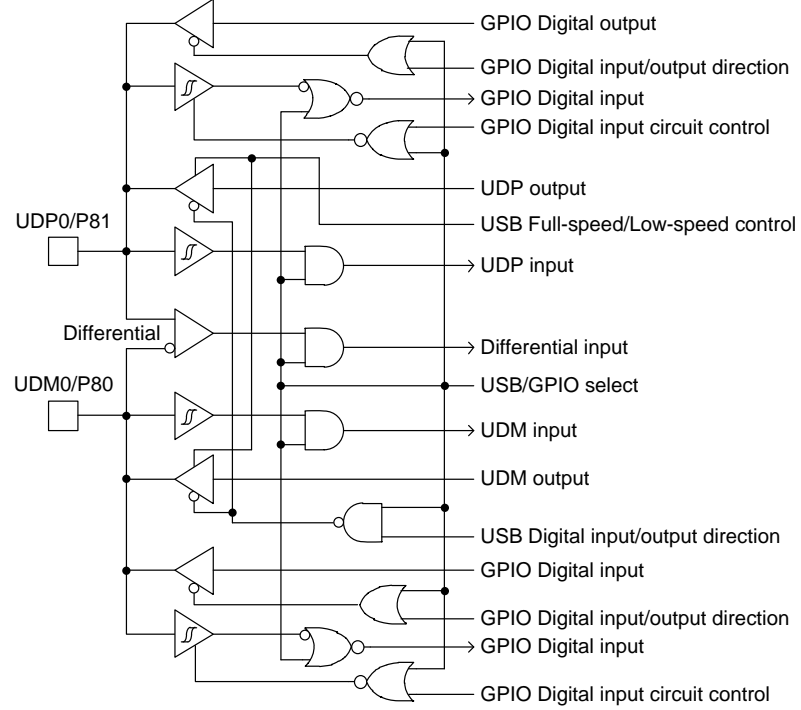
**6. I/O Circuit Type**

| Type | Circuit   | Remarks   |
|------|---|---|
| A    |   | <p>It is possible to select the main oscillation / GPIO function</p> <p>When the main oscillation is selected.</p> <ul style="list-style-type: none"> <li>• Oscillation feedback resistor<br/>Approximately 1 MΩ</li> <li>• With standby mode control</li> </ul> <p>When the GPIO is selected.</p> <ul style="list-style-type: none"> <li>• CMOS level output.</li> <li>• CMOS level hysteresis input</li> <li>• With pull-up resistor control</li> <li>• With standby mode control</li> <li>• Pull-up resistor<br/>Approximately 33 kΩ</li> <li>• <math>I_{OH} = -4 \text{ mA}</math>, <math>I_{OL} = 4 \text{ mA}</math></li> </ul> |
| B    |  | <p>CMOS level hysteresis input</p> <p>Pull-up resistor</p> <p>Approximately 33 kΩ</p>   |

| Type | Circuit  | Remarks   |
|------|--|---|
| C    |  | <p>It is possible to select the sub oscillation / GPIO function</p> <p>When the sub oscillation is selected.</p> <ul style="list-style-type: none"> <li>• Oscillation feedback resistor Approximately 5 MΩ</li> <li>• With Standby mode control</li> </ul> <p>When the GPIO is selected.</p> <ul style="list-style-type: none"> <li>• CMOS level output.</li> <li>• CMOS level hysteresis input</li> <li>• With pull-up resistor control</li> <li>• With standby mode control</li> <li>• Pull-up resistor Approximately 33 kΩ</li> </ul> <p><math>I_{OH} = -4 \text{ mA}</math>, <math>I_{OL} = 4 \text{ mA}</math></p> |

| Type | Circuit   | Remarks   |
|------|---|---|
| D    |  <p>The diagram for Type D shows a digital pin connected to a pull-up resistor R. The pin is driven by a P-channel MOSFET (P-ch) and an N-channel MOSFET (N-ch). The P-ch MOSFET is controlled by a 'Pull-up resistor control' signal. The N-ch MOSFET is controlled by a 'Standby mode Control' signal. The pin can be configured as a digital output (driven by the P-ch MOSFET) or a digital input (driven by the pull-up resistor R). The circuit also includes a digital input signal and a standby mode control signal.</p>  | <ul style="list-style-type: none"> <li>• CMOS level output</li> <li>• CMOS level hysteresis input</li> <li>• With pull-up resistor control</li> <li>• With standby mode control</li> <li>• Pull-up resistor<br/>Approximately 33 kΩ</li> <li>• IOH= -4mA, IOL= 4 mA</li> <li>• When this pin is used as an I<sup>2</sup>C pin, the digital output P-ch transistor is always off</li> </ul>  |
| E    |  <p>The diagram for Type E shows a digital pin connected to a pull-up resistor R. The pin is driven by a P-channel MOSFET (P-ch) and an N-channel MOSFET (N-ch). The P-ch MOSFET is controlled by a 'Pull-up resistor control' signal. The N-ch MOSFET is controlled by a 'Standby mode Control' signal. The pin can be configured as a digital output (driven by the P-ch MOSFET) or a digital input (driven by the pull-up resistor R). The circuit also includes a digital input signal, a standby mode control signal, a wake up request signal, and a wake up control signal.</p> | <ul style="list-style-type: none"> <li>• CMOS level output</li> <li>• CMOS level hysteresis input</li> <li>• With pull-up resistor control</li> <li>• With standby mode control</li> <li>• Pull-up resistor<br/>Approximately 33 kΩ</li> <li>• IOH= -4 mA, IOL= 4 mA</li> <li>• When this pin is used as an I<sup>2</sup>C pin, the digital output P-ch transistor is always off</li> </ul> |

| Type | Circuit   | Remarks   |
|------|---|---|
| F    |   | <ul style="list-style-type: none"> <li>• CMOS level output</li> <li>• CMOS level hysteresis input</li> <li>• With input control</li> <li>• Analog input</li> <li>• With pull-up resistor control</li> <li>• With standby mode control</li> <li>• Pull-up resistor<br/>Approximately 33 kΩ</li> <li>• IOH= -4 mA, IOL= 4 mA</li> <li>• When this pin is used as an I<sup>2</sup>C pin, the digital output P-ch transistor is always off</li> </ul>   |
| G    |  | <ul style="list-style-type: none"> <li>• CMOS level output</li> <li>• CMOS level hysteresis input</li> <li>• With input control</li> <li>• Analog input</li> <li>• With pull-up resistor control</li> <li>• With standby mode control</li> <li>• Pull-up resistor<br/>: Approximately 33 kΩ</li> <li>• IOH= -4 mA, IOL= 4 mA</li> <li>• When this pin is used as an I<sup>2</sup>C pin, the digital output P-ch transistor is always off</li> </ul> |

| Type | Circuit   | Remarks  |
|------|---|--|
| H    |  <p>The diagram shows a pull-up resistor R connected to a digital output pin. The pin is driven by a P-channel MOSFET (P-ch) and an N-channel MOSFET (N-ch). A pull-up resistor control signal is connected to the gate of the P-ch transistor. A digital input signal is connected to the pin through a Schmitt trigger. A standby mode control signal is connected to the gate of the N-ch transistor.</p>   | <ul style="list-style-type: none"> <li>• CMOS level output</li> <li>• CMOS level hysteresis input</li> <li>• 5V tolerant</li> <li>• With pull-up resistor control</li> <li>• With standby mode control</li> <li>• Pull-up resistor<br/>Approximately 33 kΩ</li> <li>• IOH= -4 mA, IOL= 4 mA</li> <li>• Available to control PZR registers</li> <li>• When this pin is used as an I<sup>2</sup>C pin, the digital output P-ch transistor is always off</li> </ul> |
| I    |  <p>The diagram shows a pull-up resistor connected to a mode input pin through a Schmitt trigger.</p>   | <ul style="list-style-type: none"> <li>• CMOS level hysteresis input</li> </ul>  |
| J    |  <p>The diagram shows a complex digital circuit with multiple inputs and outputs. It includes a pull-up resistor connected to a differential input. The circuit contains several Schmitt triggers, inverters, and logic gates. The outputs are labeled as follows:</p> <ul style="list-style-type: none"> <li>GPIO Digital output</li> <li>GPIO Digital input/output direction</li> <li>GPIO Digital input</li> <li>GPIO Digital input circuit control</li> <li>UDP output</li> <li>USB Full-speed/Low-speed control</li> <li>UDP input</li> <li>Differential input</li> <li>USB/GPIO select</li> <li>UDM input</li> <li>UDM output</li> <li>USB Digital input/output direction</li> <li>GPIO Digital input</li> <li>GPIO Digital input/output direction</li> <li>GPIO Digital input</li> <li>GPIO Digital input circuit control</li> </ul> | <p>It is possible to select the USB I/O / GPIO function.</p> <p>When the USB I/O is selected.</p> <ul style="list-style-type: none"> <li>• Full-speed, Low-speed control</li> </ul> <p>When the GPIO is selected.</p> <ul style="list-style-type: none"> <li>• CMOS level output</li> <li>• CMOS level hysteresis input</li> <li>• With standby mode control</li> </ul>  |

## 7. Handling Precautions

Any semiconductor devices have inherently a certain rate of failure. The possibility of failure is greatly affected by the conditions in which they are used (circuit conditions, environmental conditions, etc.). This page describes precautions that must be observed to minimize the chance of failure and to obtain higher reliability from your Cypress semiconductor devices.

### 7.1 Precautions for Product Design

This section describes precautions when designing electronic equipment using semiconductor devices.

#### Absolute Maximum Ratings

Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of certain established limits, called absolute maximum ratings. Do not exceed these ratings.

#### Recommended Operating Conditions

Recommended operating conditions are normal operating ranges for the semiconductor device. All the device's electrical characteristics are warranted when operated within these ranges.

Always use semiconductor devices within the recommended operating conditions. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their sales representative beforehand.

#### Processing and Protection of Pins

These precautions must be followed when handling the pins which connect semiconductor devices to power supply and input/output functions.

##### (1) Preventing Over-Voltage and Over-Current Conditions

Exposure to voltage or current levels in excess of maximum ratings at any pin is likely to cause deterioration within the device, and in extreme cases leads to permanent damage of the device. Try to prevent such overvoltage or over-current conditions at the design stage.

##### (2) Protection of Output Pins

Shorting of output pins to supply pins or other output pins, or connection to large capacitance can cause large current flows. Such conditions if present for extended periods of time can damage the device.

Therefore, avoid this type of connection.

##### (3) Handling of Unused Input Pins

Unconnected input pins with very high impedance levels can adversely affect stability of operation. Such pins should be connected through an appropriate resistance to a power supply pin or ground pin.

### Latch-Up

Semiconductor devices are constructed by the formation of P-type and N-type areas on a substrate. When subjected to abnormally high voltages, internal parasitic PNPN junctions (called thyristor structures) may be formed, causing large current levels in excess of several hundred mA to flow continuously at the power supply pin. This condition is called latch-up.

**CAUTION:** The occurrence of latch-up not only causes loss of reliability in the semiconductor device, but can cause injury or damage from high heat, smoke or flame. To prevent this from happening, do the following:

- (1) Be sure that voltages applied to pins do not exceed the absolute maximum ratings. This should include attention to abnormal noise, surge levels, etc.
- (2) Be sure that abnormal current flows do not occur during the power-on sequence.

### Observance of Safety Regulations and Standards

Most countries in the world have established standards and regulations regarding safety, protection from electromagnetic interference, etc. Customers are requested to observe applicable regulations and standards in the design of products.

### Fail-Safe Design

Any semiconductor devices have inherently a certain rate of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

### Precautions Related to Usage of Devices

Cypress semiconductor devices are intended for use in standard applications (computers, office automation and other office equipment, industrial, communications, and measurement equipment, personal or household devices, etc.).

**CAUTION:** Customers considering the use of our products in special applications where failure or abnormal operation may directly affect human lives or cause physical injury or property damage, or where extremely high levels of reliability are demanded (such as aerospace systems, atomic energy controls, sea floor repeaters, vehicle operating controls, medical devices for life support, etc.) are requested to consult with sales representatives before such use. The company will not be responsible for damages arising from such use without prior approval.

### 7.2 Precautions for Package Mounting

Package mounting may be either lead insertion type or surface mount type. In either case, for heat resistance during soldering, you should mount only under Cypress' recommended conditions. For detailed information about mount conditions, contact your sales representative.

#### Lead Insertion Type

Mounting of lead insertion type packages onto printed circuit boards may be done by two methods: direct soldering on the board, or mounting by using a socket.

Direct mounting onto boards normally involves processes for inserting leads into through-holes on the board and using the flow soldering (wave soldering) method of applying liquid solder. In this case, the soldering process usually causes leads to be subjected to thermal stress in excess of the absolute ratings for storage temperature. Mounting processes should conform to Cypress recommended mounting conditions.

If socket mounting is used, differences in surface treatment of the socket contacts and IC lead surfaces can lead to contact deterioration after long periods. For this reason it is recommended that the surface treatment of socket contacts and IC leads be verified before mounting.

### Surface Mount Type

Surface mount packaging has longer and thinner leads than lead-insertion packaging, and therefore leads are more easily deformed or bent. The use of packages with higher pin counts and narrower pin pitch results in increased susceptibility to open connections caused by deformed pins, or shorting due to solder bridges.

You must use appropriate mounting techniques. Cypress recommends the solder reflow method, and has established a ranking of mounting conditions for each product. Users are advised to mount packages in accordance with Cypress ranking of recommended conditions.

### Lead-Free Packaging

CAUTION: When ball grid array (BGA) packages with Sn-Ag-Cu balls are mounted using Sn-Pb eutectic soldering, junction strength may be reduced under some conditions of use.

### Storage of Semiconductor Devices

Because plastic chip packages are formed from plastic resins, exposure to natural environmental conditions will cause absorption of moisture. During mounting, the application of heat to a package that has absorbed moisture can cause surfaces to peel, reducing moisture resistance and causing packages to crack. To prevent, do the following:

- (1) Avoid exposure to rapid temperature changes, which cause moisture to condense inside the product.  
Store products in locations where temperature changes are slight.
- (2) Use dry boxes for product storage. Products should be stored below 70% relative humidity, and at temperatures between 5 °C and 30 °C.  
When you open Dry Package that recommends humidity 40% to 70% relative humidity.
- (3) When necessary, Cypress packages semiconductor devices in highly moisture-resistant aluminum laminate bags, with a silica gel desiccant. Devices should be sealed in their aluminum laminate bags for storage.
- (4) Avoid storing packages where they are exposed to corrosive gases or high levels of dust.

### Baking

Packages that have absorbed moisture may be de-moisturized by baking (heat drying). Follow the Cypress recommended conditions for baking.

Condition: 125°C/24 h

### Static Electricity

Because semiconductor devices are particularly susceptible to damage by static electricity, you must take the following precautions:

- (1) Maintain relative humidity in the working environment between 40% and 70%.  
Use of an apparatus for ion generation may be needed to remove electricity.
- (2) Electrically ground all conveyors, solder vessels, soldering irons and peripheral equipment.
- (3) Eliminate static body electricity by the use of rings or bracelets connected to ground through high resistance (on the level of 1 MΩ).  
Wearing of conductive clothing and shoes, use of conductive floor mats and other measures to minimize shock loads is recommended.
- (4) Ground all fixtures and instruments, or protect with anti-static measures.
- (5) Avoid the use of Styrofoam or other highly static-prone materials for storage of completed board assemblies.



### 7.3 Precautions for Use Environment

Reliability of semiconductor devices depends on ambient temperature and other conditions as described above.

For reliable performance, do the following:

(1) Humidity

Prolonged use in high humidity can lead to leakage in devices as well as printed circuit boards. If high humidity levels are anticipated, consider anti-humidity processing.

(2) Discharge of Static Electricity

When high-voltage charges exist close to semiconductor devices, discharges can cause abnormal operation. In such cases, use anti-static measures or processing to prevent discharges.

(3) Corrosive Gases, Dust, or Oil

Exposure to corrosive gases or contact with dust or oil may lead to chemical reactions that will adversely affect the device. If you use devices in such conditions, consider ways to prevent such exposure or to protect the devices.

(4) Radiation, Including Cosmic Radiation

Most devices are not designed for environments involving exposure to radiation or cosmic radiation. Users should provide shielding as appropriate.

(5) Smoke, Flame

**CAUTION:** Plastic molded devices are flammable, and therefore should not be used near combustible substances. If devices begin to smoke or burn, there is danger of the release of toxic gases.

Customers considering the use of Cypress products in other special environmental conditions should consult with sales representatives.

## 8. Handling Devices

### Power Supply Pins

In products with multiple VCC and VSS pins, respective pins at the same potential are interconnected within the device in order to prevent malfunctions such as latch-up. However, all of these pins should be connected externally to the power supply or ground lines in order to reduce electromagnetic emission levels, to prevent abnormal operation of strobe signals caused by the rise in the ground level, and to conform to the total output current rating.

Moreover, connect the current supply source with each Power supply pin and GND pin of this device at low impedance. It is also advisable that a ceramic capacitor of approximately 0.1  $\mu\text{F}$  be connected as a bypass capacitor between each Power supply pin and GND pin, between AVRH pin and AVRL pin near this device.

### Stabilizing Supply Voltage

A malfunction may occur when the power supply voltage fluctuates rapidly even though the fluctuation is within the recommended operating conditions of the VCC power supply voltage. As a rule, with voltage stabilization, suppress the voltage fluctuation so that the fluctuation in VCC ripple (peak-to-peak value) at the commercial frequency (50 Hz/60 Hz) does not exceed 10% of the VCC value in the recommended operating conditions, and the transient fluctuation rate does not exceed 0.1 V/ $\mu\text{s}$  when there is a momentary fluctuation on switching the power supply.

### Crystal Oscillator Circuit

Noise near the X0/X1 and X0A/X1A pins may cause the device to malfunction. Design the printed circuit board so that X0/X1, X0A/X1A pins, the crystal oscillator, and the bypass capacitor to ground are located as close to the device as possible.

It is strongly recommended that the PC board artwork be designed such that the X0/X1 and X0A/X1A pins are surrounded by ground plane as this is expected to produce stable operation.

Evaluate oscillation of your using crystal oscillator by your mount board.

### Sub Crystal Oscillator

This series sub oscillator circuit is low gain to keep the low current consumption. The crystal oscillator to fill the following conditions is recommended for sub crystal oscillator to stabilize the oscillation.

#### ■ Surface mount type

Size: More than 3.2 mm  $\times$  1.5 mm

Load capacitance: Approximately 6 pF to 7 pF

#### ■ Lead type

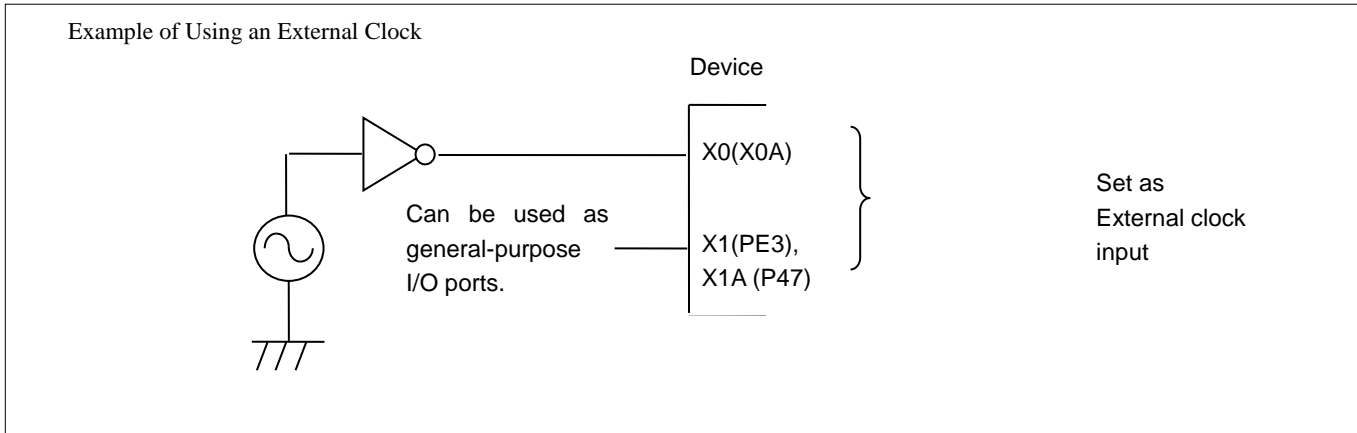
Load capacitance: Approximately 6 pF to 7 pF

### Using an External Clock

When using an external clock as an input of the main clock, set X0/X1 to the external clock input, and input the clock to X0. X1(PE3) can be used as a general-purpose I/O port.

Similarly, when using an external clock as an input of the sub clock, set X0A/X1A to the external clock input, and input the clock to X0A. X1A (P47) can be used as a general-purpose I/O port.

However in the Deep Standby mode, an external clock as an input of the sub clock cannot be used.



### Handling when Using Multi-Function Serial Pin as I<sup>2</sup>C Pin

If it is using the multi-function serial pin as I<sup>2</sup>C pins, P-ch transistor of digital output is always disabled. However, I<sup>2</sup>C pins need to keep the electrical characteristic like other pins and not to connect to the external I<sup>2</sup>C bus system with power OFF.

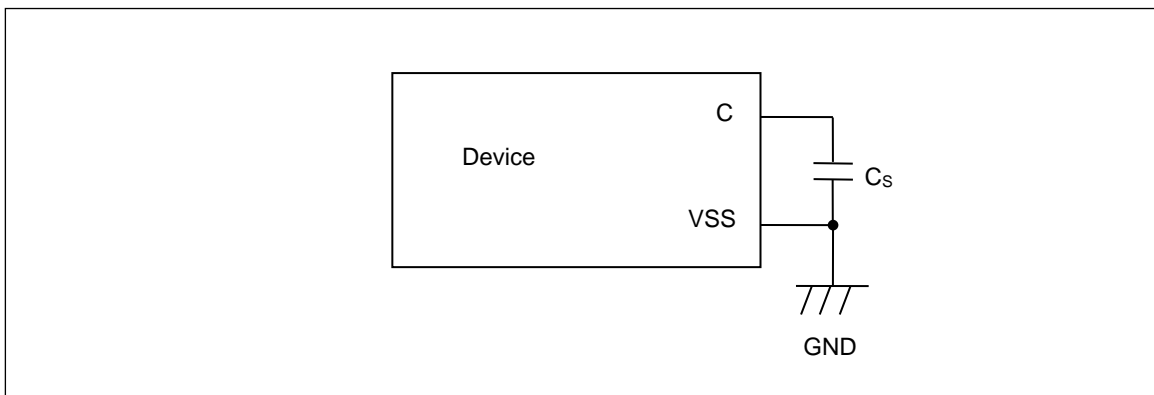
### C Pin

This series contains the regulator. Be sure to connect a smoothing capacitor (C<sub>s</sub>) for the regulator between the C pin and the GND pin. Please use a ceramic capacitor or a capacitor of equivalent frequency characteristics as a smoothing capacitor.

However, some laminated ceramic capacitors have the characteristics of capacitance variation due to thermal fluctuation (F characteristics and Y5V characteristics). Please select the capacitor that meets the specifications in the operating conditions to use by evaluating the temperature characteristics of a capacitor.

A smoothing capacitor of about 4.7 μF would be recommended for this series.

Incidentally, the C pin becomes floating in Deep standby mode.



### Mode Pins (MD0)

Connect the MD pin (MD0) directly to VCC or VSS pins. Design the printed circuit board such that the pull-up/down resistance stays low, as well as the distance between the mode pins and VCC pins or VSS pins is as short as possible and the connection impedance is low, when the pins are pulled-up/down such as for switching the pin level and rewriting the Flash memory data. It is because of preventing the device erroneously switching to test mode due to noise.

### Notes on Power-on

Turn power on/off in the following order or at the same time.

Turning on : VCC →AVRH

Turning off : AVRH →VCC

### Serial Communication

There is a possibility to receive wrong data due to the noise or other causes on the serial communication.

Therefore, design a printed circuit board so as to avoid noise.

Consider the case of receiving wrong data due to noise; perform error detection such as by applying a checksum of data at the end.

If an error is detected, retransmit the data.

### Differences in Features Among the Products with Different Memory Sizes and Between Flash Memory Products and MASK Products

The electric characteristics including power consumption, ESD, latch-up, noise characteristics, and oscillation characteristics among the products with different memory sizes and between Flash memory products and MASK products are different because chip layout and memory structures are different.

If you are switching to use a different product of the same series, please make sure to evaluate the electric characteristics.

### Pull-Up Function of 5 V Tolerant I/O

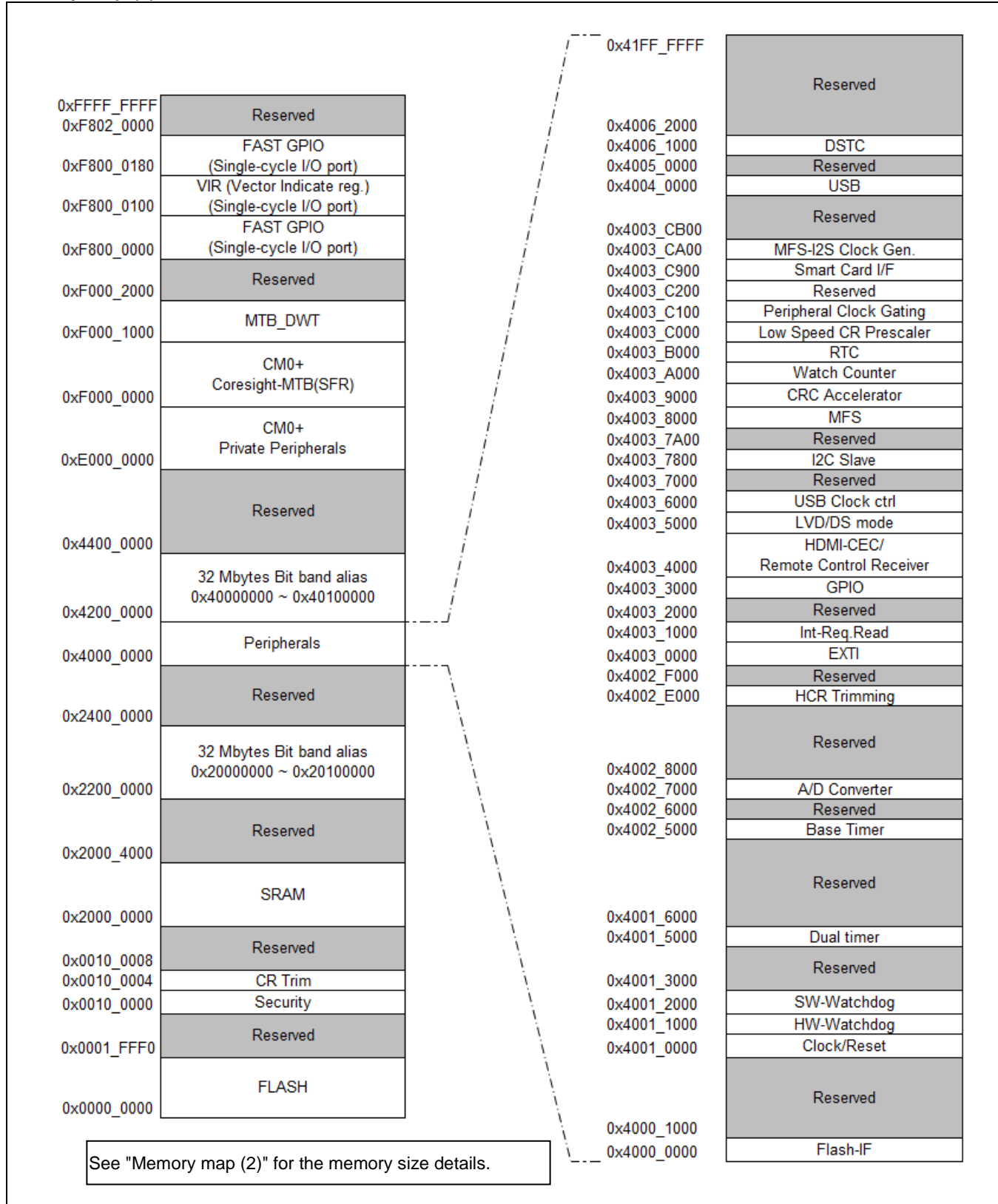
Please do not input the signal more than VCC voltage at the time of Pull-Up function use of 5 V tolerant I/O.

### Handling when Using Debug Pins

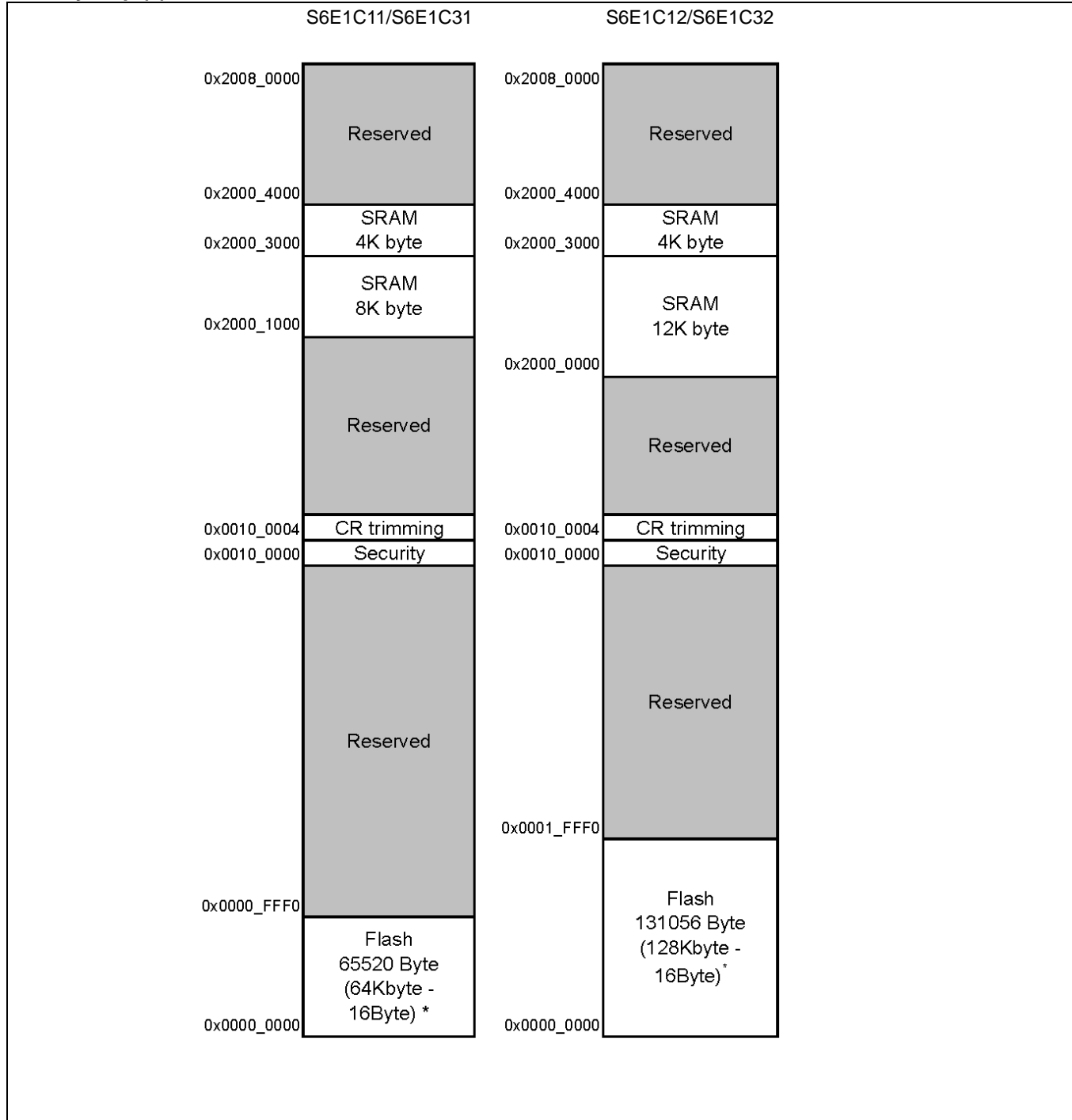
When debug pins (SWDIO/SWCLK) are set to GPIO or other peripheral functions, set them as output only; do not set them as input.

## 9. Memory Map

### Memory Map (1)



Memory Map (2)



\*: See "S6E1C1/C3 Series Flash Programming Manual" to check details of the flash memory.

**Peripheral Address Map**

| Start Address | End Address | Bus                  | Peripheral   |          |
|---------------|-------------|----------------------|--|----------|
| 0x4000_0000   | 0x4000_0FFF | AHB                  | Flash memory I/F register                          |          |
| 0x4000_1000   | 0x4000_FFFF |                      | Reserved   |          |
| 0x4001_0000   | 0x4001_0FFF | APB0                 | Clock/Reset Control                                |          |
| 0x4001_1000   | 0x4001_1FFF |                      | Hardware Watchdog Timer                            |          |
| 0x4001_2000   | 0x4001_2FFF |                      | Software Watchdog Timer                            |          |
| 0x4001_3000   | 0x4001_4FFF |                      | Reserved   |          |
| 0x4001_5000   | 0x4001_5FFF |                      | Dual-Timer   |          |
| 0x4001_6000   | 0x4001_FFFF |                      | Reserved   |          |
| 0x4002_0000   | 0x4002_0FFF |                      | Reserved   |          |
| 0x4002_1000   | 0x4002_3FFF |                      | Reserved   |          |
| 0x4002_4000   | 0x4002_4FFF | Reserved             |  |          |
| 0x4002_5000   | 0x4002_5FFF | Base Timer           |  |          |
| 0x4002_6000   | 0x4002_6FFF | Reserved             |  |          |
| 0x4002_7000   | 0x4002_7FFF | A/D Converter        |  |          |
| 0x4002_8000   | 0x4002_DFFF | Reserved             |  |          |
| 0x4002_E000   | 0x4002_EFFF | Built-in CR trimming |  |          |
| 0x4002_F000   | 0x4002_FFFF | Reserved             |  |          |
| 0x4003_0000   | 0x4003_0FFF | APB1                 | External Interrupt Controller                      |          |
| 0x4003_1000   | 0x4003_1FFF |                      | Interrupt Request Batch-Read Function              |          |
| 0x4003_2000   | 0x4003_2FFF |                      | Reserved   |          |
| 0x4003_3000   | 0x4003_3FFF |                      | GPIO   |          |
| 0x4003_4000   | 0x4003_4FFF |                      | HDMI-CEC/Remote Control Receiver                   |          |
| 0x4003_5000   | 0x4003_5FFF |                      | Low-Voltage Detection / DS mode / Vref Calibration |          |
| 0x4003_6000   | 0x4003_6FFF |                      | USB Clock Generator                                |          |
| 0x4003_7000   | 0x4003_77FF |                      | Reserved   |          |
| 0x4003_7800   | 0x4003_79FF |                      | I2C Slave  |          |
| 0x4003_7A00   | 0x4003_7FFF |                      | Reserved   |          |
| 0x4003_8000   | 0x4003_8FFF |                      | Multi-function Serial Interface                    |          |
| 0x4003_9000   | 0x4003_9FFF |                      | CRC  |          |
| 0x4003_A000   | 0x4003_AFFF |                      | Watch Counter                                      |          |
| 0x4003_B000   | 0x4003_BFFF |                      | Real-time clock                                    |          |
| 0x4003_C000   | 0x4003_C0FF |                      | Low-speed CR Prescaler                             |          |
| 0x4003_C100   | 0x4003_C7FF |                      | Peripheral Clock Gating                            |          |
| 0x4003_C800   | 0x4003_C8FF |                      | Reserved   |          |
| 0x4003_C900   | 0x4003_C9FF |                      | Smart Card Interface                               |          |
| 0x4003_CA00   | 0x4003_CAFF |                      | MFS-I2S Clock Generator                            |          |
| 0x4003_CB00   | 0x4003_FFFF |                      | Reserved   |          |
| 0x4004_0000   | 0x4004_FFFF |                      | AHB  | USB ch.0 |
| 0x4005_0000   | 0x4006_0FFF |                      |  | Reserved |
| 0x4006_1000   | 0x4006_1FFF |                      |  | DSTC     |
| 0x4006_2000   | 0x41FF_FFFF |                      |  | Reserved |

## 10. Pin Status in Each CPU State

The following table shows pin status in each CPU state.

| Type | Selected Pin Function                          |  | CPU State   |                 |       |       |       |     |     |     |
|------|--|--|---|-----------------|-------|-------|-------|-----|-----|-----|
|      |  |  | (1)   | (2)             | (3)   | (4)   | (5)   | (6) | (7) | (8) |
| A    | Main oscillation circuit selected <sup>3</sup> | Main oscillation circuit selected            | OS  | OS              | OE    | OE    | OE    | OS  | OS  | OS  |
|      | Digital I/O selected <sup>4</sup>              | Main clock external input selected           | -   | -               | IE/IS | IE/IS | IE/IS | IS  | IS  | IS  |
|      |  | GPIO selected                                | -   | -               | PC    | HC    | IS    | HS  | IS  | HS  |
| B    | Main oscillation circuit selected <sup>3</sup> | Main oscillation circuit selected            | OS  | OS              | OE    | OE    | OE    | OS  | OS  | OS  |
|      | Digital I/O selected <sup>4</sup>              | GPIO selected                                | -   | -               | PC    | HC    | IS    | GS  | IS  | GS  |
| C    | Sub oscillation circuit selected <sup>3</sup>  | Sub oscillation circuit selected             | OS  | OE              | OE    | OE    | OE    | OE  | OE  | OE  |
|      | Digital I/O selected <sup>4</sup>              | Sub clock external input selected            | -   | -               | IE/IS | IE/IS | IE/IS | IS  | IS  | IS  |
|      |  | GPIO selected                                | -   | -               | PC    | HC    | IS    | HS  | IS  | HS  |
| D    | Sub oscillation circuit selected <sup>3</sup>  | Sub oscillation circuit selected             | OS  | OE              | OE    | OE    | OE    | OE  | OE  | OE  |
|      | Digital I/O selected <sup>4</sup>              | GPIO selected                                | -   | -               | PC    | HC    | IS    | HS  | IS  | HS  |
| E    | Digital I/O selected                           | INITX input                                  | This pin is digital input pin, pull up resistor is on, and digital input is not shut off in all CPU states. |                 |       |       |       |     |     |     |
| F    | Digital I/O selected                           | MD0 input                                    | This pin is digital input pin, pull up resistor is none, digital input is not shut off in all CPU states.   |                 |       |       |       |     |     |     |
| G    | USB I/O selected <sup>5</sup>                  | USB port selected                            | -   | -               | UE    | US    | US    | US  | US  | US  |
|      | Digital I/O selected <sup>6</sup>              | GPIO selected                                | IS  | IE              | CP    | HC    | IS    | HS  | IS  | HS  |
| H    | Digital I/O selected                           | SW selected                                  | IS  | IP <sup>7</sup> | PC    | IP    | IP    | IP  | IP  | IP  |
|      |  | GPIO selected                                | -   | -               | PC    | HC    | IS    | HS  | IS  | HS  |
| I    | Digital I/O selected                           | NMI selected                                 | -   | -               | IP    | IP    | IP    | -   | -   | -   |
|      |  | WKUP0 enable and input selected              | -   | -               | IP    | IP    | IP    | IP  | IP  | IP  |
|      |  | GPIO selected                                | IS  | IE              | PC    | HC    | IS    | -   | -   | -   |
| J    | Analog input selected <sup>8</sup>             | Analog input selected                        | Analog input is enabled in all CPU state  |                 |       |       |       |     |     |     |
|      | Digital I/O selected <sup>9</sup>              | WKUP enable and input selected               | -   | -               | IP    | IP    | IP    | IP  | IP  | IP  |
|      |  | External interrupt enable and input selected | -   | -               | IP    | IP    | IP    | GS  | IS  | GS  |
|      |  | GPIO selected                                | -   | -               | PC    | HC    | IS    | HS  | IS  | HS  |

<sup>3</sup> In this type, when internal oscillation function is selected, digital output is disabled. (Hi-Z) pull up resistor is off, digital input is shut off by fixed 0.

<sup>4</sup> In this type, when Digital I/O function is selected, internal oscillation function is disabled.

<sup>5</sup> In this type, when USB I/O function is selected, digital output is disabled. (Hi-Z), digital input is shut off by fixed 0.

<sup>6</sup> In this type, when Digital I/O function is selected, USB I/O function is disabled. This pin does not have pull up resistor.

<sup>7</sup> In this case, PCR register is initialized to "1". Pull up resistor is on.

<sup>8</sup> In this type, when analog input function is selected, digital output is disabled, (Hi-Z). pull up resistor is off, digital input is shut off by fixed 0.

<sup>9</sup> In this type, when Digital I/O function is selected, analog input function is not available.



| Type | Selected Pin Function                        | CPU State |     |     |     |     |     |     |     |
|------|--|-----------|-----|-----|-----|-----|-----|-----|-----|
|      |  | (1)       | (2) | (3) | (4) | (5) | (6) | (7) | (8) |
|      | Resource other than above selected           | -         | -   | PC  | HC  | IS  | GS  | IS  | GS  |
| K    | CEC pin selected                             | -         | -   | CP  | CP  | CP  | CP  | CP  | CP  |
|      | WKUP enable and input selected               | -         | -   | IP  | IP  | IP  | IP  | IP  | IP  |
|      | I2CSLAVE enable selected                     | -         | -   | PC  | HC  | IP  | GS  | IS  | GS  |
|      | External interrupt enable and input selected | -         | -   | PC  | HC  | IP  | GS  | IS  | GS  |
|      | GPIO selected                                | IS        | IE  | PC  | HC  | IS  | HS  | IS  | HS  |
|      | Resource other than above selected           | -         | -   | PC  | HC  | IS  | GS  | IS  | GS  |

Terms in the table above have the following meanings.

**Type**

This indicates a pin status type that is shown in “pin list table” in “5. List of Pin Functions”

**Selected Pin function**

This indicates a pin function that is selected by user program.

**CPU state**

This indicates a state of the CPU that is shown below.

- (1) Reset state. CPU is initialized by Power-on reset or a reset due to low Power voltage supply.
- (2) Reset state. CPU is initialized by INITX input signal or system initialization after power on reset.
- (3) Run mode or SLEEP mode state.
- (4) Timer mode, RTC mode or STOP mode state.  
The standby pin level setting bit (SPL) in the Standby Mode Control Register (STB\_CTL) is set to "0".
- (5) Timer mode, RTC mode or STOP mode state.  
The standby pin level setting bit (SPL) in the Standby Mode Control Register (STB\_CTL) is set to "1".
- (6) Deep standby STOP mode or Deep standby RTC mode state,  
The standby pin level setting bit (SPL) in the Standby Mode Control Register (STB\_CTL) is set to "0"
- (7) Deep standby STOP mode or Deep standby RTC mode state,  
The standby pin level setting bit (SPL) in the Standby Mode Control Register (STB\_CTL) is set to "1"
- (8) Run mode state after returning from Deep Standby mode.  
(I/O state hold function(CONTX) is fixed at 1)

### Each pin status

The meaning of the symbols in the pin status table is as follows.

- IS Digital output is disabled. (Hi-Z) Pull up resistor is off. Digital input is shut off by fixed 0.
- IE Digital output is disabled. (Hi-Z) Pull up resistor is off. Digital input is not shut off.
- IP Digital output is disabled. (Hi-Z) Pull up resistor is defined by the value of the PCR register. Digital input is not shut off.
- IE/IS Digital output is disabled. (Hi-Z) Pull up resistor is off. Digital input is shut off in case of the OSC stop. Digital input is not shut off in case of the OSC operation.
- OE The OSC is in operation state. However, it may be stopped in some operation mode of the CPU.  
For detail, see chapter “Low Power Consumption Mode” in peripheral manual.
- OS The OSC is in stop state. (Hi-Z)
- UE USB I/O function is controlled by USB controller.
- US USB I/O function is disabled(Hi-Z)
- PC Digital output and pull up resistor is controlled by the register in the GPIO or peripheral function.  
Digital input is not shut off
- CP Digital output is controlled by the register in the GPIO or peripheral function. Pull up resistor is off.  
Digital input is not shut off.
- HC Digital output and pull up resistor is maintained the status that is immediately prior to entering the current CPU state. Digital input is not shut off
- HS Digital output and pull up resistor is maintained the status that is immediately prior to entering the current CPU state. Digital input is shut off
- GS Digital output and pull up resistor is copied the GPIO status that is immediately prior to entering the current CPU state and the status is maintained. Digital input is shut off.

## 11. Electrical Characteristics

### 11.1 Absolute Maximum Ratings

| Parameter  | Symbol             | Rating                |                                    | Unit | Remarks      |
|--|--------------------|-----------------------|------------------------------------|------|--------------|
|  |                    | Min                   | Max                                |      |              |
| Power supply voltage <sup>10, 11</sup>             | V <sub>CC</sub>    | V <sub>SS</sub> - 0.5 | V <sub>SS</sub> + 4.6              | V    |              |
| Analog reference voltage <sup>10, 12</sup>         | AVRH               | V <sub>SS</sub> - 0.5 | V <sub>SS</sub> + 4.6              | V    |              |
| Input voltage <sup>10</sup>                        | V <sub>I</sub>     | V <sub>SS</sub> - 0.5 | V <sub>CC</sub> + 0.5<br>(≤ 4.6 V) | V    |              |
|  |                    | V <sub>SS</sub> - 0.5 | V <sub>SS</sub> + 6.5              | V    | 5 V tolerant |
| Analog pin input voltage <sup>10</sup>             | V <sub>IA</sub>    | V <sub>SS</sub> - 0.5 | V <sub>CC</sub> + 0.5<br>(≤ 4.6 V) | V    |              |
| Output voltage <sup>10</sup>                       | V <sub>O</sub>     | V <sub>SS</sub> - 0.5 | V <sub>CC</sub> + 0.5<br>(≤ 4.6 V) | V    |              |
| L level maximum output current <sup>13</sup>       | I <sub>OL</sub>    | -                     | 10                                 | mA   | 4 mA type    |
| L level average output current <sup>14</sup>       | I <sub>OLAV</sub>  | -                     | 4                                  | mA   | 4 mA type    |
| L level total maximum output current               | ∑I <sub>OL</sub>   | -                     | 100                                | mA   |              |
| L level total average output current <sup>15</sup> | ∑I <sub>OLAV</sub> | -                     | 50                                 | mA   |              |
| H level maximum output current <sup>13</sup>       | I <sub>OH</sub>    | -                     | - 10                               | mA   | 4 mA type    |
| H level average output current <sup>14</sup>       | I <sub>OHAV</sub>  | -                     | - 4                                | mA   | 4 mA type    |
| H level total maximum output current               | ∑I <sub>OH</sub>   | -                     | - 100                              | mA   |              |
| H level total average output current <sup>15</sup> | ∑I <sub>OHAV</sub> | -                     | - 50                               | mA   |              |
| Power consumption                                  | P <sub>D</sub>     | -                     | 200                                | mW   |              |
| Storage temperature                                | T <sub>STG</sub>   | - 55                  | + 150                              | °C   |              |

**<WARNING>**

- Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

<sup>10</sup> These parameters are based on the condition that V<sub>SS</sub>= 0 V.

<sup>11</sup> V<sub>CC</sub> must not drop below V<sub>SS</sub> - 0.5 V.

<sup>12</sup> Ensure that the voltage does not to exceed V<sub>CC</sub> + 0.5 V at power-on.

<sup>13</sup> The maximum output current is the peak value for a single pin.

<sup>14</sup> The average output is the average current for a single pin over a period of 100 ms.

<sup>15</sup> The total average output current is the average current for all pins over a period of 100 ms.

## 11.2 Recommended Operating Conditions

(V<sub>SS</sub>= 0.0 V)

| Parameter                | Symbol          | Conditions | Value              |                 | Unit | Remarks                     |
|--------------------------|-----------------|------------|--------------------|-----------------|------|-----------------------------|
|                          |                 |            | Min                | Max             |      |                             |
| Power supply voltage     | V <sub>CC</sub> | -          | 1.65 <sup>16</sup> | 3.6             | V    |                             |
|                          |                 |            | 3.0                | 3.6             | V    | <sup>17</sup>               |
| Analog reference voltage | AVRH            | -          | 2.7                | V <sub>CC</sub> | V    | V <sub>CC</sub> ≥ 2.7 V     |
|                          |                 |            | V <sub>CC</sub>    | V <sub>CC</sub> | V    | V <sub>CC</sub> < 2.7 V     |
|                          | AVRL            | -          | V <sub>SS</sub>    | V <sub>SS</sub> | V    |                             |
| Smoothing capacitor      | C <sub>S</sub>  | -          | 1                  | 10              | μF   | For regulator <sup>18</sup> |
| Operating temperature    | T <sub>a</sub>  | -          | - 40               | + 105           | °C   |                             |

### <WARNING>

1. The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.
2. Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.
3. No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet.
4. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

<sup>16</sup> In between less than the minimum power supply voltage reset / interrupt detection voltage or more, instruction execution and low voltage detection function by built-in High-speed CR (including Main PLL is used) or built-in Low-speed CR is possible to operate only.

<sup>17</sup> When P81/UDP0 and P80/UDM0 pins are used as USB (UDP0, UDM0).

<sup>18</sup> See "C Pin" in "8. Handling Devices" for the connection of the smoothing capacitor.

### 11.3 DC Characteristics

#### 11.3.1 Current Rating

| Symbol<br>(Pin Name)                     | Conditions   | HCLK<br>Frequency <sup>19</sup>  | Value  |   | Unit    | Remarks    |         |      |    |    |
|--|--|--|--|---|---------|------------|---------|------|----|----|
|  |  |  | Typ <sup>20</sup>  | Max <sup>21</sup>   |         |            |         |      |    |    |
| I <sub>cc</sub><br>(VCC)                 | Run mode,<br>code executed<br>from Flash   | 8 MHz external clock input, PLL ON <sup>22</sup><br>NOP code executed  | 8 MHz  | 1.4   | 2.7     | mA         | 23      |      |    |    |
|  |  | Built-in high speed CR stopped<br>All peripheral clock stopped by CKENx  | 20 MHz   | 2.6   | 4.1     |            |         |      |    |    |
|  |  |  | 40 MHz   | 3.9   | 5.6     |            |         |      |    |    |
|  | Run mode,<br>code executed<br>from Flash   | 8 MHz external clock input, PLL ON <sup>22</sup><br>Benchmark code executed<br>Built-in high speed CR stopped<br>PCLK1 stopped                   | 8 MHz  | 1.3   | 2.6     | mA         | 23      |      |    |    |
|  |  |  | 20 MHz   | 2.3   | 3.8     |            |         |      |    |    |
|  |  |  | 40 MHz   | 3.4   | 5.1     |            |         |      |    |    |
|  | Run mode,<br>code executed<br>from RAM   | 8 MHz crystal oscillation, PLL ON <sup>22</sup><br>NOP code executed<br>Built-in high speed CR stopped<br>All peripheral clock stopped by CKENx  | 8 MHz  | 1.6   | 3.0     | mA         | 23, 24, |      |    |    |
|  |  |  | 20 MHz   | 2.8   | 4.4     |            |         |      |    |    |
|  |  |  | 40 MHz   | 4.1   | 5.9     |            |         |      |    |    |
|  | Run mode,<br>code executed<br>from RAM   | 8 MHz external clock input, PLL ON <sup>22</sup><br>NOP code executed<br>Built-in high speed CR stopped<br>All peripheral clock stopped by CKENx | 8 MHz  | 1.0   | 2.1     | mA         | 23      |      |    |    |
|  |  |  | 20 MHz   | 1.7   | 2.9     |            |         |      |    |    |
|  |  |  | 40 MHz   | 2.7   | 4.0     |            |         |      |    |    |
| Run mode,<br>code executed<br>from Flash | 8 MHz external clock input, PLL ON<br>NOP code executed<br>Built-in high speed CR stopped<br>PCLK1 stopped | 40 MHz   | 1.6  | 3.1   | mA      | 23, 25, 26 |         |      |    |    |
|  |  | Run mode,<br>code executed<br>from Flash   | Built-in high speed CR <sup>27</sup><br>NOP code executed<br>All peripheral clock stopped by CKENx | 8 MHz   |         |            | 1.1     | 2.4  | mA | 23 |
|  |  |  |  | 32 kHz crystal oscillation<br>NOP code executed<br>All peripheral clock stopped by CKENx  |         |            | 32 kHz  | 240  |    |    |
| Run mode,<br>code executed<br>from Flash | Built-in low speed CR<br>NOP code executed<br>All peripheral clock stopped by CKENx                        | 100 kHz  | 246  | 1271  | μA      | 23         |         |      |    |    |
|  |  | I <sub>ccs</sub><br>(VCC)  | Sleep<br>operation   | 8 MHz external clock input, PLL ON <sup>22</sup><br>All peripheral clock stopped by CKENx | 8 MHz   | 0.8        | 1.9     | mA   | 23 |    |
|  |  |  |  |   | 20 MHz  | 1.3        | 2.4     |      |    |    |
| 40 MHz                                   | 1.8  |  |  |   | 3.0     |            |         |      |    |    |
| I <sub>ccs</sub><br>(VCC)                | Sleep<br>operation   | Built-in high speed CR <sup>27</sup><br>All peripheral clock stopped by CKENx  | 8 MHz  | 0.6   | 1.7     | mA         | 23      |      |    |    |
|  |  |  | 32 kHz crystal oscillation<br>All peripheral clock stopped by CKENx                                | 32 kHz  | 237     |            |         | 1261 | μA | 23 |
|  |  |  |  | Built-in low speed CR<br>All peripheral clock stopped by CKENx                            | 100 kHz |            |         | 238  |    |    |

<sup>19</sup> PCLK0 is set to divided rate 8.

<sup>20</sup> T<sub>A</sub>=+25°C, V<sub>CC</sub>=3.3 V

<sup>21</sup> T<sub>A</sub>=+105°C, V<sub>CC</sub>=3.6 V

<sup>22</sup> When HCLK=8, PLL is off.

<sup>23</sup> All ports are fixed

<sup>24</sup> When IMAINSEL bit (MOSC\_CTL:IMAINSEL) is "10" (default).

<sup>25</sup> Flash sync down is set to FRWTR.RWT=111 and FSYNDN.SD=1111

<sup>26</sup> VCC=1.65 V

<sup>27</sup> The frequency is set to 8 MHz by trimming

| Parameter            | Symbol (Pin Name)       | Conditions     |   | Value |      | Unit | Remarks                       |
|----------------------|-------------------------|----------------|---|-------|------|------|-------------------------------|
|                      |                         |                |   | Typ   | Max  |      |                               |
| Power supply current | I <sub>CCH</sub> (VCC)  | Stop mode      | Ta=25°C<br>Vcc=3.3 V                                | 12.4  | 52.4 | μA   | <sup>28</sup> , <sup>29</sup> |
|                      |                         |                | Ta=25°C<br>Vcc=1.65 V                               | 12.0  | 52.0 | μA   | <sup>28</sup> , <sup>29</sup> |
|                      |                         |                | Ta=105°C<br>Vcc=3.6 V                               | -     | 597  | μA   | <sup>28</sup> , <sup>29</sup> |
|                      | I <sub>CCCT</sub> (VCC) | Sub timer mode | Ta=25°C<br>Vcc=3.3 V<br>32 kHz Crystal oscillation  | 15.6  | 55.6 | μA   | <sup>28</sup> , <sup>29</sup> |
|                      |                         |                | Ta=25°C<br>Vcc=1.65 V<br>32 kHz Crystal oscillation | 15.0  | 55.0 | μA   | <sup>28</sup> , <sup>29</sup> |
|                      |                         |                | Ta=105°C<br>Vcc=3.6 V<br>32 kHz Crystal oscillation | -     | 601  | μA   | <sup>28</sup> , <sup>29</sup> |
|                      | I <sub>CCR</sub> (VCC)  | RTC mode       | Ta=25°C<br>Vcc=3.3 V<br>32 kHz Crystal oscillation  | 13.2  | 53.2 | μA   | <sup>28</sup> , <sup>29</sup> |
|                      |                         |                | Ta=25°C<br>Vcc=1.65 V<br>32 kHz Crystal oscillation | 12.7  | 52.7 | μA   | <sup>28</sup> , <sup>29</sup> |
|                      |                         |                | Ta=105°C<br>Vcc=3.6 V<br>32 kHz Crystal oscillation | -     | 598  | μA   | <sup>28</sup> , <sup>29</sup> |

<sup>28</sup> All ports are fixed. LVD off. Flash off.

<sup>29</sup> When CALDONE bit(CAL\_CTL:CALDONE) is "1". In case of "0", Bipolar Vref current is added.

| Parameter            | Symbol (Pin Name)       | Conditions             |         |                       | Value |      | Unit | Remarks |
|----------------------|-------------------------|------------------------|---------|-----------------------|-------|------|------|---------|
|                      |                         |                        |         |                       | Typ   | Max  |      |         |
| Power supply current | I <sub>CCHD</sub> (VCC) | Deep standby Stop mode | RAM off | Ta=25°C<br>Vcc=3.3 V  | 0.58  | 1.85 | μA   | 30, 31  |
|                      |                         |                        |         | Ta=25°C<br>Vcc=1.65 V | 0.56  | 1.83 | μA   | 30, 31  |
|                      |                         |                        |         | Ta=105°C<br>Vcc=3.6 V | -     | 46   | μA   | 30, 31  |
|                      |                         |                        | RAM on  | Ta=25°C<br>Vcc=3.3 V  | 0.78  | 6.6  | μA   | 30, 31  |
|                      |                         |                        |         | Ta=25°C<br>Vcc=1.65 V | 0.76  | 6.6  | μA   | 30, 31  |
|                      |                         |                        |         | Ta=105°C<br>Vcc=3.6 V | -     | 88   | μA   | 30, 31  |
|                      | I <sub>CCRD</sub> (VCC) | Deep standby RTC mode  | RAM off | Ta=25°C<br>Vcc=3.3 V  | 1.16  | 2.4  | μA   | 30, 31  |
|                      |                         |                        |         | Ta=25°C<br>Vcc=1.65 V | 1.15  | 2.4  | μA   | 30, 31  |
|                      |                         |                        |         | Ta=105°C<br>Vcc=3.6 V | -     | 46   | μA   | 30, 31  |
|                      |                         |                        | RAM on  | Ta=25°C<br>Vcc=3.3 V  | 1.37  | 7.2  | μA   | 30, 31  |
|                      |                         |                        |         | Ta=25°C<br>Vcc=1.65 V | 1.35  | 7.2  | μA   | 30, 31  |
|                      |                         |                        |         | Ta=105°C<br>Vcc=3.6 V | -     | 88   | μA   | 30, 31  |

<sup>30</sup> All ports are fixed. LVD off.

<sup>31</sup> When CALDONE bit(CAL\_CTL:CALDONE) is "1". In case of "0", Bipolar Vref current is added.

**LVD Current**

 (V<sub>CC</sub>=1.65 V to 3.6 V, V<sub>SS</sub>= 0 V, T<sub>A</sub>=- 40°C to +105°C)

| Parameter  | Symbol              | Pin Name | Conditions   | Value |     | Unit | Remarks                     |
|--|---------------------|----------|--------------|-------|-----|------|-----------------------------|
|  |                     |          |              | Typ   | Max |      |                             |
| Low-Voltage detection circuit (LVD) power supply current | I <sub>CC</sub> LVD | VCC      | At operation | 0.15  | 0.3 | μA   | For occurrence of reset     |
|  |                     |          |              | 0.10  | 0.3 | μA   | For occurrence of interrupt |

**Bipolar Vref Current**

 (V<sub>CC</sub>=1.65 V to 3.6 V, V<sub>SS</sub>= 0 V, T<sub>A</sub>=- 40°C to +105°C)

| Parameter            | Symbol              | Pin Name | Conditions   | Value |     | Unit | Remarks |
|----------------------|---------------------|----------|--------------|-------|-----|------|---------|
|                      |                     |          |              | Typ   | Max |      |         |
| Bipolar Vref Current | I <sub>CC</sub> BGR | VCC      | At operation | 100   | 200 | μA   |         |

**Flash Memory Current**

 (V<sub>CC</sub>=1.65 V to 3.6 V, V<sub>SS</sub>= 0 V, T<sub>A</sub>=- 40°C to +105°C)

| Parameter                        | Symbol                | Pin Name | Conditions     | Value |     | Unit | Remarks |
|----------------------------------|-----------------------|----------|----------------|-------|-----|------|---------|
|                                  |                       |          |                | Typ   | Max |      |         |
| Flash memory write/erase current | I <sub>CC</sub> FLASH | VCC      | At Write/Erase | 4.4   | 5.6 | mA   |         |

**A/D converter Current**

 (V<sub>CC</sub>=1.65 V to 3.6 V, V<sub>SS</sub>= 0 V, T<sub>A</sub>=- 40°C to +105°C)

| Parameter                             | Symbol               | Pin Name | Conditions   | Value |      | Unit | Remarks    |
|---------------------------------------|----------------------|----------|--------------|-------|------|------|------------|
|                                       |                      |          |              | Typ   | Max  |      |            |
| Power supply current                  | I <sub>CC</sub> AD   | VCC      | At operation | 0.5   | 0.75 | mA   |            |
| Reference power supply current (AVRH) | I <sub>CC</sub> AVRH | AVRH     | At operation | 0.69  | 1.3  | mA   | AVRH=3.6 V |
|                                       |                      |          | At stop      | 0.1   | 1.3  | μA   |            |



**Peripheral Current Dissipation**

(V<sub>CC</sub>=1.65 V to 3.6 V, V<sub>SS</sub>=0 V, T<sub>A</sub>=- 40°C to +105°C)

| Clock System | Peripheral            | Conditions             | Frequency (MHz) |      |      | Unit | Remarks       |
|--------------|-----------------------|------------------------|-----------------|------|------|------|---------------|
|              |                       |                        | 8               | 20   | 40   |      |               |
| HCLK         | GPIO                  | At all ports operation | 0.05            | 0.12 | 0.23 | mA   |               |
|              | DSTC                  | At 2ch operation       | 0.02            | 0.06 | 0.10 |      |               |
|              | USB                   | At 1ch operation       | 0.13            | 0.13 | 0.13 | mA   | <sup>32</sup> |
| PCLK1        | Base timer            | At 4ch operation       | 0.02            | 0.05 | 0.10 | mA   |               |
|              | ADC                   | At 1 unit operation    | 0.04            | 0.10 | 0.21 |      |               |
|              | Multi-function serial | At 1ch operation       | 0.01            | 0.03 | 0.06 |      |               |
|              | MFS-I2S               | At 1ch operation       | 0.02            | 0.05 | 0.08 |      |               |
|              | Smart Card I/F        | At 1ch operation       | 0.04            | 0.08 | 0.18 |      |               |

<sup>32</sup> USB itself uses 48 MHz clock

**11.3.3 Pin Characteristics**

 ( $V_{CC} = 1.65\text{ V to }3.6\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ,  $T_A = -40^\circ\text{C to }+105^\circ\text{C}$ )

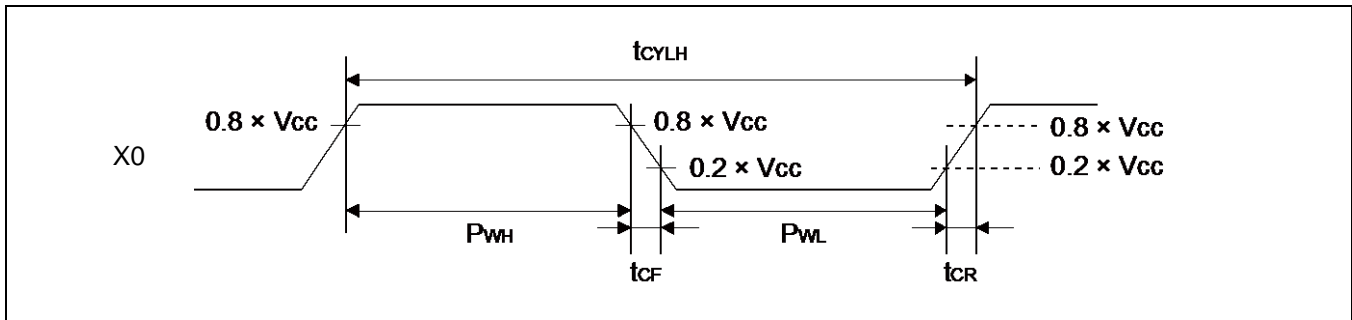
| Parameter                                | Symbol    | Pin Name                       | Conditions   | Value               |     |                     | Unit          | Remarks |
|--|-----------|--------------------------------|--|---------------------|-----|---------------------|---------------|---------|
|  |           |                                |  | Min                 | Typ | Max                 |               |         |
| H level input voltage (hysteresis input) | $V_{IHS}$ | CMOS hysteresis input pin, MD0 | $V_{CC} \geq 2.7\text{ V}$                           | $V_{CC} \times 0.8$ | -   | $V_{CC} + 0.3$      | V             |         |
|  |           |                                | $V_{CC} < 2.7\text{ V}$                              | $V_{CC} \times 0.7$ |     |                     |               |         |
|  |           | 5 V tolerant input pin         | $V_{CC} \geq 2.7\text{ V}$                           | $V_{CC} \times 0.8$ | -   | $V_{SS} + 5.5$      | V             |         |
|  |           |                                | $V_{CC} < 2.7\text{ V}$                              | $V_{CC} \times 0.7$ |     |                     |               |         |
| L level input voltage (hysteresis input) | $V_{ILS}$ | CMOS hysteresis input pin, MD0 | $V_{CC} \geq 2.7\text{ V}$                           | $V_{SS} - 0.3$      | -   | $V_{CC} \times 0.2$ | V             |         |
|  |           |                                | $V_{CC} < 2.7\text{ V}$                              |                     |     | $V_{CC} \times 0.3$ |               |         |
|  |           | 5 V tolerant input pin         | $V_{CC} \geq 2.7\text{ V}$                           | $V_{SS} - 0.3$      | -   | $V_{CC} \times 0.2$ | V             |         |
|  |           |                                | $V_{CC} < 2.7\text{ V}$                              |                     | -   | $V_{CC} \times 0.3$ |               |         |
| H level output voltage                   | $V_{OH}$  | 4 mA type                      | $V_{CC} \geq 2.7\text{ V}$ , $I_{OH} = -4\text{ mA}$ | $V_{CC} - 0.5$      | -   | $V_{CC}$            | V             |         |
|  |           |                                | $V_{CC} < 2.7\text{ V}$ , $I_{OH} = -2\text{ mA}$    | $V_{CC} - 0.45$     |     |                     |               |         |
| L level output voltage                   | $V_{OL}$  | 4 mA type                      | $V_{CC} \geq 2.7\text{ V}$ , $I_{OL} = 4\text{ mA}$  | $V_{SS}$            | -   | 0.4                 | V             |         |
|  |           |                                | $V_{CC} < 2.7\text{ V}$ , $I_{OL} = 2\text{ mA}$     |                     |     |                     |               |         |
| Input leak current                       | $I_{IL}$  | -                              | -  | -5                  | -   | +5                  | $\mu\text{A}$ |         |
| Pull-up resistance value                 | $R_{PU}$  | Pull-up pin                    | $V_{CC} \geq 2.7\text{ V}$                           | 21                  | 33  | 48                  | k $\Omega$    |         |
|  |           |                                | $V_{CC} < 2.7\text{ V}$                              | -                   | -   | 88                  |               |         |
| Input capacitance                        | $C_{IN}$  | Other than VCC, VSS, AVRH      | -  | -                   | 5   | 15                  | pF            |         |

**11.4 AC Characteristics**

**11.4.1 Main Clock Input Characteristics**

( $V_{CC}$  = 1.65 V to 3.6 V,  $V_{SS}$  = 0 V,  $T_A$  = -40°C to +105°C)

| Parameter   | Symbol                 | Pin name  | Conditions                               | Value |                                 | Unit | Remarks                                  |
|---|------------------------|-----------|--|-------|---------------------------------|------|--|
|   |                        |           |  | Min   | Max                             |      |  |
| Input frequency                                   | $F_{CH}$               | X0,<br>X1 | $V_{CC} \geq 2.7V$                       | 8     | 48                              | MHz  | When the crystal oscillator is connected |
|   |                        |           | $V_{CC} < 2.7V$                          | 8     | 20                              |      |  |
| -   | 8                      |           | 48                                       | MHz   | When the external clock is used |      |  |
| Input clock cycle                                 | $t_{CYLH}$             |           | -  | 20.83 | 125                             | ns   | When the external clock is used          |
| Input clock pulse width                           | -                      |           | $P_{WH}/t_{CYLH}$ ,<br>$P_{WL}/t_{CYLH}$ | 45    | 55                              | %    | When the external clock is used          |
| Input clock rising time and falling time          | $t_{CF}$ ,<br>$t_{CR}$ |           | -  | -     | 5                               | ns   | When the external clock is used          |
| Internal operating clock <sup>33</sup> frequency  | $F_{CM}$               | -         | -  | -     | 40.8                            | MHz  | Master clock                             |
|   | $F_{CC}$               | -         | -  | -     | 40.8                            | MHz  | Base clock (HCLK/FCLK)                   |
|   | $F_{CP0}$              | -         | -  | -     | 40.8                            | MHz  | APB0 bus clock <sup>34</sup>             |
|   | $F_{CP1}$              | -         | -  | -     | 40.8                            | MHz  | APB1 bus clock <sup>34</sup>             |
| Internal operating clock <sup>33</sup> cycle time | $t_{CYCCM}$            | -         | -  | 24.5  | -                               | ns   | Master clock                             |
|   | $t_{CYCC}$             | -         | -  | 24.5  | -                               | ns   | Base clock (HCLK/FCLK)                   |
|   | $t_{CYCP0}$            | -         | -  | 24.5  | -                               | ns   | APB0 bus clock <sup>34</sup>             |
|   | $t_{CYCP1}$            | -         | -  | 24.5  | -                               | ns   | APB1 bus clock <sup>34</sup>             |



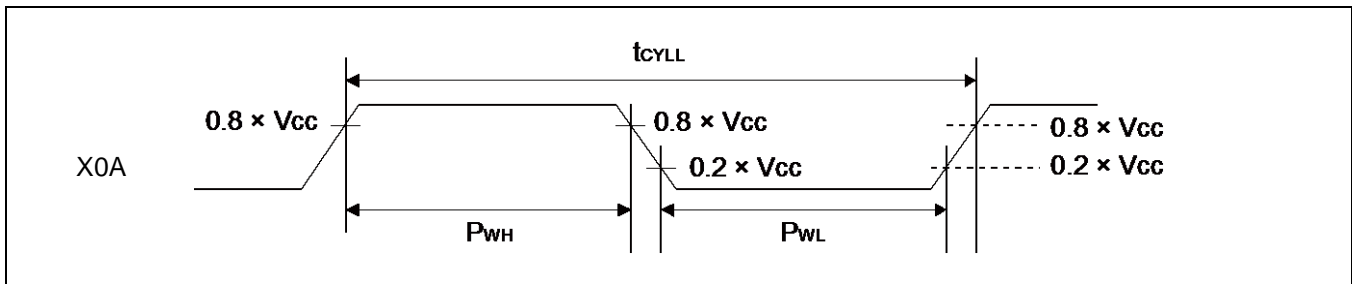
<sup>33</sup> For details of each internal operating clock, refer to "Chapter: Clock" in "FM0+ Family Peripheral Manual".

<sup>34</sup> For details of the APB bus to which a peripheral is connected, see the [Peripheral Address Map](#).

**11.4.2 Sub Clock Input Characteristics<sup>35</sup>**

( $V_{CC} = 1.65\text{ V to }3.6\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ,  $T_A = -40^\circ\text{C to }+105^\circ\text{C}$ )

| Parameter               | Symbol     | Pin Name    | Conditions                               | Value |        |       | Unit          | Remarks                                  |
|-------------------------|------------|-------------|--|-------|--------|-------|---------------|--|
|                         |            |             |  | Min   | Typ    | Max   |               |  |
| Input frequency         | $f_{CL}$   | X0A,<br>X1A | -  | -     | 32.768 | -     | kHz           | When the crystal oscillator is connected |
|                         |            |             | -  | 32    | -      | 100   | kHz           | When the external clock is used          |
| Input clock cycle       | $t_{CYLL}$ |             | -  | 10    | -      | 31.25 | $\mu\text{s}$ | When the external clock is used          |
| Input clock pulse width | -          |             | $P_{WH}/t_{CYLL}$ ,<br>$P_{WL}/t_{CYLL}$ | 45    | -      | 55    | %             | When the external clock is used          |



<sup>35</sup> See "Sub crystal oscillator" in "11. Handling Devices" for the crystal oscillator used.

### 11.4.3 Built-in CR Oscillation Characteristics

#### Built-in High-Speed CR

( $V_{CC}$  = 1.65 V to 3.6 V,  $V_{SS}$  = 0 V,  $T_A$  = - 40°C to +105°C)

| Parameter                    | Symbol     | Conditions  | Value |     |      | Unit          | Remarks                      |
|------------------------------|------------|---|-------|-----|------|---------------|------------------------------|
|                              |            |   | Min   | Typ | Max  |               |                              |
| Clock frequency              | $F_{CRH}$  | $T_a = - 10^\circ\text{C}$ to $+ 105^\circ\text{C}$ , | 7.92  | 8   | 8.08 | MHz           | After trimming <sup>36</sup> |
|                              |            | $T_a = - 40^\circ\text{C}$ to $+ 105^\circ\text{C}$ , | 7.84  | 8   | 8.16 | MHz           |                              |
| Frequency stabilization time | $t_{CRWT}$ | -   | -     | -   | 300  | $\mu\text{s}$ | <sup>37</sup>                |

#### Built-in Low-Speed CR

( $V_{CC}$  = 1.65 V to 3.6 V,  $V_{SS}$  = 0 V,  $T_A$  = - 40°C to +105°C)

| Parameter       | Symbol    | Conditions | Value |     |     | Unit | Remarks |
|-----------------|-----------|------------|-------|-----|-----|------|---------|
|                 |           |            | Min   | Typ | Max |      |         |
| Clock frequency | $f_{CRL}$ | -          | 50    | 100 | 150 | kHz  |         |

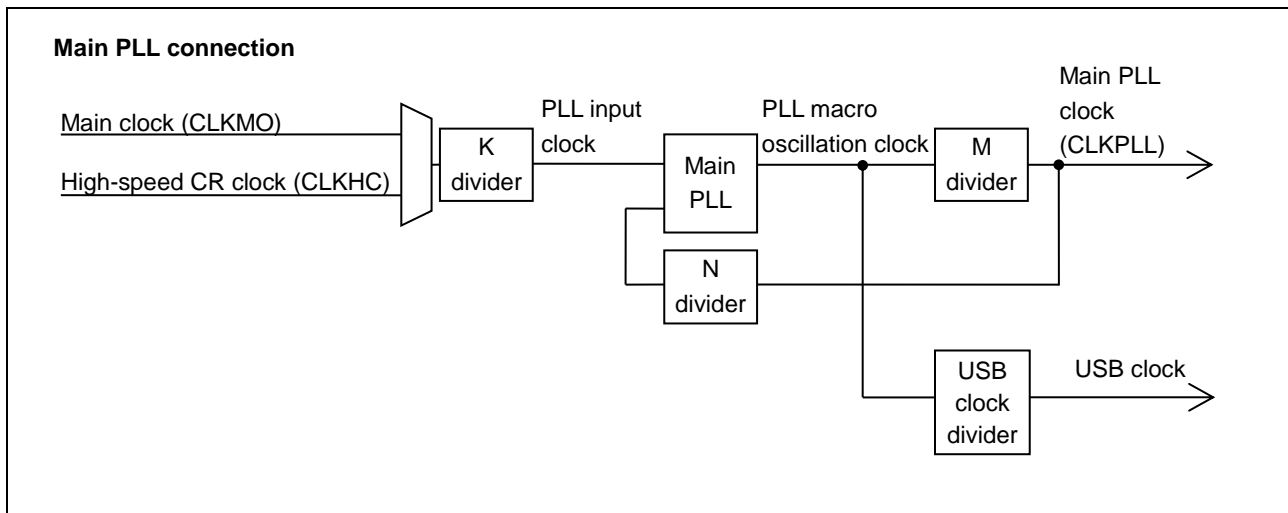
<sup>36</sup> In the case of using the values in CR trimming area of Flash memory at shipment for frequency trimming/temperature trimming.

<sup>37</sup> This is time from the trim value setting to stable of the frequency of the High-speed CR clock.

After setting the trim value, the period when the frequency stability time passes can use the High-speed CR clock as a source clock.

**11.4.4 Operating Conditions of Main PLL  
(In the Case of Using the Main Clock as the Input Clock of the PLL)**
 $(V_{CC} = 1.65\text{ V to } 3.6\text{ V}, V_{SS} = 0\text{ V}, T_A = -40^\circ\text{C to } +105^\circ\text{C})$ 

| Parameter   | Symbol        | Value |     |     | Unit          | Remarks |
|---|---------------|-------|-----|-----|---------------|---------|
|   |               | Min   | Typ | Max |               |         |
| PLL oscillation stabilization wait time <sup>38</sup><br>(LOCK UP time) | $t_{LOCK}$    | 50    | -   | -   | $\mu\text{s}$ |         |
| PLL input clock frequency   | $F_{PLLI}$    | 8     | -   | 16  | MHz           |         |
| PLL multiple rate   | -             | 5     | -   | 18  | multiple      |         |
| PLL macro oscillation clock frequency                                   | $F_{PLLO}$    | 75    | -   | 150 | MHz           |         |
| Main PLL clock frequency <sup>39</sup>                                  | $F_{CLKPLL}$  | -     | -   | 40  | MHz           |         |
| USB clock frequency <sup>40</sup>                                       | $F_{CLKSPLL}$ | -     | -   | 48  | MHz           |         |


**11.4.5 Operating Conditions of Main PLL  
(In the Case of Using the Built-in High-Speed CR Clock as the Input Clock of the Main PLL)**
 $(V_{CC} = 1.65\text{ V to } 3.6\text{ V}, V_{SS} = 0\text{ V}, T_A = -40^\circ\text{C to } +105^\circ\text{C})$ 

| Parameter   | Symbol       | Value |     |      | Unit          | Remarks |
|---|--------------|-------|-----|------|---------------|---------|
|   |              | Min   | Typ | Max  |               |         |
| PLL oscillation stabilization wait time <sup>41</sup><br>(LOCK UP time) | $t_{LOCK}$   | 50    | -   | -    | $\mu\text{s}$ |         |
| PLL input clock frequency   | $F_{PLLI}$   | 7.84  | 8   | 8.16 | MHz           |         |
| PLL multiple rate   | -            | 9     | -   | 18   | multiple      |         |
| PLL macro oscillation clock frequency                                   | $F_{PLLO}$   | 75    | -   | 150  | MHz           |         |
| Main PLL clock frequency <sup>42</sup>                                  | $F_{CLKPLL}$ | -     | -   | 40.8 | MHz           |         |

**Note:**

- For the main PLL source clock, input the high-speed CR clock (CLKHC) whose frequency and temperature have been trimmed. When setting PLL multiple rate, please take the accuracy of the built-in High-speed CR clock into account and prevent the master clock from exceeding the maximum frequency.

<sup>38</sup> The wait time is the time it takes for PLL oscillation to stabilize.

<sup>39</sup> For details of the main PLL clock (CLKPLL), refer to "Chapter: Clock" in "FM0+ Family Peripheral Manual".

<sup>40</sup> For more information about USB clock, see "Chapter: USB Clock Generation" in "FM0+ Family Peripheral Manual Communication Macro Part".

<sup>41</sup> The wait time is the time it takes for PLL oscillation to stabilize.

<sup>42</sup> For details of the main PLL clock (CLKPLL), refer to "Chapter: Clock" in "FM0+ Family Peripheral Manual".

**11.4.6 Reset Input Characteristics**

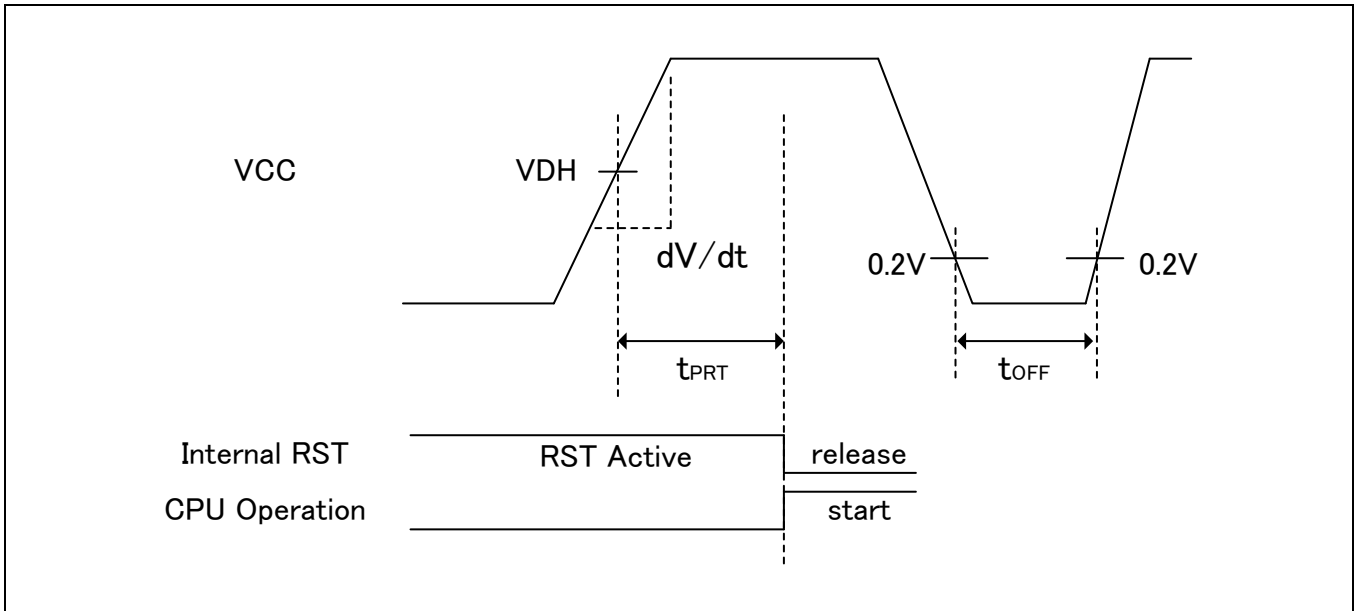
( $V_{CC} = 1.65\text{ V to }3.6\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ,  $T_A = -40^\circ\text{C to }+105^\circ\text{C}$ )

| Parameter        | Symbol      | Pin Name | Conditions | Value |     | Unit | Remarks |
|------------------|-------------|----------|------------|-------|-----|------|---------|
|                  |             |          |            | Min   | Max |      |         |
| Reset input time | $t_{INITX}$ | INITX    | -          | 500   | -   | ns   |         |

**11.4.7 Power-on Reset Timing**

( $V_{CC} = 1.65\text{ V to }3.6\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ,  $T_A = -40^\circ\text{C to }+105^\circ\text{C}$ )

| Parameter                           | Symbol    | Pin Name | Condition                             | Value |     |      | Unit        | Remarks  |
|-------------------------------------|-----------|----------|---------------------------------------|-------|-----|------|-------------|--|
|                                     |           |          |                                       | Min   | Typ | Max  |             |  |
| Power supply shut down time         | $t_{OFF}$ | VCC      | -                                     | 2     | -   | -    | ms          | $V_{CC}$ must be held below 0.2V for a minimum period of $t_{OFF}$ . Improper initialization may occur if this condition is not met. |
| Power ramp rate                     | dV/dt     |          | $V_{CC}: 0.2\text{V to }1.65\text{V}$ | 0.6   | -   | 1000 | mV/ $\mu$ s | This dV/dt characteristic is applied at the power-on of cold start ( $t_{OFF} > 2\text{ms}$ ).                                       |
| Time until releasing Power-on reset | $t_{PRT}$ |          | -                                     | 0.43  | -   | 3.4  | ms          |  |



Glossary

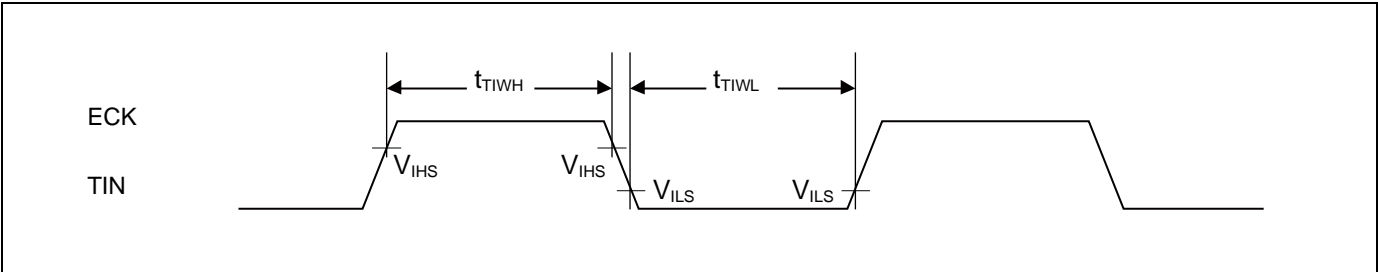
- VDH: detection voltage of Low-Voltage detection reset. See "11.7 Low-Voltage Detection Characteristics".

**11.4.8 Base Timer Input Timing**

**Timer Input Timing**

( $V_{CC}$ = 1.65 V to 3.6 V,  $V_{SS}$ = 0 V,  $T_A$ =- 40°C to +105°C)

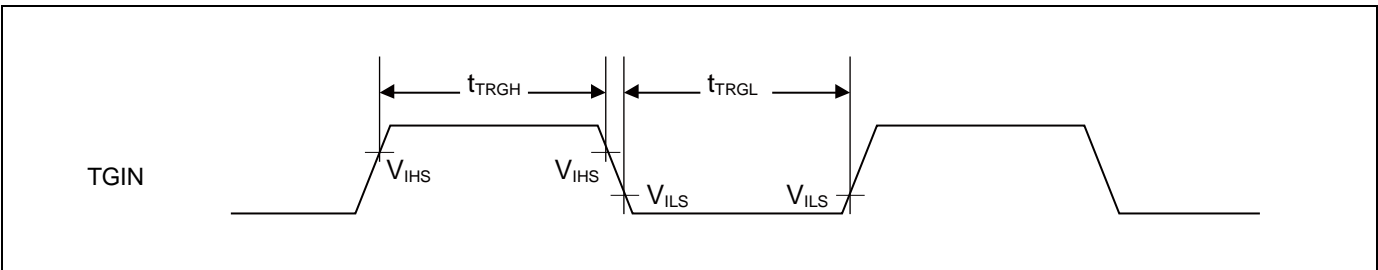
| Parameter         | Symbol                  | Pin Name                                   | Conditions | Value        |     | Unit | Remarks |
|-------------------|-------------------------|--|------------|--------------|-----|------|---------|
|                   |                         |  |            | Min          | Max |      |         |
| Input pulse width | $t_{TIWH}$ , $t_{TIWL}$ | TIOAn/TIOBn<br>(when using as<br>ECK, TIN) | -          | $2 t_{CYCP}$ | -   | ns   |         |



**Trigger Input Timing**

( $V_{CC}$ = 1.65 V to 3.6 V,  $V_{SS}$ = 0 V,  $T_A$ =- 40°C to +105°C)

| Parameter         | Symbol                  | Pin Name                               | Conditions | Value        |     | Unit | Remarks |
|-------------------|-------------------------|--|------------|--------------|-----|------|---------|
|                   |                         |  |            | Min          | Max |      |         |
| Input pulse width | $t_{TRGH}$ , $t_{TRGL}$ | TIOAn/TIOBn<br>(when using as<br>TGIN) | -          | $2 t_{CYCP}$ | -   | ns   |         |



**Note:**

- $t_{CYCP}$  indicates the APB bus clock cycle time.  
For the number of the APB bus to which the Base Timer has been connected, see the [Peripheral Address Map](#)
- "



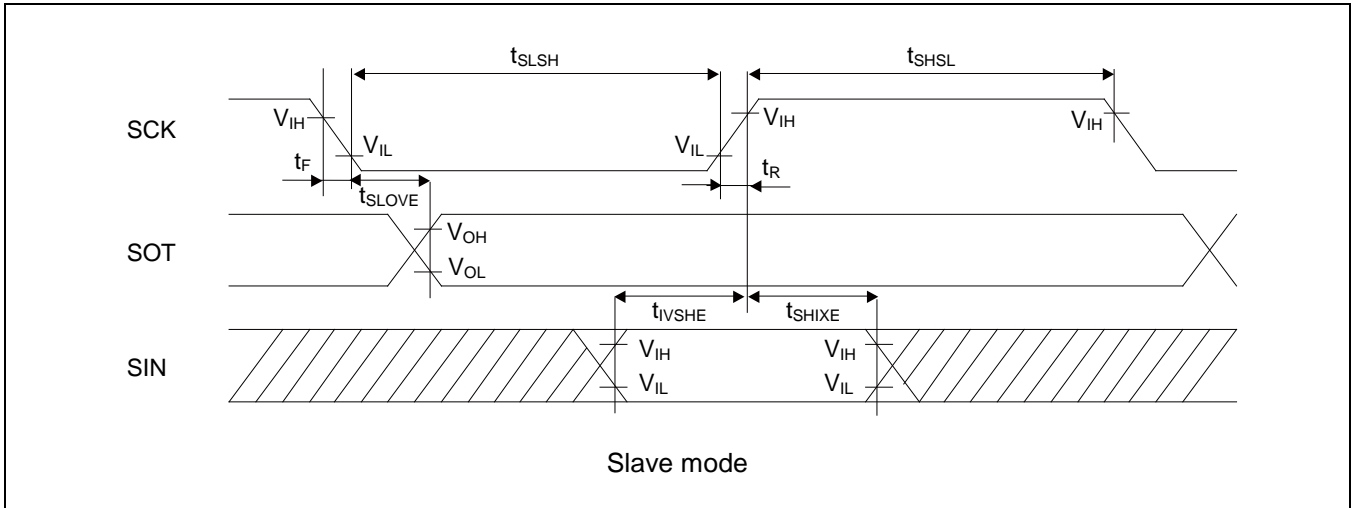
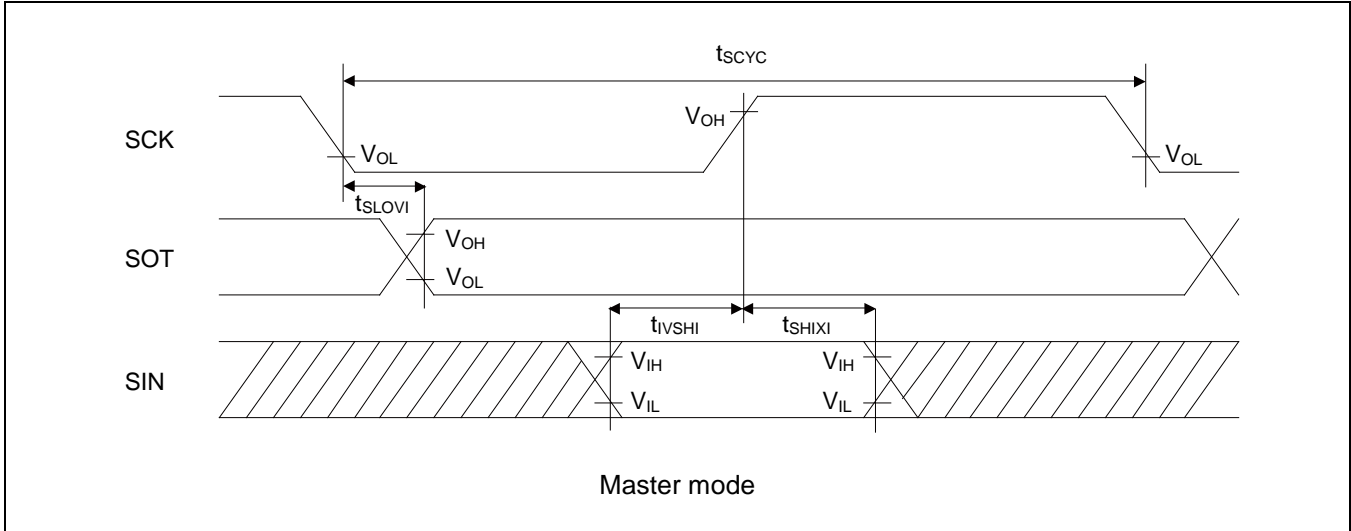
**11.4.9 CSIO/SPI/UART Timing**
**CSIO (SPI=0, SCINV=0)**

 (V<sub>CC</sub>= 1.65 V to 3.6 V, V<sub>SS</sub>= 0 V, T<sub>A</sub>=- 40°C to +105°C)

| Parameter                    | Symbol             | Pin name      | Conditions  | V <sub>CC</sub> < 2.7 V  |      | V <sub>CC</sub> ≥ 2.7 V  |      | Unit |
|------------------------------|--------------------|---------------|-------------|--------------------------|------|--------------------------|------|------|
|                              |                    |               |             | Min                      | Max  | Min                      | Max  |      |
| Serial clock cycle time      | t <sub>SCYC</sub>  | SCKx          | Master mode | 4 t <sub>CYCP</sub>      | -    | 4 t <sub>CYCP</sub>      | -    | ns   |
| SCK ↓ → SOT delay time       | t <sub>SLOVI</sub> | SCKx,<br>SOTx |             | - 30                     | + 30 | - 20                     | + 20 | ns   |
| SIN → SCK ↑ setup time       | t <sub>IVSHI</sub> | SCKx,<br>SINx |             | 50                       | -    | 36                       | -    | ns   |
| SCK ↑ → SIN hold time        | t <sub>SHIXI</sub> | SCKx,<br>SINx |             | 0                        | -    | 0                        | -    | ns   |
| Serial clock "L" pulse width | t <sub>SLSH</sub>  | SCKx          | Slave mode  | 2 t <sub>CYCP</sub> - 10 | -    | 2 t <sub>CYCP</sub> - 10 | -    | ns   |
| Serial clock "H" pulse width | t <sub>SHSL</sub>  | SCKx          |             | t <sub>CYCP</sub> + 10   | -    | t <sub>CYCP</sub> + 10   | -    | ns   |
| SCK ↓ → SOT delay time       | t <sub>SLOVE</sub> | SCKx,<br>SOTx |             | -                        | 50   | -                        | 30   | ns   |
| SIN → SCK ↑ setup time       | t <sub>IVSHE</sub> | SCKx,<br>SINx |             | 10                       | -    | 10                       | -    | ns   |
| SCK ↑ → SIN hold time        | t <sub>SHIXE</sub> | SCKx,<br>SINx |             | 20                       | -    | 20                       | -    | ns   |
| SCK falling time             | t <sub>F</sub>     | SCKx          |             | -                        | 5    | -                        | 5    | ns   |
| SCK rising time              | t <sub>R</sub>     | SCKx          |             | -                        | 5    | -                        | 5    | ns   |

**Notes:**

- The above AC characteristics are for clock synchronous mode.
- t<sub>CYCP</sub> indicates the APB bus clock cycle time.  
For the number of the APB bus to which the Base Timer has been connected, see the [Peripheral Address Map](#).
- The characteristics are applicable only when the relocate port numbers are the same.  
For instance, they are not applicable for the combination of SCKx\_0 and SOTx\_1.
- External load capacitance C<sub>L</sub>=30 pF



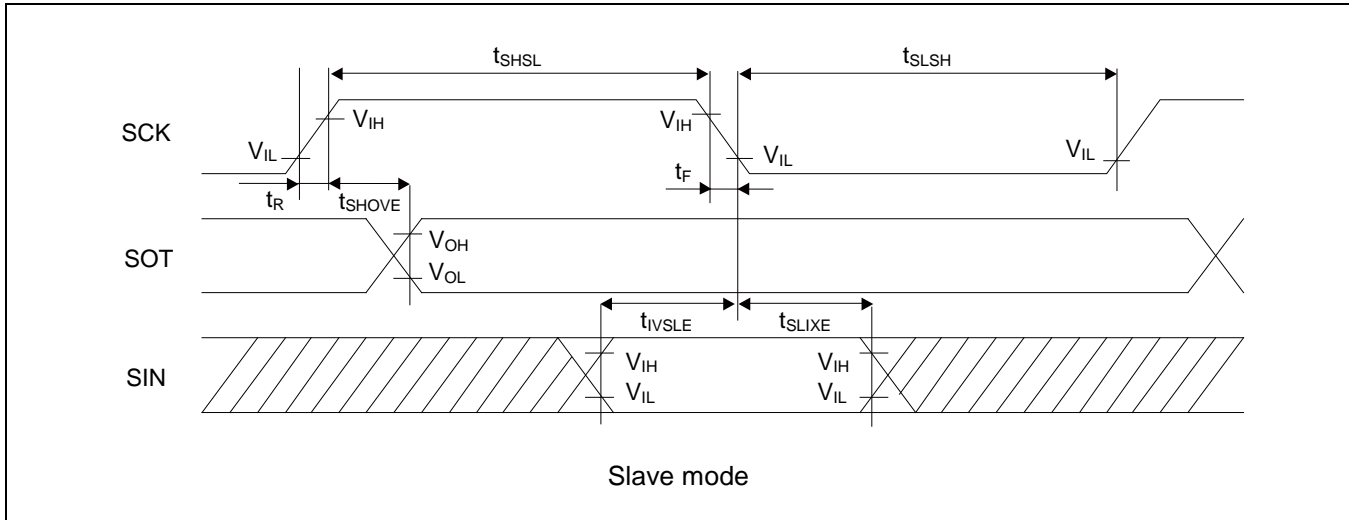
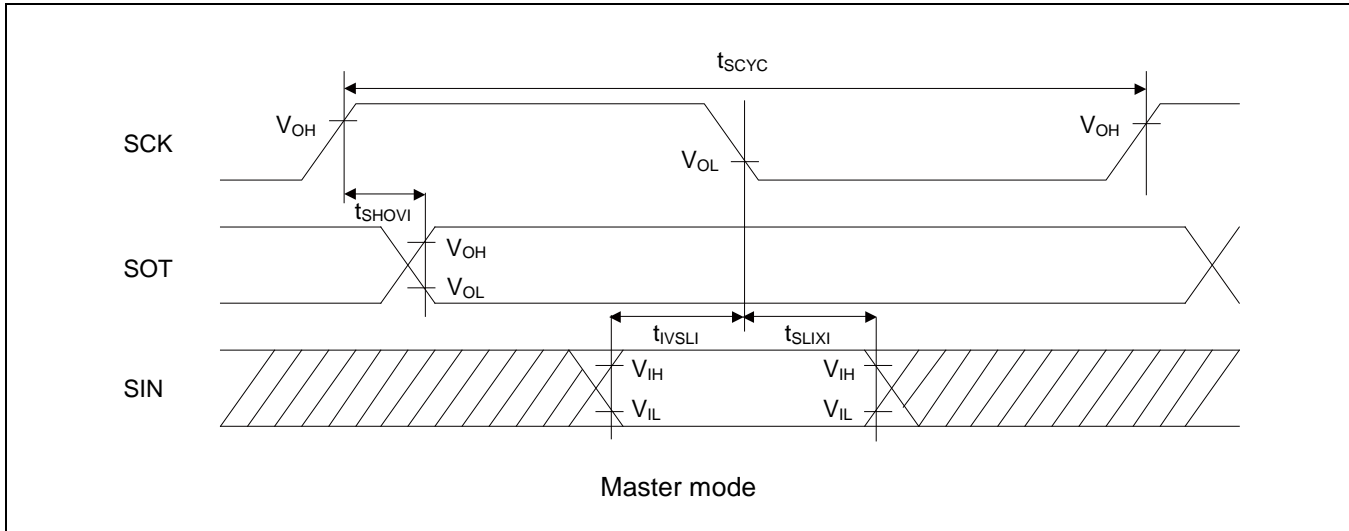
**CSIO (SPI=0, SCINV=1)**

( $V_{CC}$  = 1.65 V to 3.6 V,  $V_{SS}$  = 0 V,  $T_A$  = -40°C to +105°C)

| Parameter                    | Symbol      | Pin name   | Conditions  | $V_{CC} < 2.7V$   |      | $V_{CC} \geq 2.7V$ |      | Unit |
|------------------------------|-------------|------------|-------------|-------------------|------|--------------------|------|------|
|                              |             |            |             | Min               | Max  | Min                | Max  |      |
| Serial clock cycle time      | $t_{SCYC}$  | SCKx       | Master mode | 4 $t_{CYCP}$      | -    | 4 $t_{CYCP}$       | -    | ns   |
| SCK ↑ → SOT delay time       | $t_{SHOVI}$ | SCKx, SOTx |             | - 30              | + 30 | - 20               | + 20 | ns   |
| SIN → SCK ↓ setup time       | $t_{IVSLI}$ | SCKx, SINx |             | 50                | -    | 36                 | -    | ns   |
| SCK ↓ → SIN hold time        | $t_{SLIXI}$ | SCKx, SINx |             | 0                 | -    | 0                  | -    | ns   |
| Serial clock "L" pulse width | $t_{SLSH}$  | SCKx       | Slave mode  | 2 $t_{CYCP}$ - 10 | -    | 2 $t_{CYCP}$ - 10  | -    | ns   |
| Serial clock "H" pulse width | $t_{SHSL}$  | SCKx       |             | $t_{CYCP}$ + 10   | -    | $t_{CYCP}$ + 10    | -    | ns   |
| SCK ↑ → SOT delay time       | $t_{SHOVE}$ | SCKx, SOTx |             | -                 | 50   | -                  | 33   | ns   |
| SIN → SCK ↓ setup time       | $t_{IVSLE}$ | SCKx, SINx |             | 10                | -    | 10                 | -    | ns   |
| SCK ↓ → SIN hold time        | $t_{SLIXE}$ | SCKx, SINx |             | 20                | -    | 20                 | -    | ns   |
| SCK falling time             | tF          | SCKx       |             | -                 | 5    | -                  | 5    | ns   |
| SCK rising time              | tR          | SCKx       |             | -                 | 5    | -                  | 5    | ns   |

**Notes:**

- The above AC characteristics are for clock synchronous mode.
- $t_{CYCP}$  indicates the APB bus clock cycle time.  
For the number of the APB bus to which the Base Timer has been connected, see the [Peripheral Address Map](#).
- The characteristics are applicable only when the relocate port numbers are the same.  
For instance, they are not applicable for the combination of SCKx\_0 and SOTx\_1.
- External load capacitance  $C_L=30$  pF



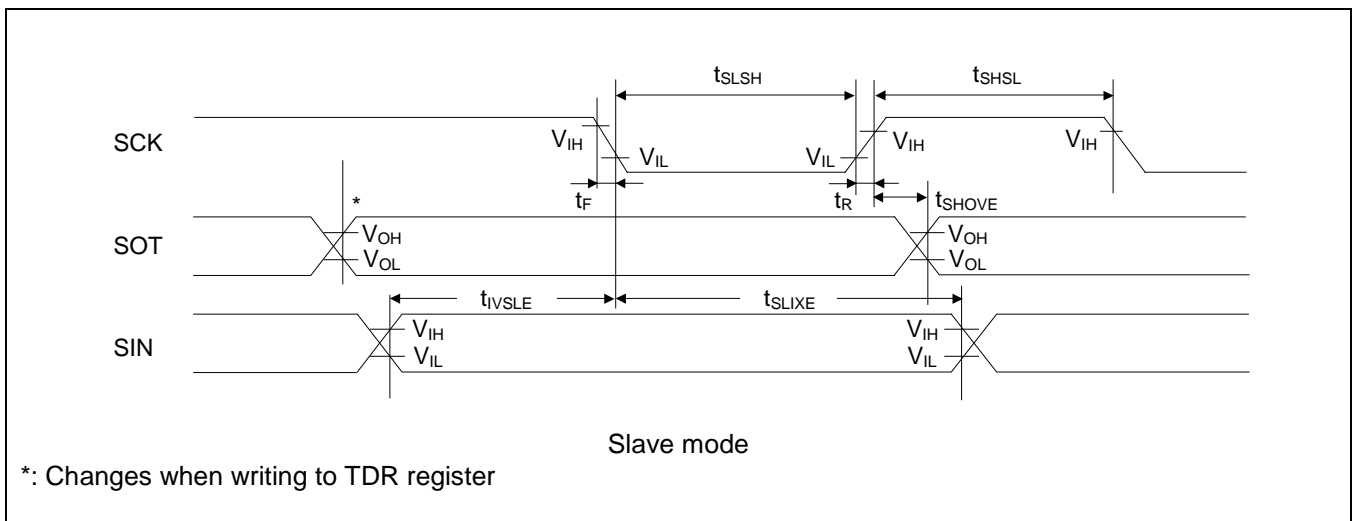
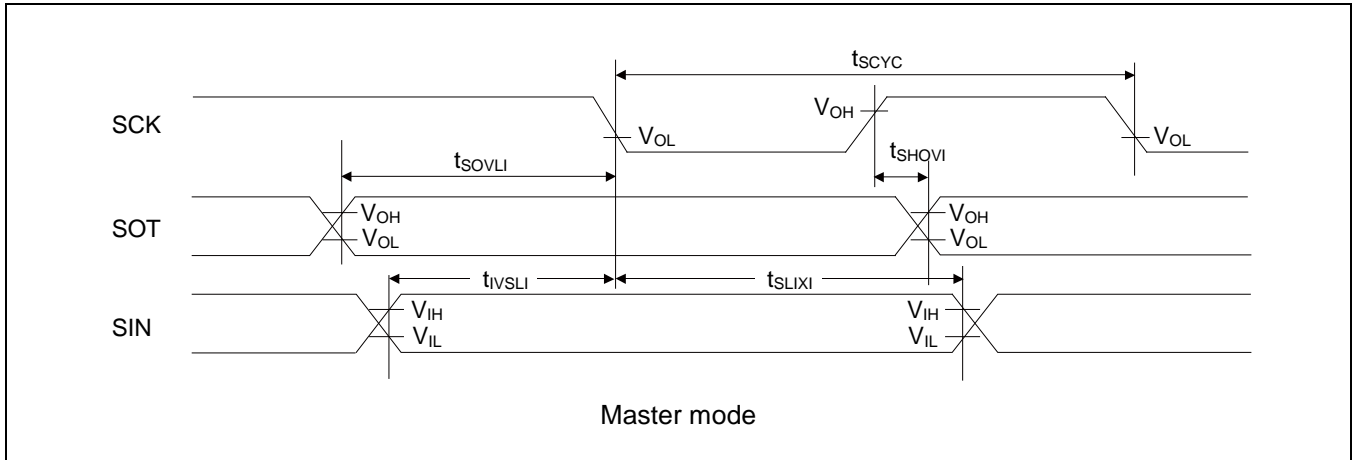
## SPI (SPI=1, SCINV=0)

( $V_{CC}$  = 1.65 V to 3.6 V,  $V_{SS}$  = 0 V,  $T_A$  = -40°C to +105°C)

| Parameter                                     | Symbol      | Pin name   | Conditions      | $V_{CC} < 2.7 V$  |                 | $V_{CC} \geq 2.7 V$ |      | Unit |
|---|-------------|------------|-----------------|-------------------|-----------------|---------------------|------|------|
|   |             |            |                 | Min               | Max             | Min                 | Max  |      |
| Serial clock cycle time                       | $t_{SCYC}$  | SCKx       | Master mode     | $4 t_{CYCP}$      | -               | $4 t_{CYCP}$        | -    | ns   |
| SCK $\uparrow$ $\rightarrow$ SOT delay time   | $t_{SHOVI}$ | SCKx, SOTx |                 | - 30              | + 30            | - 20                | + 20 | ns   |
| SIN $\rightarrow$ SCK $\downarrow$ setup time | $t_{IVSLI}$ | SCKx, SINx |                 | 50                | -               | 36                  | -    | ns   |
| SCK $\downarrow$ $\rightarrow$ SIN hold time  | $t_{SLIXI}$ | SCKx, SINx |                 | 0                 | -               | 0                   | -    | ns   |
| SOT $\rightarrow$ SCK $\downarrow$ delay time | $t_{SOVLI}$ | SCKx, SOTx |                 | $2 t_{CYCP} - 30$ | -               | $2 t_{CYCP} - 30$   | -    | ns   |
| Serial clock "L" pulse width                  | $t_{SLSH}$  | SCKx       |                 | $2 t_{CYCP} - 10$ | -               | $2 t_{CYCP} - 10$   | -    | ns   |
| Serial clock "H" pulse width                  | $t_{SHSL}$  | SCKx       | $t_{CYCP} + 10$ | -                 | $t_{CYCP} + 10$ | -                   | ns   |      |
| SCK $\uparrow$ $\rightarrow$ SOT delay time   | $t_{SHOVE}$ | SCKx, SOTx | Slave mode      | -                 | 50              | -                   | 3356 | ns   |
| SIN $\rightarrow$ SCK $\downarrow$ setup time | $t_{IVSLE}$ | SCKx, SINx |                 | 10                | -               | 10                  | -    | ns   |
| SCK $\downarrow$ $\rightarrow$ SIN hold time  | $t_{SLIXE}$ | SCKx, SINx |                 | 20                | -               | 20                  | -    | ns   |
| SCK falling time                              | tF          | SCKx       |                 | -                 | 5               | -                   | 5    | ns   |
| SCK rising time                               | tR          | SCKx       |                 | -                 | 5               | -                   | 5    | ns   |

### Notes:

- The above AC characteristics are for clock synchronous mode.
- $t_{CYCP}$  indicates the APB bus clock cycle time.  
For the number of the APB bus to which the Base Timer has been connected, see the [Peripheral Address Map](#).
- The characteristics are applicable only when the relocate port numbers are the same.  
For instance, they are not applicable for the combination of SCKx\_0 and SOTx\_1.
- External load capacitance  $C_L=30$  pF



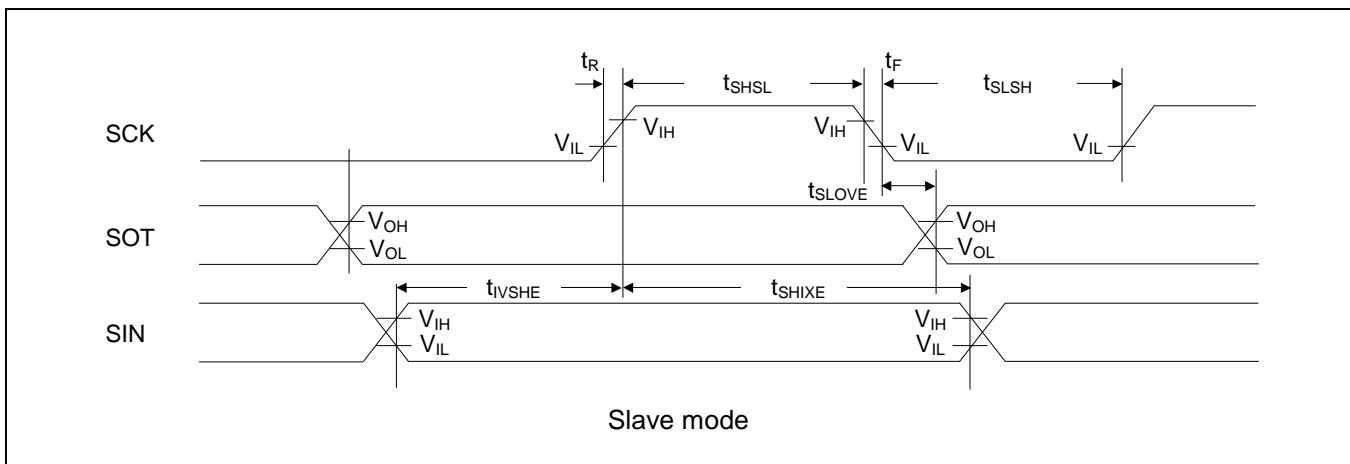
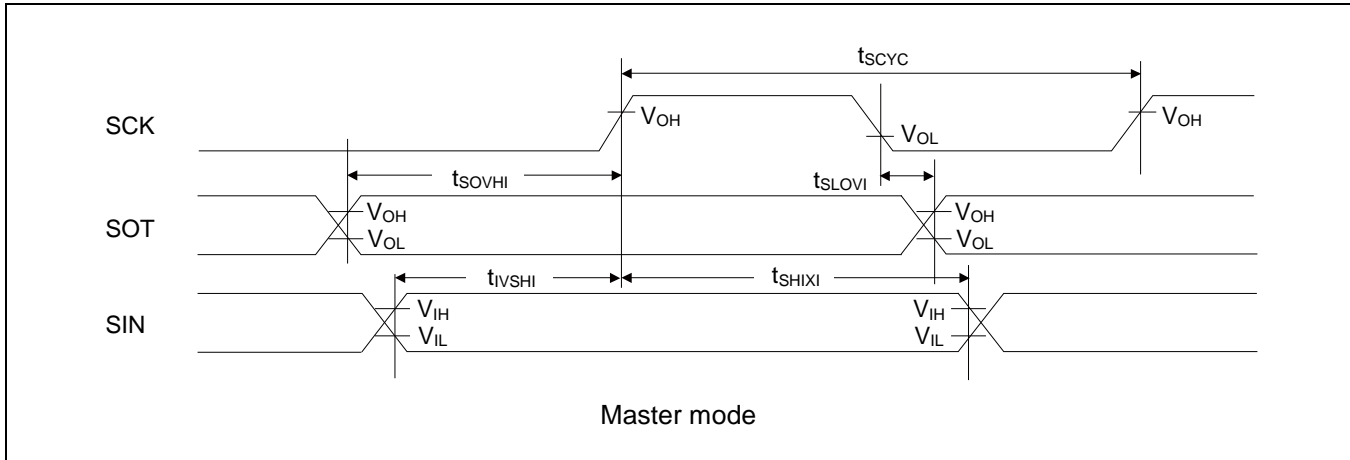
**SPI (SPI=1, SCINV=1)**

( $V_{CC}$ = 1.65 V to 3.6 V,  $V_{SS}$ = 0 V,  $T_A$ =- 40°C to +105°C)

| Parameter                    | Symbol      | Pin name      | Conditions  | $V_{CC} < 2.7 V$     |      | $V_{CC} \geq 2.7 V$  |      | Unit |
|------------------------------|-------------|---------------|-------------|----------------------|------|----------------------|------|------|
|                              |             |               |             | Min                  | Max  | Min                  | Max  |      |
| Serial clock cycle time      | $t_{SCYC}$  | SCKx          | Master mode | 4 $t_{CYCP}$         | -    | 4 $t_{CYCP}$         | -    | ns   |
| SCK ↓ → SOT delay time       | $t_{SLOVI}$ | SCKx,<br>SOTx |             | - 30                 | + 30 | - 20                 | + 20 | ns   |
| SIN → SCK ↑ setup time       | $t_{IVSHI}$ | SCKx,<br>SINx |             | 50                   | -    | 36                   | -    | ns   |
| SCK ↑ → SIN hold time        | $t_{SHIXI}$ | SCKx,<br>SINx |             | 0                    | -    | 0                    | -    | ns   |
| SOT → SCK ↑ delay time       | $t_{SOVHI}$ | SCKx,<br>SOTx |             | 2 $t_{CYCP}$ -<br>30 | -    | 2 $t_{CYCP}$ -<br>30 | -    | ns   |
| Serial clock "L" pulse width | $t_{SLSH}$  | SCKx          | Slave mode  | 2 $t_{CYCP}$ -<br>10 | -    | 2 $t_{CYCP}$ -<br>10 | -    | ns   |
| Serial clock "H" pulse width | $t_{SHSL}$  | SCKx          |             | $t_{CYCP} + 10$      | -    | $t_{CYCP} + 10$      | -    | ns   |
| SCK ↓ → SOT delay time       | $t_{SLOVE}$ | SCKx,<br>SOTx |             | -                    | 50   | -                    | 33   | ns   |
| SIN → SCK ↑ setup time       | $t_{IVSHE}$ | SCKx,<br>SINx |             | 10                   | -    | 10                   | -    | ns   |
| SCK ↑ → SIN hold time        | $t_{SHIXE}$ | SCKx,<br>SINx |             | 20                   | -    | 20                   | -    | ns   |
| SCK falling time             | tF          | SCKx          |             | -                    | 5    | -                    | 5    | ns   |
| SCK rising time              | tR          | SCKx          |             | -                    | 5    | -                    | 5    | ns   |

**Notes:**

- The above AC characteristics are for clock synchronous mode.
- $t_{CYCP}$  indicates the APB bus clock cycle time.  
For the number of the APB bus to which the Base Timer has been connected, see the [Peripheral Address Map](#).
- The characteristics are applicable only when the relocate port numbers are the same.  
For instance, they are not applicable for the combination of SCKx\_0 and SOTx\_1.
- External load capacitance  $C_L=30$  pF





**When Using CSIO/SPI Chip Select (SCINV=0, CSLVL=1)**

( $V_{CC}$ = 1.65 V to 3.6 V,  $V_{SS}$ = 0 V,  $T_A$ =- 40°C to +105°C)

| Parameter            | Symbol     | Conditions  | $V_{CC} < 2.7 V$  |                   | $V_{CC} \geq 2.7 V$ |                   | Unit |
|----------------------|------------|-------------|-------------------|-------------------|---------------------|-------------------|------|
|                      |            |             | Min               | Max               | Min                 | Max               |      |
| SCS↓→SCK↓ setup time | $t_{CSSI}$ | Master mode | -50 <sup>43</sup> | +0 <sup>43</sup>  | -50 <sup>43</sup>   | +0 <sup>43</sup>  | ns   |
| SCK↑→SCS↑ hold time  | $t_{CSHI}$ |             | +0 <sup>44</sup>  | +50 <sup>44</sup> | +0 <sup>44</sup>    | +50 <sup>44</sup> | ns   |
| SCS deselect time    | $t_{CSDI}$ |             | -50 <sup>45</sup> | +50 <sup>44</sup> | -50 <sup>44</sup>   | +50 <sup>44</sup> | ns   |
| SCS↓→SCK↓ setup time | $t_{CSSE}$ | Slave mode  | $3t_{CYCP}+30$    | -                 | $3t_{CYCP}+30$      | -                 | ns   |
| SCK↑→SCS↑ hold time  | $t_{CSHE}$ |             | 0                 | -                 | 0                   | -                 | ns   |
| SCS deselect time    | $t_{CSDE}$ |             | $3t_{CYCP}+30$    | -                 | $3t_{CYCP}+30$      | -                 | ns   |
| SCS↓→SOT delay time  | $t_{DSE}$  |             | -                 | 55                | -                   | 40                | ns   |
| SCS↑→SOT delay time  | $t_{DEE}$  |             | 0                 | -                 | 0                   | -                 | ns   |

**Notes:**

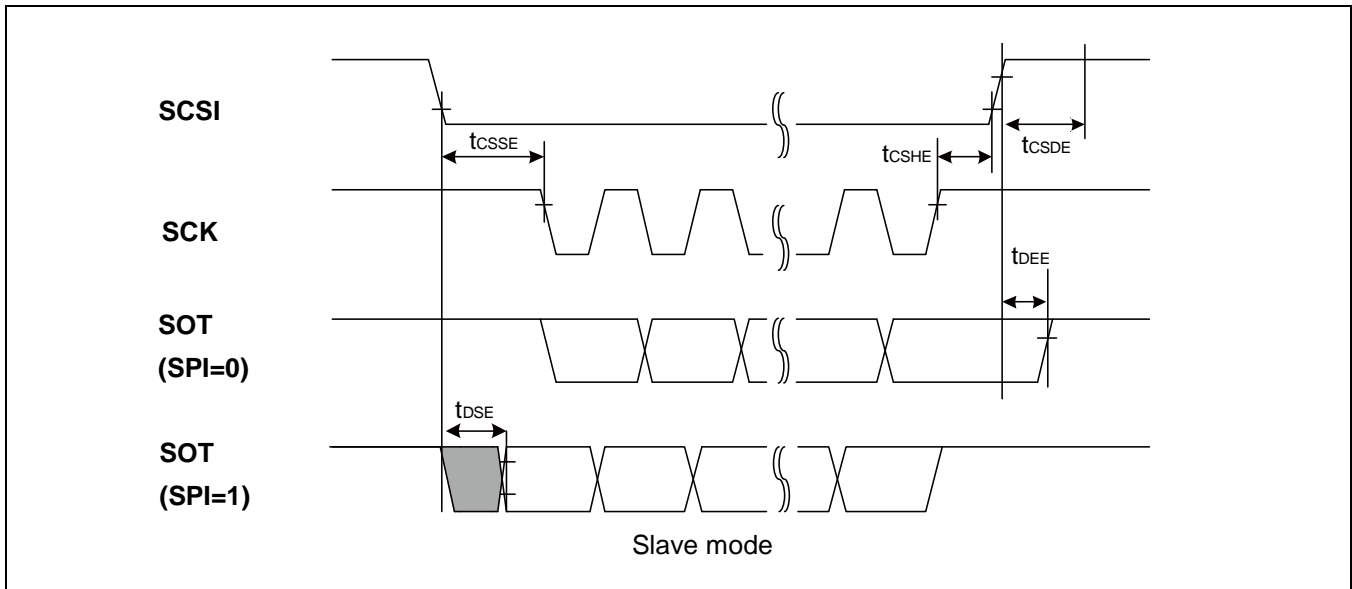
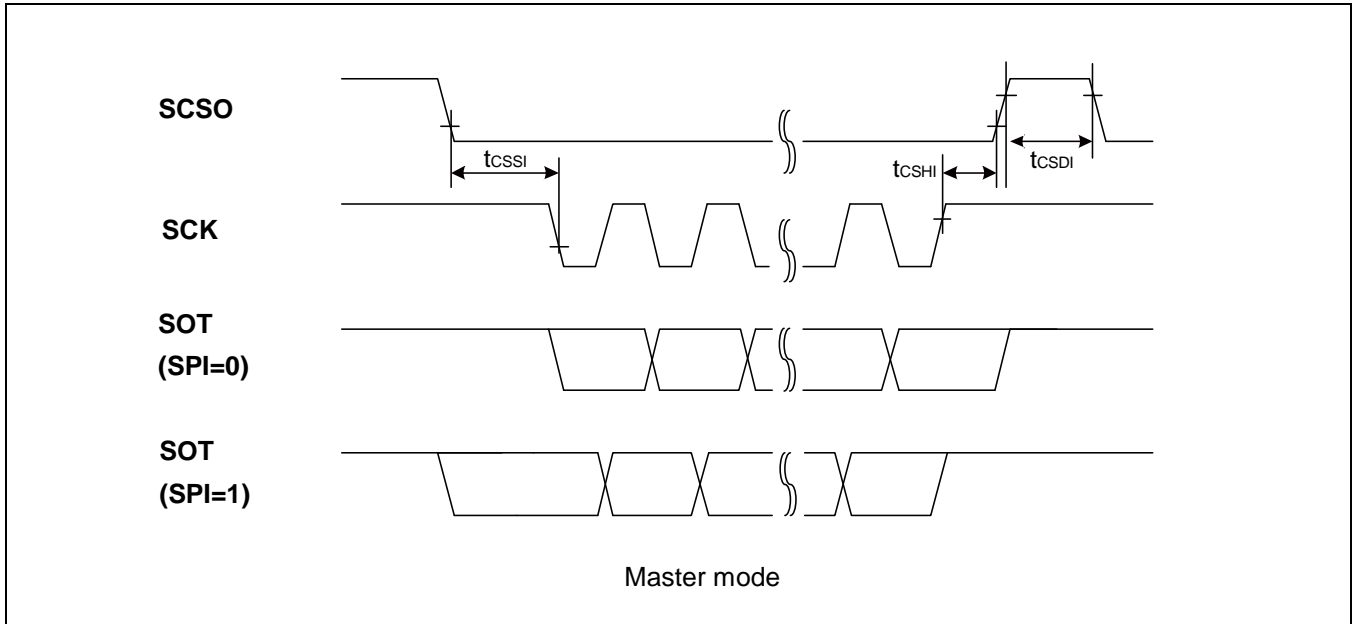
- $t_{CYCP}$  indicates the APB bus clock cycle time.  
For the number of the APB bus to which the Base Timer has been connected, see the [Peripheral Address Map](#).
- For information about CSSU, CSHD, CSDS, serial chip select timing operating clock, see "FM0+ Family Peripheral Manual".
- These characteristics guarantee only the same relocate port number.  
For example, the combination of SCKx\_0 and SCSIx\_1 is not guaranteed.
- When the external load capacitance  $C_L=30 pF$ .

<sup>43</sup> CSSU bit value × serial chip select timing operating clock cycle.

<sup>44</sup> CSHD bit value × serial chip select timing operating clock cycle.

<sup>45</sup> CSDS bit value × serial chip select timing operating clock cycle.

Irrespective of CSDS bit setting,  $5t_{CYCP}$  or more are required for the period the time when the serial chip select pin becomes inactive to the time when the serial chip select pin becomes active again.



## When Using CSIO/SPI Chip Select (SCINV=1, CSLVL=1)

( $V_{CC}$ = 1.65 V to 3.6 V,  $V_{SS}$ = 0 V,  $T_A$ =- 40°C to +105°C)

| Parameter                                   | Symbol     | Conditions  | $V_{CC} < 2.7 V$  |                   | $V_{CC} \geq 2.7 V$ |                   | Unit |
|---|------------|-------------|-------------------|-------------------|---------------------|-------------------|------|
|   |            |             | Min               | Max               | Min                 | Max               |      |
| SCS $\downarrow$ →SCK $\uparrow$ setup time | $t_{CSSI}$ | Master mode | -50 <sup>46</sup> | +0 <sup>46</sup>  | -50 <sup>46</sup>   | +0 <sup>46</sup>  | ns   |
| SCK $\downarrow$ →SCS $\uparrow$ hold time  | $t_{CSHI}$ |             | +0 <sup>47</sup>  | +50 <sup>47</sup> | +0 <sup>47</sup>    | +50 <sup>47</sup> | ns   |
| SCS deselect time                           | $t_{CSDI}$ |             | -50 <sup>48</sup> | +50 <sup>48</sup> | -50 <sup>48</sup>   | +50 <sup>48</sup> | ns   |
| SCS $\downarrow$ →SCK $\uparrow$ setup time | $t_{CSSE}$ | Slave mode  | $3t_{CYCP}+30$    | -                 | $3t_{CYCP}+30$      | -                 | ns   |
| SCK $\downarrow$ →SCS $\uparrow$ hold time  | $t_{CSHE}$ |             | 0                 | -                 | 0                   | -                 | ns   |
| SCS deselect time                           | $t_{CSDE}$ |             | $3t_{CYCP}+30$    | -                 | $3t_{CYCP}+30$      | -                 | ns   |
| SCS $\downarrow$ →SOT delay time            | $t_{DSE}$  |             | -                 | 55                | -                   | 40                | ns   |
| SCS $\uparrow$ →SOT delay time              | $t_{DEE}$  |             | 0                 | -                 | 0                   | -                 | ns   |

### Notes:

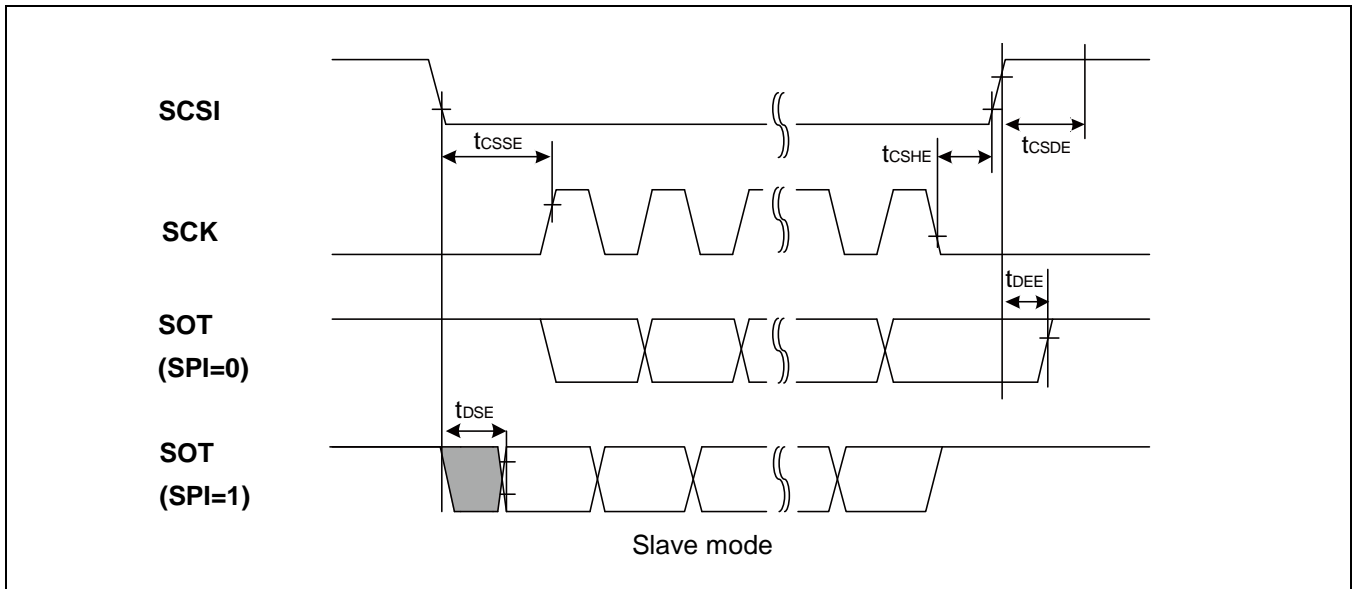
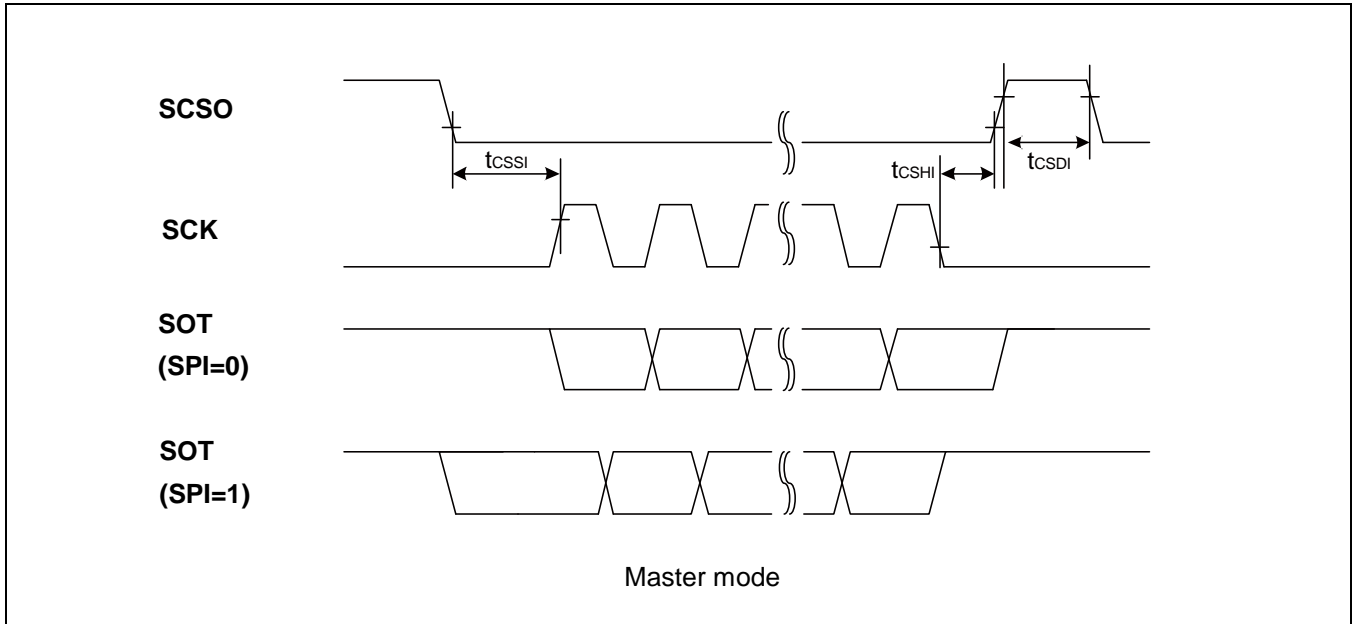
- $t_{CYCP}$  indicates the APB bus clock cycle time.  
For the number of the APB bus to which the Base Timer has been connected, see the [Peripheral Address Map](#).
- For information about CSSU, CSHD, CSDS, serial chip select timing operating clock, see "FM0+ Family Peripheral Manual".
- These characteristics guarantee only the same relocate port number.  
For example, the combination of SCKx\_0 and SCSIx\_1 is not guaranteed.
- When the external load capacitance  $C_L=30 pF$ .

<sup>46</sup> CSSU bit value × serial chip select timing operating clock cycle.

<sup>47</sup> CSHD bit value × serial chip select timing operating clock cycle.

<sup>48</sup> CSDS bit value × serial chip select timing operating clock cycle.

Irrespective of CSDS bit setting,  $5t_{CYCP}$  or more are required for the period the time when the serial chip select pin becomes inactive to the time when the serial chip select pin becomes active again.



**When Using CSIO/SPI Chip Select (SCINV=0, CSLVL=0)**

( $V_{CC}$ = 1.65 V to 3.6 V,  $V_{SS}$ = 0 V,  $T_A$ =- 40°C to +105°C)

| Parameter                                   | Symbol     | Conditions  | $V_{CC} < 2.7 V$  |                   | $V_{CC} \geq 2.7 V$ |                   | Unit |
|---|------------|-------------|-------------------|-------------------|---------------------|-------------------|------|
|   |            |             | Min               | Max               | Min                 | Max               |      |
| SCS $\uparrow$ →SCK $\downarrow$ setup time | $t_{CSSI}$ | Master mode | -50 <sup>49</sup> | +0 <sup>49</sup>  | -50 <sup>49</sup>   | +0 <sup>49</sup>  | ns   |
| SCK $\uparrow$ →SCS $\downarrow$ hold time  | $t_{CSHI}$ |             | +0 <sup>50</sup>  | +50 <sup>50</sup> | +0 <sup>50</sup>    | +50 <sup>50</sup> | ns   |
| SCS deselect time                           | $t_{CSDI}$ |             | -50 <sup>51</sup> | +50 <sup>51</sup> | -50 <sup>51</sup>   | +50 <sup>51</sup> | ns   |
| SCS $\uparrow$ →SCK $\downarrow$ setup time | $t_{CSSE}$ | Slave mode  | $3t_{CYCP}+30$    | -                 | $3t_{CYCP}+30$      | -                 | ns   |
| SCK $\uparrow$ →SCS $\downarrow$ hold time  | $t_{CSHE}$ |             | 0                 | -                 | 0                   | -                 | ns   |
| SCS deselect time                           | $t_{CSDE}$ |             | $3t_{CYCP}+30$    | -                 | $3t_{CYCP}+30$      | -                 | ns   |
| SCS $\uparrow$ →SOT delay time              | $t_{DSE}$  |             | -                 | 55                | -                   | 40                | ns   |
| SCS $\downarrow$ →SOT delay time            | $t_{DEE}$  |             | 0                 | -                 | 0                   | -                 | ns   |

**Notes:**

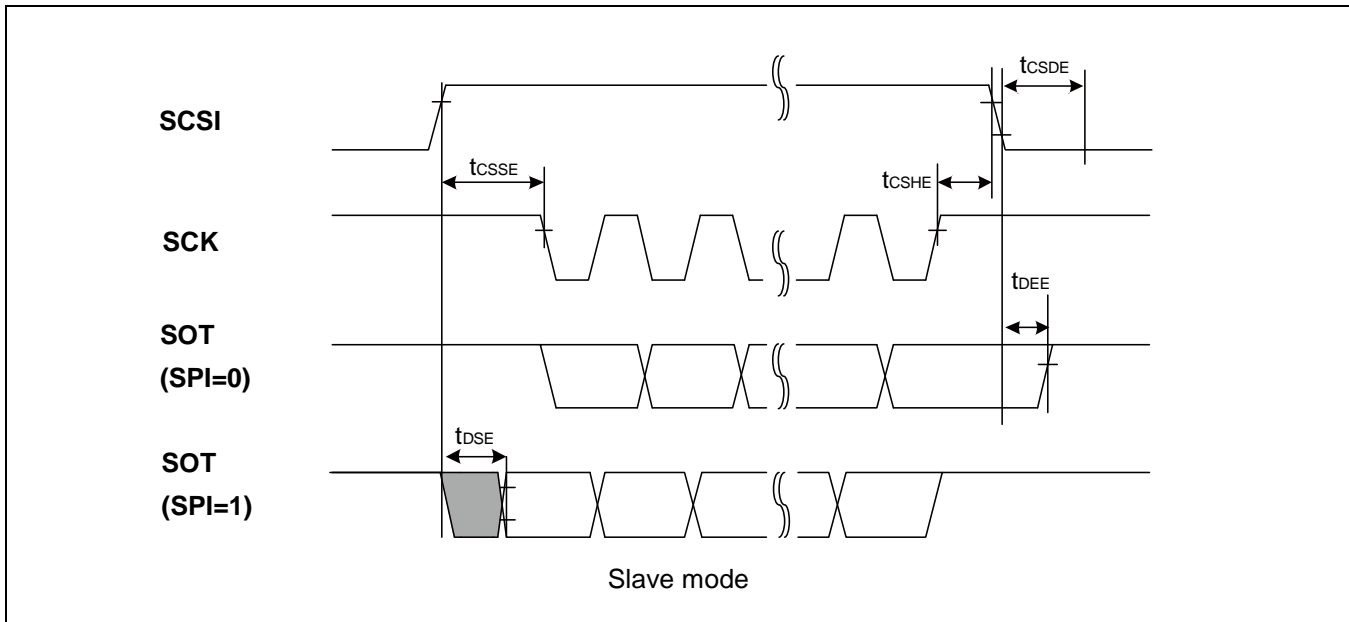
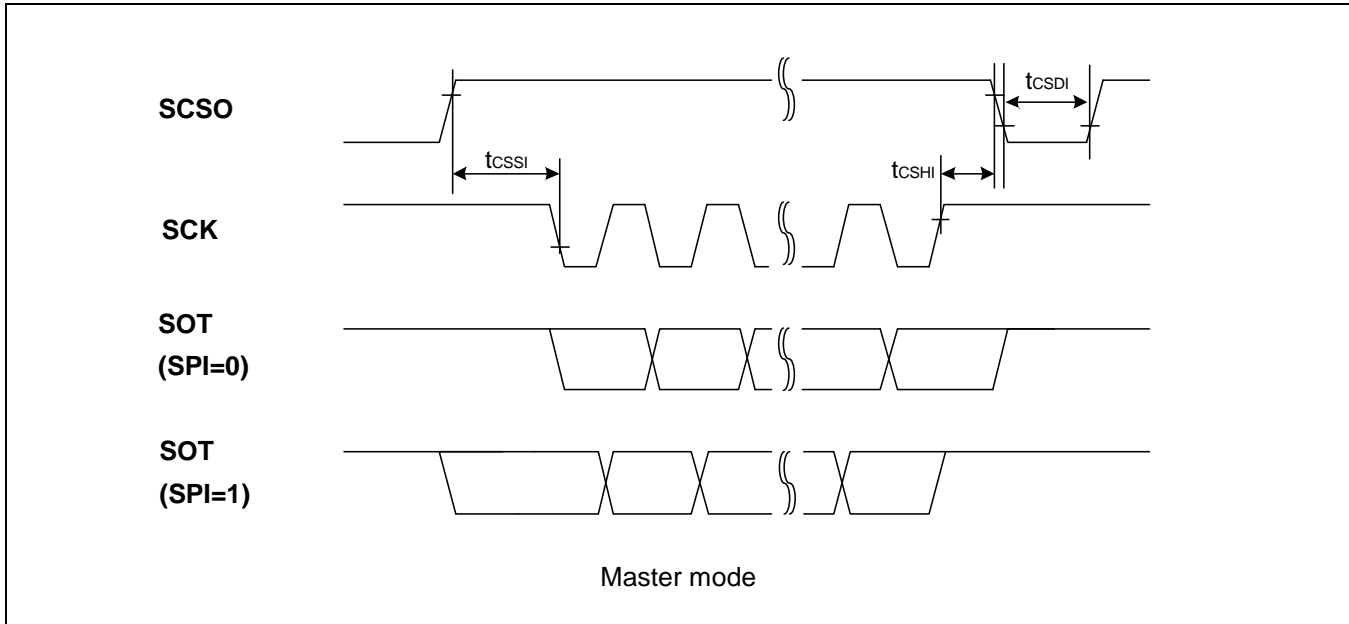
- $t_{CYCP}$  indicates the APB bus clock cycle time.  
For the number of the APB bus to which the Base Timer has been connected, see the [Peripheral Address Map](#).
- For information About CSSU, CSHD, CSDS, serial chip select timing operating clock, see "FM0+ Family Peripheral Manual".
- These characteristics guarantee only the same relocate port number.  
For example, the combination of SCKx\_0 and SCSIx\_1 is not guaranteed.
- When the external load capacitance  $C_L=30 pF$ .

<sup>49</sup> CSSU bit value × serial chip select timing operating clock cycle.

<sup>50</sup> CSHD bit value × serial chip select timing operating clock cycle.

<sup>51</sup> CSDS bit value × serial chip select timing operating clock cycle.

Irrespective of CSDS bit setting,  $5t_{CYCP}$  or more are required for the period the time when the serial chip select pin becomes inactive to the time when the serial chip select pin becomes active again.



**When Using CSIO/SPI Chip Select (SCINV=1, CSLVL=0)**

( $V_{CC}$ = 1.65 V to 3.6 V,  $V_{SS}$ = 0 V,  $T_A$ =- 40°C to +105°C)

| Parameter                                    | Symbol     | Conditions  | $V_{CC} < 2.7 V$  |                   | $V_{CC} \geq 2.7 V$ |                   | Unit |
|--|------------|-------------|-------------------|-------------------|---------------------|-------------------|------|
|  |            |             | Min               | Max               | Min                 | Max               |      |
| SCS $\uparrow$ →SCK $\uparrow$ setup time    | $t_{CSSI}$ | Master mode | -50 <sup>52</sup> | +0 <sup>52</sup>  | -50 <sup>52</sup>   | +0 <sup>52</sup>  | ns   |
| SCK $\downarrow$ →SCS $\downarrow$ hold time | $t_{CSHI}$ |             | +0 <sup>53</sup>  | +50 <sup>53</sup> | +0 <sup>53</sup>    | +50 <sup>53</sup> | ns   |
| SCS deselect time                            | $t_{CSDI}$ |             | -50 <sup>54</sup> | +50 <sup>54</sup> | -50 <sup>54</sup>   | +50 <sup>54</sup> | ns   |
| SCS $\uparrow$ →SCK $\uparrow$ setup time    | $t_{CSSE}$ | Slave mode  | $3t_{CYCP}+30$    | -                 | $3t_{CYCP}+30$      | -                 | ns   |
| SCK $\downarrow$ →SCS $\downarrow$ hold time | $t_{CSHE}$ |             | 0                 | -                 | 0                   | -                 | ns   |
| SCS deselect time                            | $t_{CSDE}$ |             | $3t_{CYCP}+30$    | -                 | $3t_{CYCP}+30$      | -                 | ns   |
| SCS $\uparrow$ →SOT delay time               | $t_{DSE}$  |             | -                 | 55                | -                   | 40                | ns   |
| SCS $\downarrow$ →SOT delay time             | $t_{DEE}$  |             | 0                 | -                 | 0                   | -                 | ns   |

**Notes:**

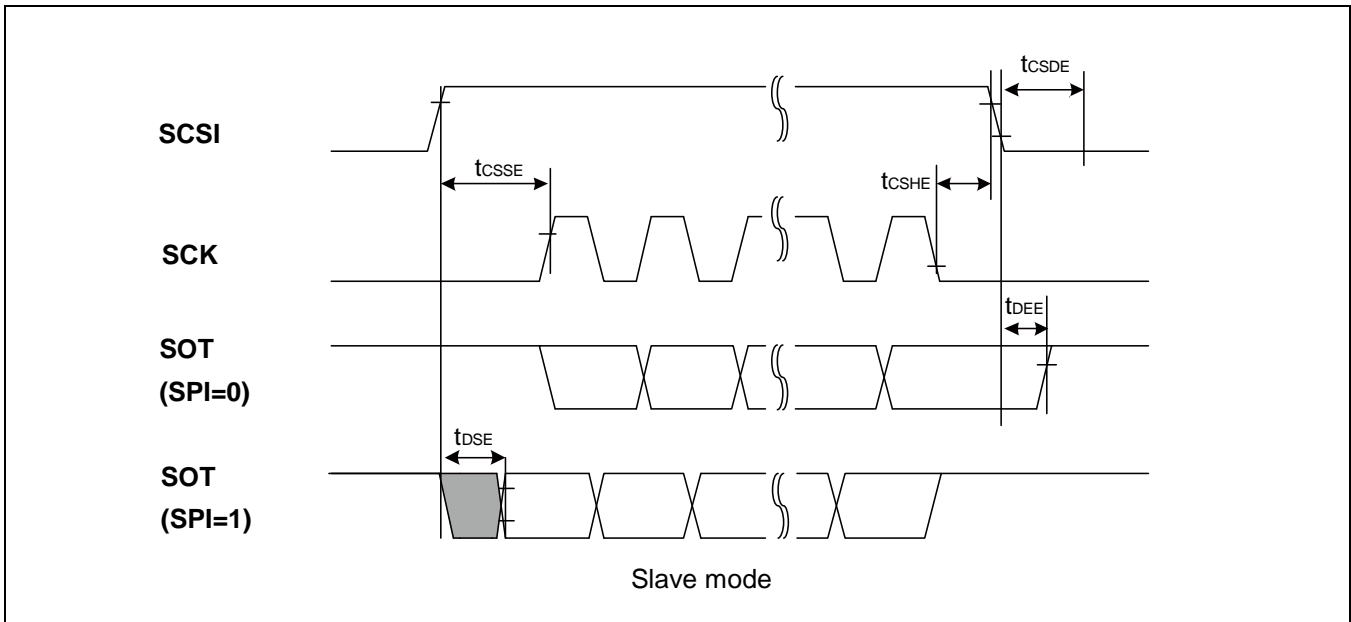
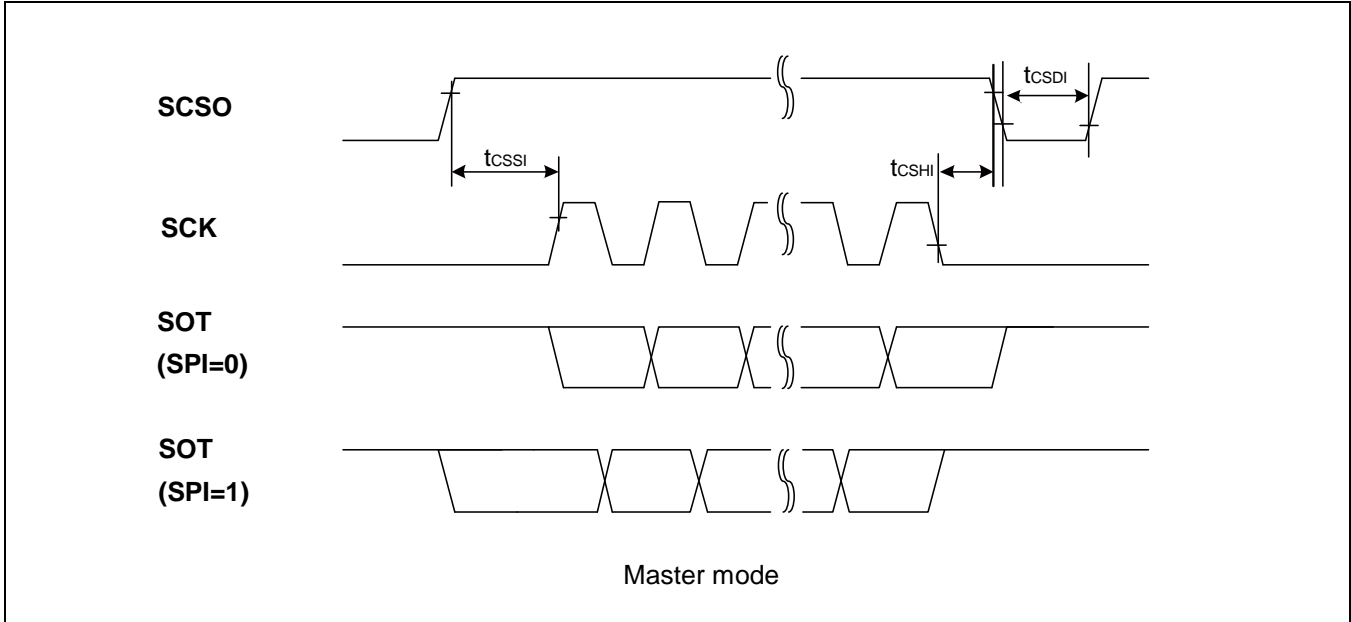
- $t_{CYCP}$  indicates the APB bus clock cycle time.  
For the number of the APB bus to which the Base Timer has been connected, see the [Peripheral Address Map](#).
- For information about CSSU, CSHD, CSDS, serial chip select timing operating clock, see "FM0+ Family Peripheral Manual".
- These characteristics guarantee only the same relocate port number.  
For example, the combination of SCKx\_0 and SCSIx\_1 is not guaranteed.
- When the external load capacitance  $C_L=30 pF$ .

<sup>52</sup> CSSU bit value × serial chip select timing operating clock cycle.

<sup>53</sup> CSHD bit value × serial chip select timing operating clock cycle.

<sup>54</sup> CSDS bit value × serial chip select timing operating clock cycle.

Irrespective of CSDS bit setting,  $5t_{CYCP}$  or more are required for the period the time when the serial chip select pin becomes inactive to the time when the serial chip select pin becomes active again.

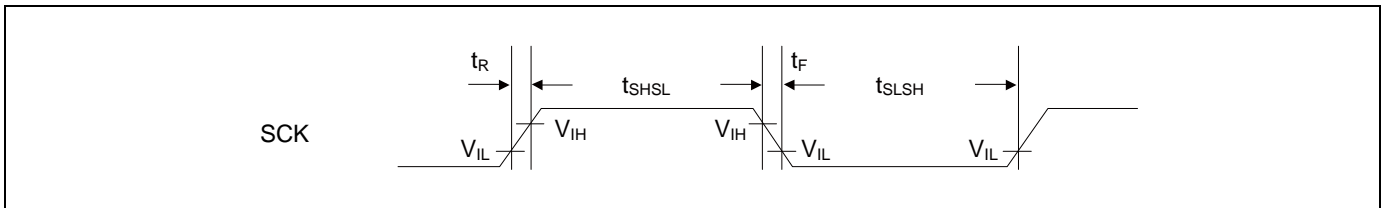




## UART external clock input (EXT=1)

( $V_{CC}$ = 1.65 V to 3.6 V,  $V_{SS}$ = 0 V,  $T_A$ =- 40°C to +105°C)

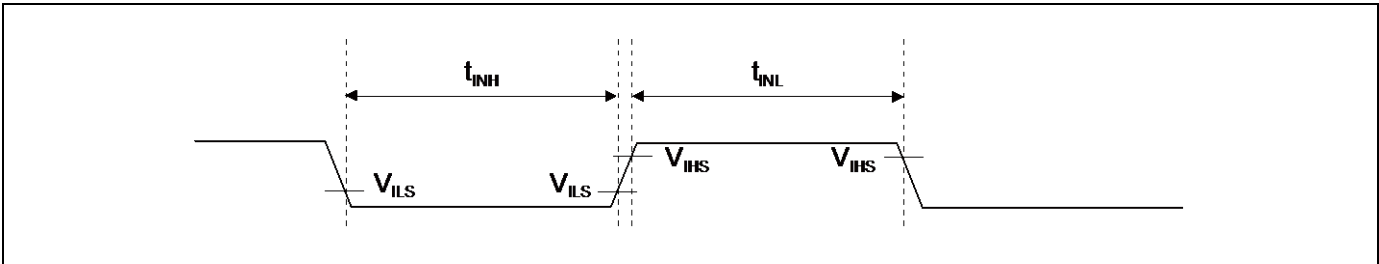
| Parameter                  | Symbol     | Conditions  | Value          |     | Unit | Remarks |
|----------------------------|------------|-------------|----------------|-----|------|---------|
|                            |            |             | Min            | Max |      |         |
| Serial clock L pulse width | $t_{SLSH}$ | $C_L=30$ pF | $t_{CYCP} +10$ | -   | ns   |         |
| Serial clock H pulse width | $t_{SHSL}$ |             | $t_{CYCP} +10$ | -   | ns   |         |
| SCK falling time           | $t_F$      |             | -              | 5   | ns   |         |
| SCK rising time            | $t_R$      |             | -              | 5   | ns   |         |



**11.4.10 External Input Timing**

( $V_{CC}$ = 1.65 V to 3.6 V,  $V_{SS}$ = 0 V,  $T_A$ =- 40°C to +105°C)

| Parameter         | Symbol                | Pin Name                                  | Conditions    | Value                   |     | Unit | Remarks                     |
|-------------------|-----------------------|---|---------------|-------------------------|-----|------|-----------------------------|
|                   |                       |   |               | Min                     | Max |      |                             |
| Input pulse width | $t_{INH}$ , $t_{INL}$ | ADTGx                                     | -             | $2 t_{CYCP}^{55}$       | -   | ns   | A/D converter trigger input |
|                   |                       | INT00 to INT08, INT12, INT13, INT15, NMIX | <sup>56</sup> | $2 t_{CYCP} + 100^{55}$ | -   | ns   | External interrupt, NMI     |
|                   |                       |   | <sup>57</sup> | 500                     | -   | ns   |                             |
|                   |                       | WKUPx                                     | <sup>58</sup> | 500                     | -   | ns   | Deep standby wake up        |



<sup>55</sup>  $t_{CYCP}$  indicates the APB bus clock cycle time. For the number of the APB bus to which the Base Timer has been connected, see the Peripheral Address Map.

<sup>56</sup> In Run mode and Sleep mode

<sup>57</sup> In Timer mode, RTC mode and Stop mode

<sup>58</sup> In Deep Standby RTC mode and Deep Standby Stop mode

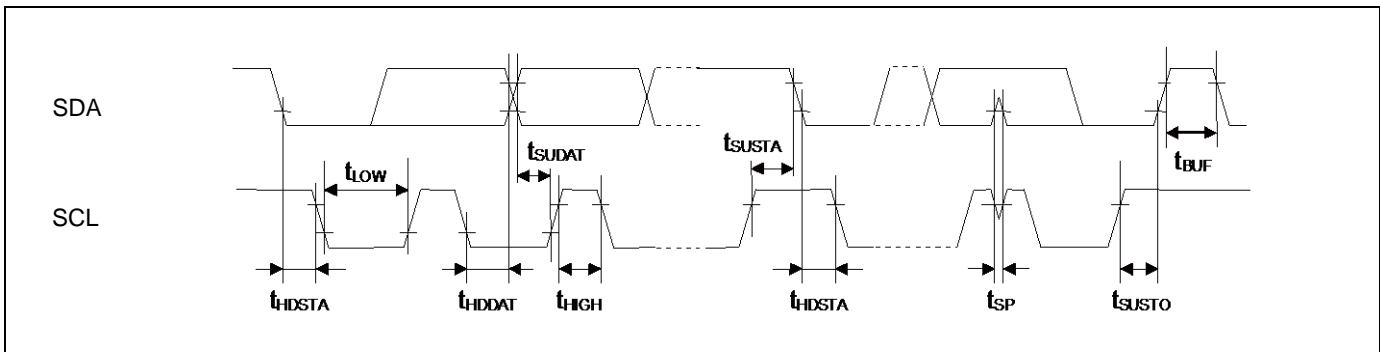
**11.4.11 I<sup>2</sup>C Timing / I2C Slave Timing**

(V<sub>CC</sub>= 1.65 V to 3.6 V, V<sub>SS</sub>= 0 V, T<sub>A</sub>=- 40°C to +105°C)

| Parameter  | Symbol             | Conditions   | Standard-Mode                        |                    | Fast-Mode                            |                   | Unit | Remarks                          |
|--|--------------------|--|--------------------------------------|--------------------|--------------------------------------|-------------------|------|----------------------------------|
|  |                    |  | Min                                  | Max                | Min                                  | Max               |      |                                  |
| SCL(SI2CSCL) clock frequency   | F <sub>SCL</sub>   |  | 0                                    | 100                | 0                                    | 400               | kHz  |                                  |
| (Repeated) Start condition hold time<br>SDA(SI2CSDA) ↓ → SCL(SI2CSCL)<br>↓ | t <sub>HDSTA</sub> |  | 4.0                                  | -                  | 0.6                                  | -                 | μs   |                                  |
| SCL(SI2CSCL) clock L width   | t <sub>LOW</sub>   |  | 4.7                                  | -                  | 1.3                                  | -                 | μs   |                                  |
| SCL(SI2CSCL) clock H width   | t <sub>HIGH</sub>  |  | 4.0                                  | -                  | 0.6                                  | -                 | μs   |                                  |
| (Repeated) Start setup time<br>SCL(SI2CSCL) ↑ → SDA<br>(SI2CSDA) ↓         | t <sub>SUSTA</sub> |  | 4.7                                  | -                  | 0.6                                  | -                 | μs   |                                  |
| Data hold time<br>SCL(SI2CSCL) ↓ → SDA(SI2CSDA)<br>↓ ↑                     | t <sub>HDDAT</sub> | C <sub>L</sub> =30 pF,<br>R=(V <sub>P</sub> /I <sub>OL</sub> ) <sup>59</sup> | 0                                    | 3.45 <sup>60</sup> | 0                                    | 0.9 <sup>61</sup> | μs   |                                  |
| Data setup time<br>SDA (SI2CSDA) ↓ ↑ → SCL<br>(SI2CSCL) ↑                  | t <sub>SUDAT</sub> |  | 250                                  | -                  | 100                                  | -                 | ns   |                                  |
| Stop condition setup time<br>SCL(SI2CSCL) ↑ → SDA(SI2CSDA)<br>↑            | t <sub>SUSTO</sub> |  | 4.0                                  | -                  | 0.6                                  | -                 | μs   |                                  |
| Bus free time between<br>Stop condition and<br>Start condition             | t <sub>BUF</sub>   |  | 4.7                                  | -                  | 1.3                                  | -                 | μs   |                                  |
| Noise filter   | t <sub>SP</sub>    | -  | 2<br>t <sub>CYCP</sub> <sup>62</sup> | -                  | 2<br>t <sub>CYCP</sub> <sup>62</sup> | -                 | ns   | except I <sup>2</sup> C<br>Slave |

"

To use Standard-mode, set the APB bus clock at 2 MHz or more.  
To use Fast-mode, set the APB bus clock at 8 MHz or more.



<sup>59</sup> R represents the pull-up resistance of the SCL and SDA lines, and C<sub>L</sub> the load capacitance of the SCL and SDA lines. V<sub>P</sub> represents the power supply voltage of the pull-up resistance, and I<sub>OL</sub> the V<sub>OL</sub> guaranteed current.

<sup>60</sup> The maximum t<sub>HDDAT</sub> must satisfy at least the condition that the period during which the device is holding the SCL signal at L (t<sub>LOW</sub>) does not extend.

<sup>61</sup> A Fast-mode I<sup>2</sup>C bus device can be used in a Standard-mode I<sup>2</sup>C bus system, provided that the condition of t<sub>SUDAT</sub> ≥ 250 ns is fulfilled.

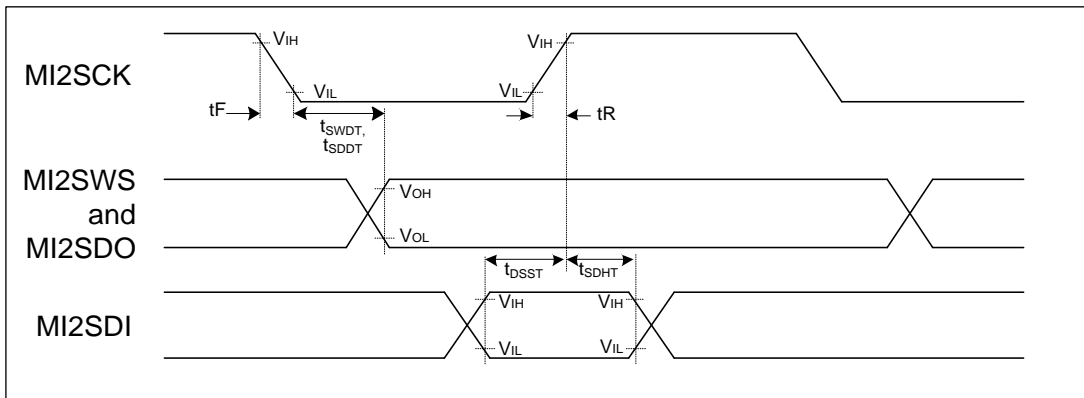
<sup>62</sup> t<sub>CYCP</sub> represents the APB bus clock cycle time. For the number of the APB bus to which the Base Timer has been connected, see the [Peripheral Address Map](#).

**11.4.12 I<sup>2</sup>S Timing (MFS-I2S Timing)**

**Master Mode Timing**

(V<sub>CC</sub>= 1.65 V to 3.6 V, V<sub>SS</sub>= 0 V, T<sub>A</sub>=- 40°C to +105°C)

| Parameter                                       | Symbol              | Pin Name         | Conditions            | V <sub>CC</sub> < 2.7 V |       | V <sub>CC</sub> ≥ 2.7 V |       | Unit |
|---|---------------------|------------------|-----------------------|-------------------------|-------|-------------------------|-------|------|
|   |                     |                  |                       | Min                     | Max   | Min                     | Max   |      |
| MI2SCK max frequency <sup>63</sup>              | F <sub>MI2SCK</sub> | MI2SCKx          | C <sub>L</sub> =30 pF | -                       | 6.144 | -                       | 6.144 | MHz  |
| I <sup>2</sup> S clock cycle time <sup>63</sup> | t <sub>CYC</sub>    | MI2SCKx          |                       | 4 t <sub>CYCP</sub>     | -     | 4 t <sub>CYCP</sub>     | -     | ns   |
| I <sup>2</sup> S clock Duty cycle               | Δ                   | MI2SCKx          |                       | 45%                     | 55%   | 45%                     | 55%   |      |
| MI2SCK ↓ → MI2SWS delay time                    | t <sub>SWDT</sub>   | MI2SCKx, MI2SWSx |                       | -30                     | +30   | -20                     | +20   | ns   |
| MI2SCK ↓ → MI2SDO delay time                    | t <sub>SDDT</sub>   | MI2SCKx, MI2SDOx |                       | -30                     | +30   | -20                     | +20   | ns   |
| MI2SDI → MI2SCK ↑ setup time                    | t <sub>DSST</sub>   | MI2SCKx, MI2SDIx |                       | 50                      | -     | 36                      | -     | ns   |
| MI2SCK ↑ → MI2SDI hold time                     | t <sub>SDHT</sub>   | MI2SCKx, MI2SDIx |                       | 0                       | -     | 0                       | -     | ns   |
| MI2SCK falling time                             | t <sub>F</sub>      | MI2SCKx          |                       | -                       | 5     | -                       | 5     | ns   |
| MI2SCK rising time                              | t <sub>R</sub>      | MI2SCKx          |                       | -                       | 5     | -                       | 5     | ns   |

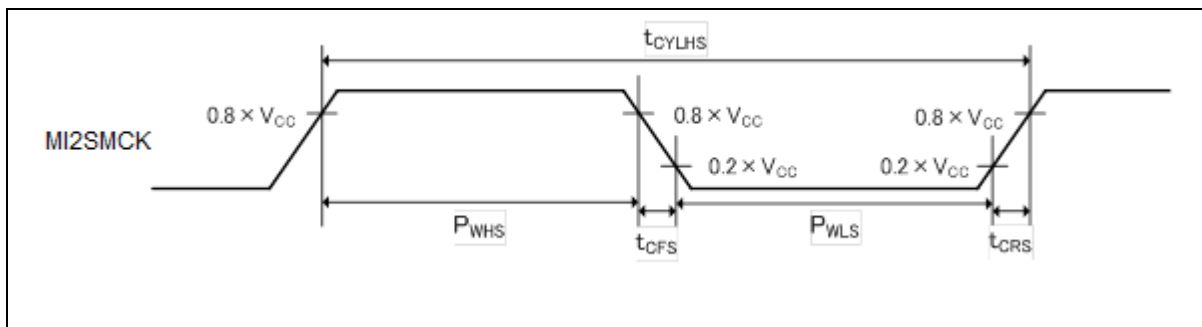


<sup>63</sup> I<sup>2</sup>S clock should meet the multiple of PCLK(t<sub>CYC</sub>) and the frequency less than F<sub>MI2SCK</sub> meantime. The detail information please refer to Chapter I<sup>2</sup>S of Communication Macro Part of the Peripheral Manual.

**MI2SMCK Input Characteristics**

( $V_{CC}$ = 1.65 V to 3.6 V,  $V_{SS}$ = 0 V,  $T_A$ =- 40°C to +105°C)

| Parameter                           | Symbol                 | Pin Name | Conditions                                 | Value |        | Unit | Remarks                   |
|-------------------------------------|------------------------|----------|--|-------|--------|------|---------------------------|
|                                     |                        |          |  | Min   | Max    |      |                           |
| Input frequency                     | $f_{CHS}$              | MI2SMCK  | -  | -     | 12.288 | MHz  |                           |
| Input clock cycle                   | $t_{CYLHS}$            | -        | -  | 81.3  | -      | ns   |                           |
| Input clock pulse width             | -                      | -        | $P_{WHS}/t_{CYLHS}$<br>$P_{WLS}/t_{CYLHS}$ | 45    | 55     | %    | When using external clock |
| Input clock rise time and fall time | $t_{CFS}$<br>$t_{CRS}$ | -        | -  | -     | 5      | ns   | When using external clock |



**MI2SMCK Output Characteristics**

( $V_{CC}$ = 1.65 V to 3.6 V,  $V_{SS}$ = 0 V,  $T_A$ =- 40°C to +105°C)

| Parameter        | Symbol    | Pin Name | Conditions | Value |     | Unit | Remarks             |
|------------------|-----------|----------|------------|-------|-----|------|---------------------|
|                  |           |          |            | Min   | Max |      |                     |
| Output frequency | $f_{CHS}$ | MI2SMCK  | -          | -     | 25  | MHz  | $V_{CC} \geq 2.7$ V |
|                  |           |          |            | -     | 20  | MHz  | $V_{CC} < 2.7$ V    |

### 11.4.13 Smart Card Interface Characteristics

( $V_{CC}$ = 1.65 V to 3.6 V,  $V_{SS}$ = 0 V,  $T_A$ =- 40°C to +105°C)

| Parameter              | Symbol    | Pin Name             | Conditions            | Value |     | Unit | Remarks |
|------------------------|-----------|----------------------|-----------------------|-------|-----|------|---------|
|                        |           |                      |                       | Min   | Max |      |         |
| Output rising time     | $t_R$     | ICx_VCC,<br>ICx_RST, | C <sub>L</sub> =30 pF | 4     | 20  | ns   |         |
| Output falling time    | $t_F$     | ICx_CLK,<br>ICx_DATA |                       | 4     | 20  | ns   |         |
| Output clock frequency | $f_{CLK}$ | ICx_CLK              |                       | -     | 20  | MHz  |         |
| Duty cycle             | $\Delta$  |                      |                       | 45%   | 55% |      |         |

■ External pull-up resistor (20 kΩ to 50 kΩ) must be applied to ICx\_CIN pin when it's used as smart card reader function.

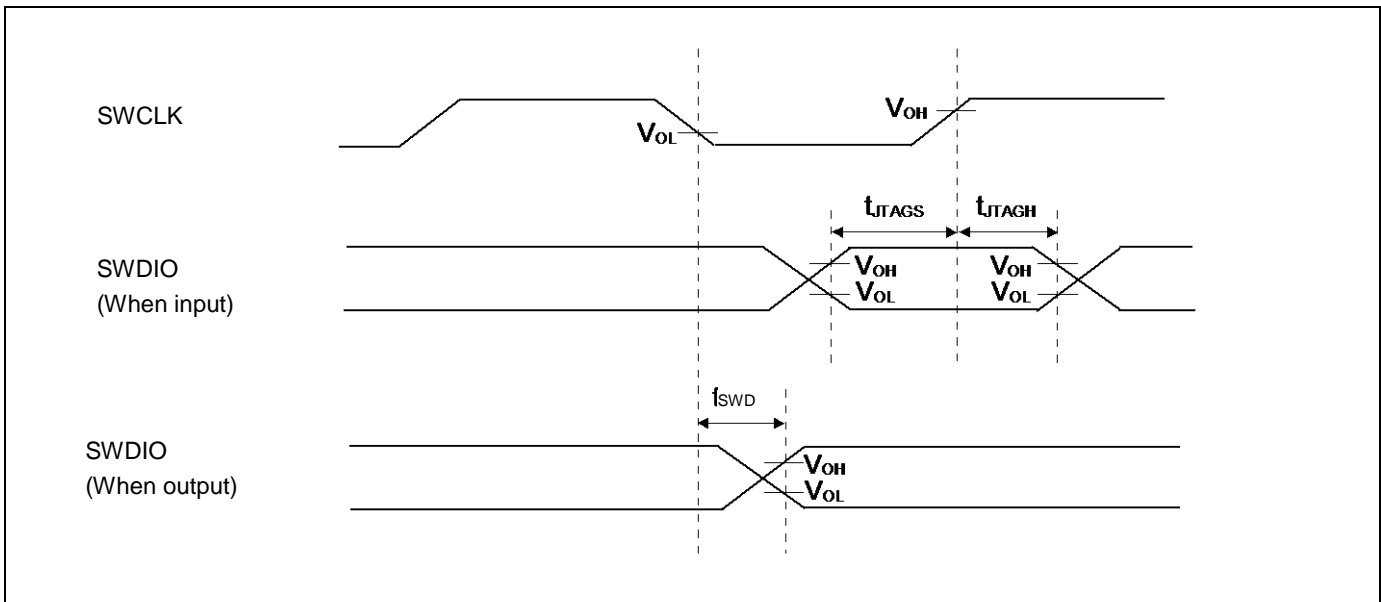
**11.4.14 SW-DP Timing**

( $V_{CC} = 1.65\text{ V to }3.6\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ,  $T_A = -40^\circ\text{C to }+105^\circ\text{C}$ )

| Parameter        | Symbol    | Pin Name        | Conditions | Value |     | Unit | Remarks |
|------------------|-----------|-----------------|------------|-------|-----|------|---------|
|                  |           |                 |            | Min   | Max |      |         |
| SWDIO setup time | $t_{SWS}$ | SWCLK,<br>SWDIO | -          | 15    | -   | ns   |         |
| SWDIO hold time  | $t_{SWH}$ | SWCLK,<br>SWDIO | -          | 15    | -   | ns   |         |
| SWDIO delay time | $t_{SWD}$ | SWCLK,<br>SWDIO | -          | -     | 45  | ns   |         |

**Note:**

- External load capacitance  $C_L = 30\text{ pF}$



**11.5 12-bit A/D Converter**
**Electrical Characteristics of A/D Converter (Preliminary Values)**
 $(V_{CC} = 1.65\text{ V to } 3.6\text{ V}, V_{SS} = 0\text{ V}, T_A = -40^\circ\text{C to } +105^\circ\text{C})$ 

| Parameter                                     | Symbol    | Pin Name | Value     |     |           | Unit          | Remarks                           |
|---|-----------|----------|-----------|-----|-----------|---------------|-----------------------------------|
|   |           |          | Min       | Typ | Max       |               |                                   |
| Resolution                                    | -         | -        | -         | -   | 12        | bit           |                                   |
| Integral Nonlinearity                         | -         | -        | - 4.5     | -   | 4.5       | LSB           |                                   |
| Differential Nonlinearity                     | -         | -        | - 2.5     | -   | + 2.5     | LSB           |                                   |
| Zero transition voltage                       | $V_{ZT}$  | ANxx     | - 15      | -   | + 15      | mV            |                                   |
| Full-scale transition voltage                 | $V_{FST}$ | ANxx     | AVRH - 15 | -   | AVRH + 15 | mV            |                                   |
| Conversion time <sup>64</sup>                 | -         | -        | 1.0       | -   | -         | $\mu\text{s}$ | $V_{CC} \geq 2.7\text{ V}$        |
|   |           |          | 4.0       | -   | -         |               | $1.8 \leq V_{CC} < 2.7\text{ V}$  |
|   |           |          | 10        | -   | -         |               | $1.65 \leq V_{CC} < 1.8\text{ V}$ |
| Sampling time <sup>65</sup>                   | $T_s$     | -        | 0.3       | -   | 10        | $\mu\text{s}$ | $V_{CC} \geq 2.7\text{ V}$        |
|   |           |          | 1.2       | -   |           |               | $1.8 \leq V_{CC} < 2.7\text{ V}$  |
|   |           |          | 3.0       | -   |           |               | $1.65 \leq V_{CC} < 1.8\text{ V}$ |
| Compare clock cycle <sup>66</sup>             | $T_{cck}$ | -        | 50        | -   | 1000      | ns            | $V_{CC} \geq 2.7\text{ V}$        |
|   |           |          | 200       | -   |           |               | $1.8 \leq V_{CC} < 2.7\text{ V}$  |
|   |           |          | 500       | -   |           |               | $1.65 \leq V_{CC} < 1.8\text{ V}$ |
| State transition time to operation permission | $T_{stt}$ | -        | -         | -   | 1.0       | $\mu\text{s}$ |                                   |
| Analog input capacity                         | $C_{AIN}$ | -        | -         | -   | 7.5       | pF            |                                   |
| Analog input resistance                       | $R_{AIN}$ | -        | -         | -   | 2.2       | k $\Omega$    | $V_{CC} \geq 2.7\text{ V}$        |
|   |           |          |           |     | 5.5       |               | $1.8 \leq V_{CC} < 2.7\text{ V}$  |
|   |           |          |           |     | 10.5      |               | $1.65 \leq V_{CC} < 1.8\text{ V}$ |
| Interchannel disparity                        | -         | -        | -         | -   | 4         | LSB           |                                   |
| Analog port input leak current                | -         | ANxx     | -         | -   | 5         | $\mu\text{A}$ |                                   |
| Analog input voltage                          | -         | ANxx     | $V_{SS}$  | -   | AVRH      | V             |                                   |
| Reference voltage                             | -         | AVRH     | 2.7       | -   | $V_{CC}$  | V             | $V_{CC} \geq 2.7\text{ V}$        |
|   |           |          | $V_{CC}$  |     |           |               | $V_{CC} < 2.7\text{ V}$           |
|   |           | AVRL     | $V_{SS}$  | -   | $V_{SS}$  | V             |                                   |

<sup>64</sup> The conversion time is the value of sampling time ( $t_s$ ) + compare time ( $t_c$ ).  
The minimum conversion time is computed according to the following conditions:  
 $V_{CC} \geq 2.7\text{ V}$       sampling time=0.3  $\mu\text{s}$ , compare time=0.7  $\mu\text{s}$   
 $1.8 \leq V_{CC} < 2.7\text{ V}$       sampling time=1.2  $\mu\text{s}$ , compare time=2.8  $\mu\text{s}$   
 $1.65 \leq V_{CC} < 1.8\text{ V}$       sampling time=3.0  $\mu\text{s}$ , compare time=7.0  $\mu\text{s}$

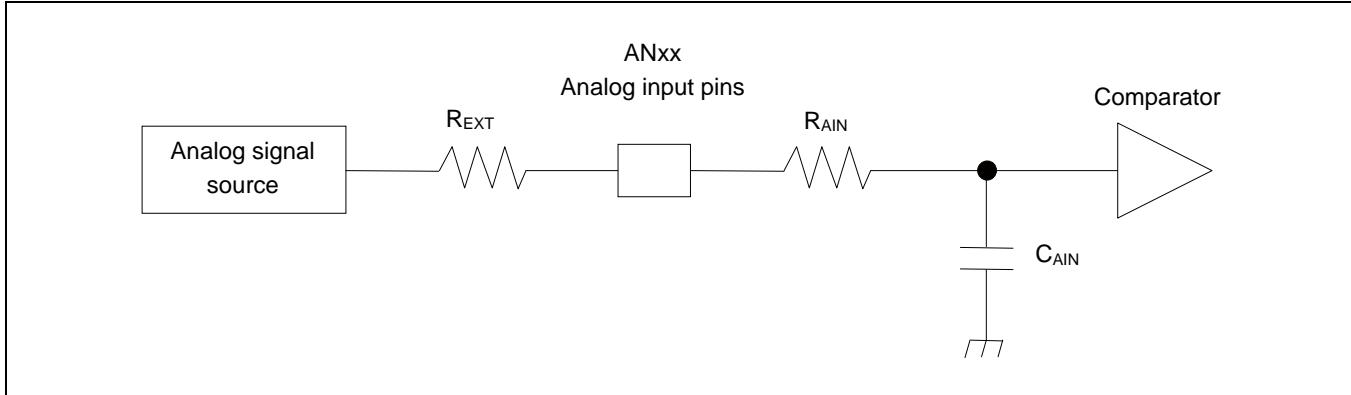
Ensure that the conversion time satisfies the specifications of the sampling time ( $t_s$ ) and compare clock cycle ( $t_{cck}$ ).  
For details of the settings of the sampling time and compare clock cycle, refer to "Chapter: A/D Converter" in "FM0+ Family Peripheral Manual Analog Macro Part".  
The register settings of the A/D Converter are reflected in the operation according to the APB bus clock timing.  
For the number of the APB bus to which the A/D Converter is connected, see the [Peripheral Address Map](#).

The base clock (HCLK) is used to generate the sampling time and the compare clock cycle.

<sup>65</sup> The required sampling time varies according to the external impedance. Set a sampling time that satisfies (Equation 1).

<sup>66</sup> The compare time ( $t_c$ ) is the result of (Equation 2).





(Equation 1)  $t_S \geq (R_{AIN} + R_{EXT}) \times C_{AIN} \times 9$

$t_S$ : Sampling time

$R_{AIN}$ : Input resistance of A/D Converter = 2.2 k $\Omega$  with  $2.7 \leq VCC \leq 3.6$

Input resistance of A/D Converter = 5.5 k $\Omega$  with  $1.8 \leq VCC \leq 2.7$

Input resistance of A/D Converter = 10.5 k $\Omega$  with  $1.65 \leq VCC \leq 1.8$

$C_{AIN}$ : Input capacitance of A/D Converter = 7.5 pF with  $1.65 \leq VCC \leq 3.6$

$R_{EXT}$ : Output impedance of external circuit

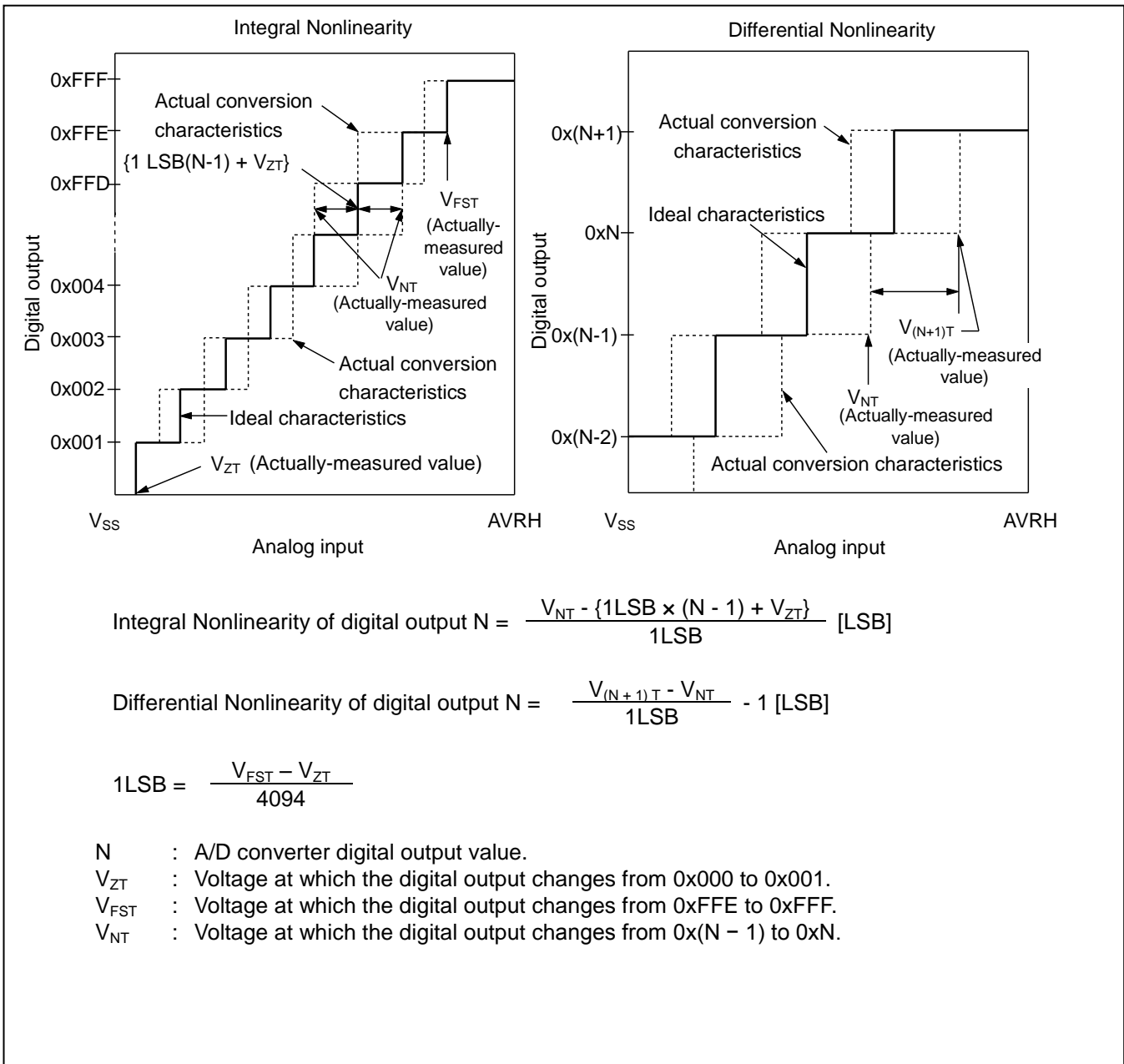
(Equation 2)  $t_C = t_{CCK} \times 14$

$t_C$ : Compare time

$t_{CCK}$ : Compare clock cycle

**Definitions of 12-bit A/D Converter Terms**

- Resolution: Analog variation that is recognized by an A/D converter.
- Integral Nonlinearity: Deviation of the line between the zero-transition point (0b000000000000 ↔ 0b000000000001) and the full-scale transition point (0b111111111110 ↔ 0b111111111111) from the actual conversion characteristics.
- Differential Nonlinearity: Deviation from the ideal value of the input voltage that is required to change the output code by 1 LSB.

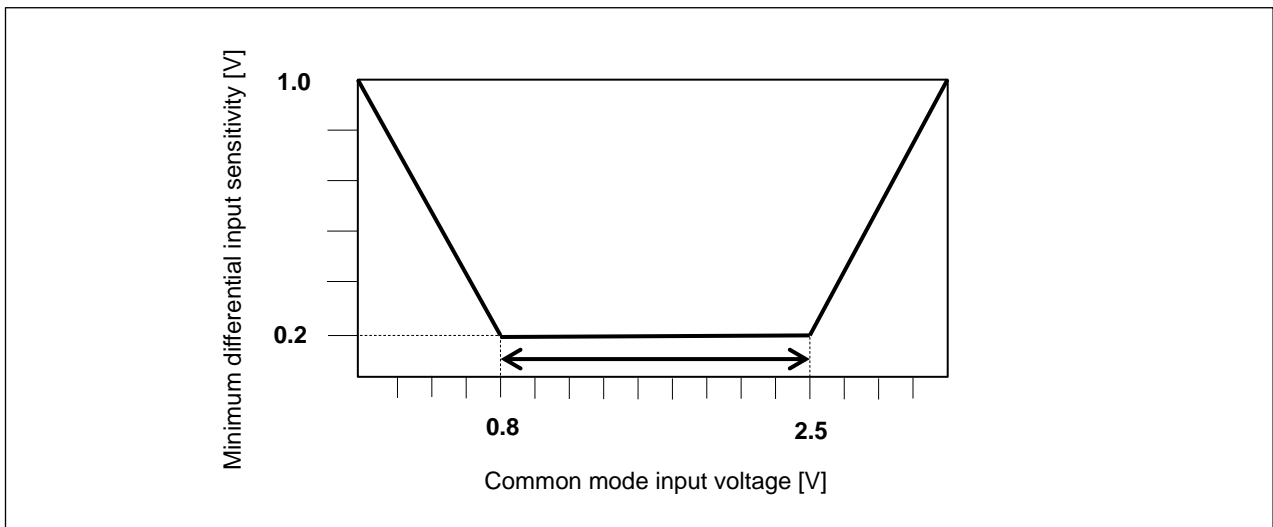


## 11.6 USB Characteristics

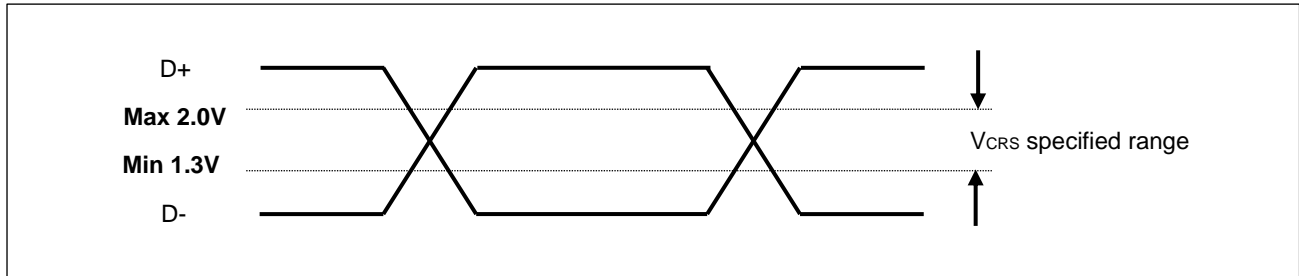
( $V_{CC}=3.0\text{ V to }3.6\text{ V}$ ,  $V_{SS}=0\text{ V}$ ,  $T_A=-40^\circ\text{C to }+105^\circ\text{C}$ )

| Parameter             | Symbol                         | Pin Name   | Conditions                                    | Value          |                | Unit     | Schematic Reference |
|-----------------------|--------------------------------|------------|---|----------------|----------------|----------|---------------------|
|                       |                                |            |   | Min            | Max            |          |                     |
| Input characteristics | Input H level voltage          | $V_{IH}$   | -   | 2.0            | $V_{CC} + 0.3$ | V        | 1                   |
|                       | Input L level voltage          | $V_{IL}$   | -   | $V_{SS} - 0.3$ | 0.8            | V        | 1                   |
|                       | Differential input sensitivity | $V_{DI}$   | -   | 0.2            | -              | V        | 2                   |
|                       | Differential common mode range | $V_{CM}$   | -   | 0.8            | 2.5            | V        | 2                   |
| Output characteristic | Output H level voltage         | $V_{OH}$   | External pull-down resistance = 15 k $\Omega$ | 2.8            | 3.6            | V        | 3                   |
|                       | Output L level voltage         | $V_{OL}$   | External pull-up resistance = 1.5 k $\Omega$  | 0.0            | 0.3            | V        | 3                   |
|                       | Crossover voltage              | $V_{CRS}$  | -   | 1.3            | 2.0            | V        | 4                   |
|                       | Rising time                    | $t_{FR}$   | Full-speed                                    | 4              | 20             | ns       | 5                   |
|                       | Falling time                   | $t_{FF}$   | Full-speed                                    | 4              | 20             | ns       | 5                   |
|                       | Rising/Falling time matching   | $t_{FRFM}$ | Full-speed                                    | 90             | 111.11         | %        | 5                   |
|                       | Output impedance               | $Z_{DRV}$  | Full-speed                                    | 28             | 44             | $\Omega$ | 6                   |
|                       | Rising time                    | $t_{LR}$   | Low-speed                                     | 75             | 300            | ns       | 7                   |
|                       | Falling time                   | $t_{LF}$   | Low-speed                                     | 75             | 300            | ns       | 7                   |
|                       | Rising/Falling time matching   | $t_{LRFM}$ | Low-speed                                     | 80             | 125            | %        | 7                   |

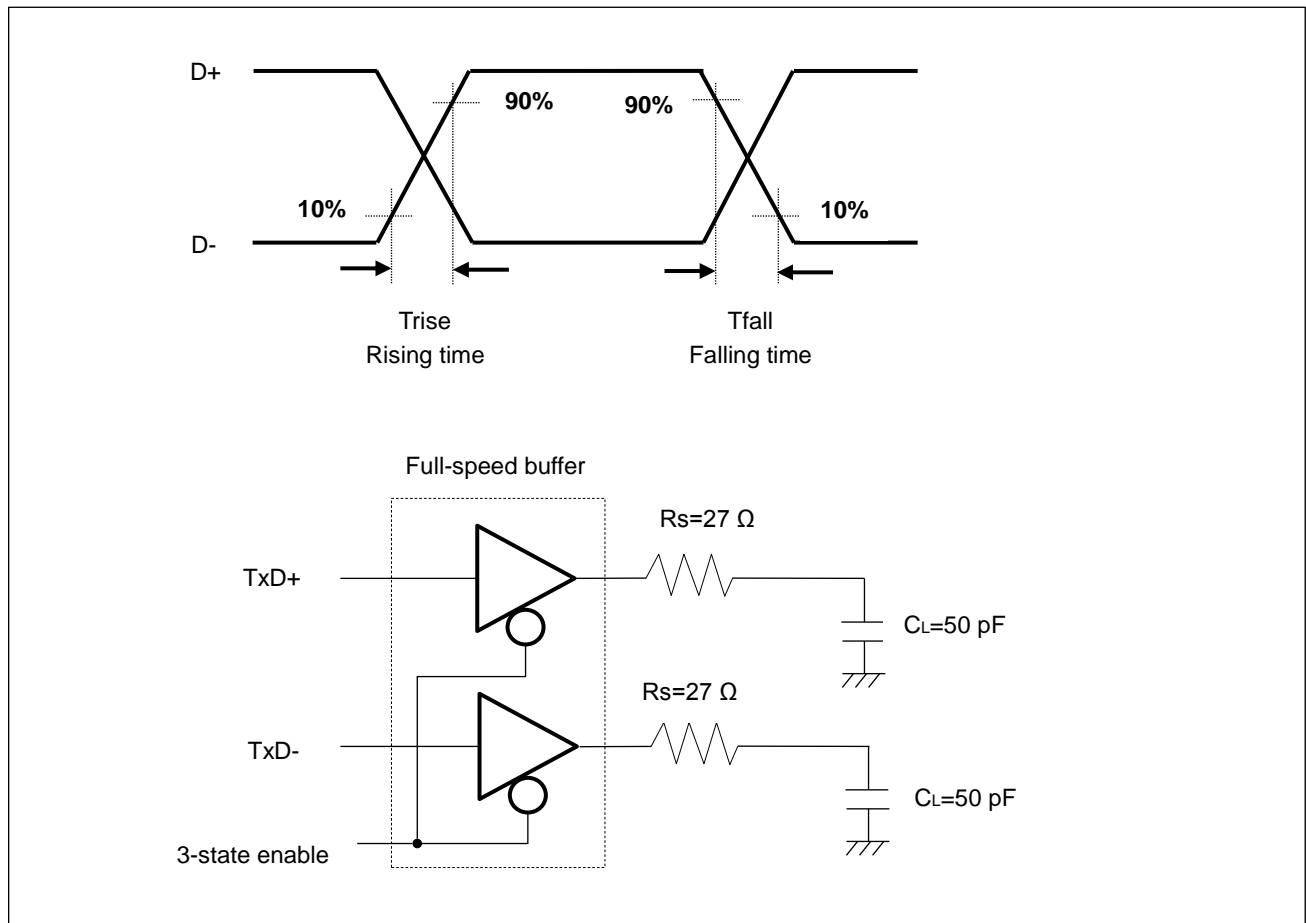
- The switching threshold voltage of single-end-receiver of USB I/O buffer is set as within  $V_{IL}(\text{Max})=0.8\text{ V}$ ,  $V_{IH}(\text{Min})=2.0\text{ V}$  (TTL input standard).  
There is some hysteresis to lower noise sensitivity.
- Use differential-receiver to receive USB differential data signal.  
Differential-receiver has 200 mV of differential input sensitivity when the differential data input is within 0.8 V to 2.5 V to the local ground reference level.  
Above voltage range is the common mode input voltage range.



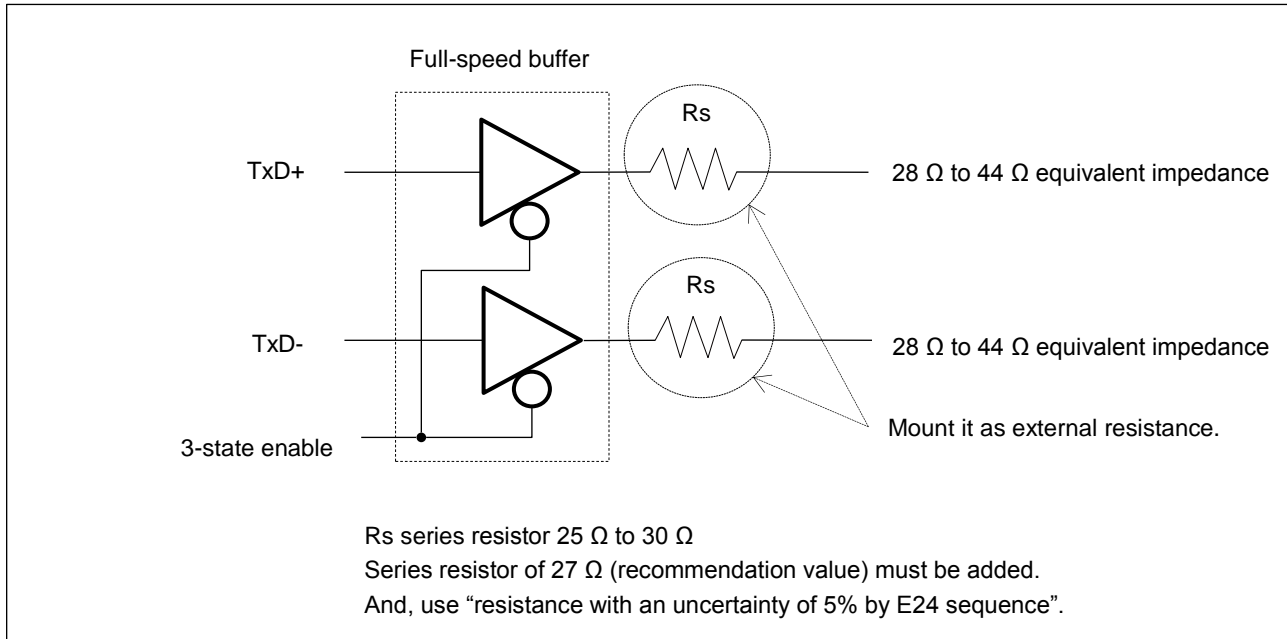
- The output drive capability of the driver is below 0.3 V at Low-state ( $V_{OL}$ ) (to 3.6 V and 1.5 k $\Omega$  load), and 2.8 V or above (to the VSS and 1.5 k $\Omega$  load) at high-state ( $V_{OH}$ )
- The cross voltage of the external differential output signal (D+ / D-) of USB I/O buffer is within 1.3 V to 2.0 V.



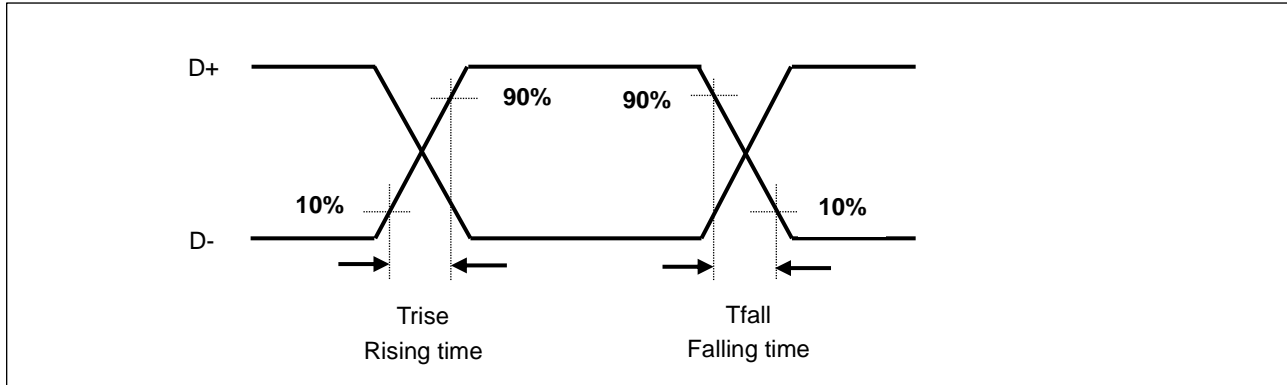
- They indicate rising time ( $T_{rise}$ ) and falling time ( $T_{fall}$ ) of the full-speed differential data signal. They are defined by the time between 10% and 90% of the output signal voltage. For full-speed buffer,  $T_r/T_f$  ratio is regulated as within  $\pm 10\%$  to minimize RFI emission.



- USB Full-speed connection is performed via twist pair cable shield with  $90 \Omega \pm 15\%$  characteristic impedance (Differential Mode).  
 USB standard defines that output impedance of USB driver must be in range from  $28 \Omega$  to  $44 \Omega$ . So, discrete series resistor ( $R_s$ ) addition is defined to satisfy the above definition and keep balance.  
 When using this USB I/O, use it with  $25 \Omega$  to  $33 \Omega$  (recommendation value:  $27 \Omega$ ) series resistor  $R_s$ .

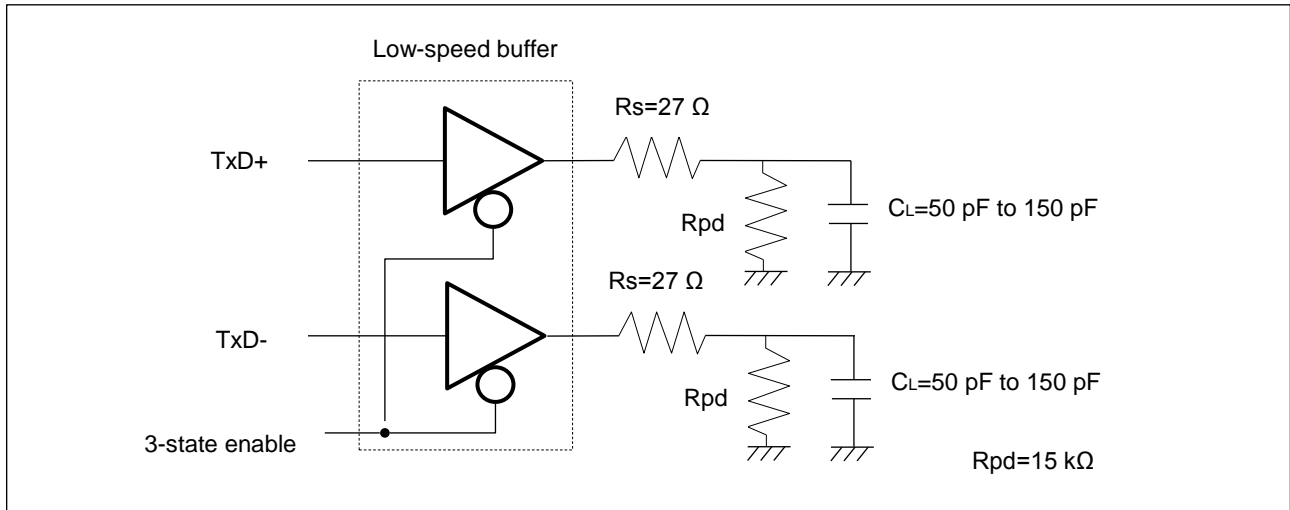


7. They indicate rising time ( $T_{rise}$ ) and falling time ( $T_{fall}$ ) of the low-speed differential data signal. They are defined by the time between 10% and 90% of the output signal voltage.

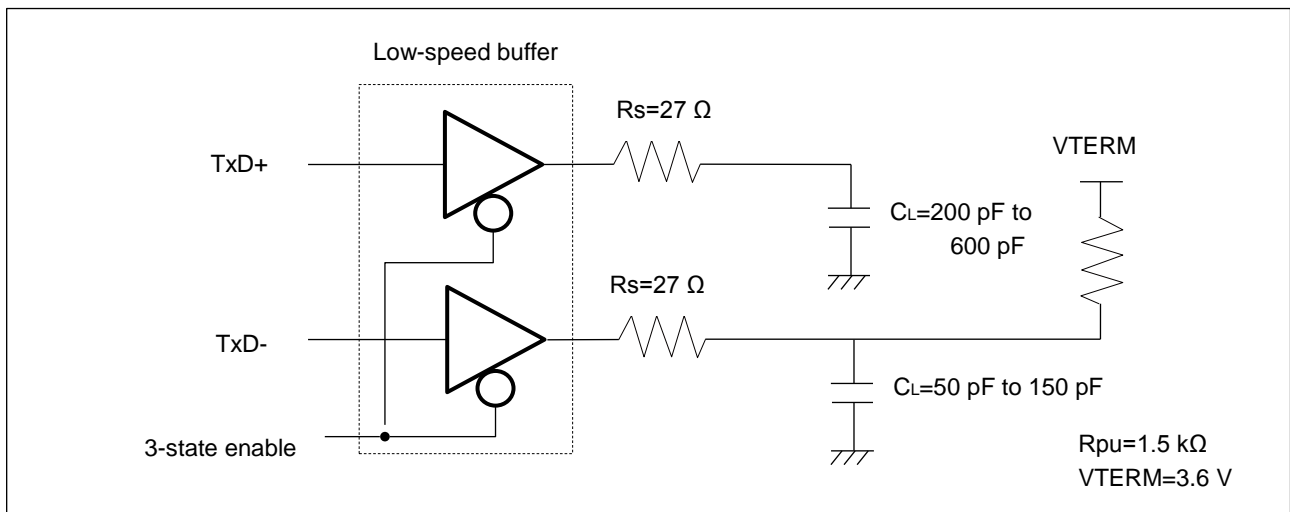


See “Low-speed load (Compliance Load)” for conditions of external load.

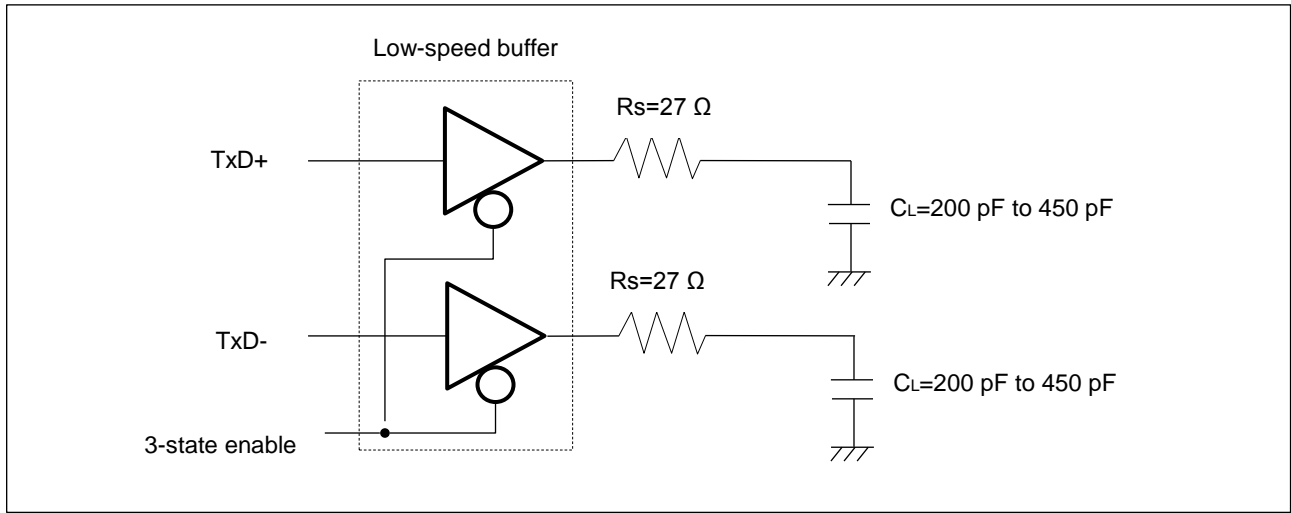
• Low-Speed Load (Upstream Port Load) – Reference 1



• Low-Speed Load (Downstream Port Load) – Reference 2



- Low-Speed Load (Compliance Load)



## 11.7 Low-Voltage Detection Characteristics

### 11.7.1 Low-Voltage Detection Reset

(T<sub>A</sub>=-40°C to +105°C)

| Parameter                   | Symbol            | Conditions          | Value |      |  | Unit | Remarks            |
|-----------------------------|-------------------|---------------------|-------|------|--|------|--------------------|
|                             |                   |                     | Min   | Typ  | Max                                      |      |                    |
| Detected voltage            | V <sub>DL</sub>   | Fixed <sup>67</sup> | 1.38  | 1.50 | 1.60                                     | V    | When voltage drops |
| Released voltage            | V <sub>DH</sub>   |                     | 1.43  | 1.55 | 1.65                                     | V    | When voltage rises |
| LVD stabilization wait time | T <sub>LVDW</sub> | -                   | -     | -    | 8160x<br>t <sub>CYCP</sub> <sup>68</sup> | μs   |                    |
| LVD detection delay time    | T <sub>LVDL</sub> | -                   | -     | -    | 200                                      | μs   |                    |

<sup>67</sup> The value of low voltage detection reset is always fixed.

<sup>68</sup> t<sub>CYCP</sub> indicates the APB1 bus clock cycle time.



**11.7.2 Low-Voltage Detection Interrupt**

 (T<sub>A</sub>=-40°C to +105°C)

| Parameter                   | Symbol            | Conditions | Value |      |  | Unit | Remarks            |
|-----------------------------|-------------------|------------|-------|------|--|------|--------------------|
|                             |                   |            | Min   | Typ  | Max                                    |      |                    |
| Detected voltage            | VDL               | SVHI=00100 | 1.56  | 1.70 | 1.84                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 1.61  | 1.75 | 1.89                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=00101 | 1.61  | 1.75 | 1.89                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 1.66  | 1.80 | 1.94                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=00110 | 1.66  | 1.80 | 1.94                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 1.70  | 1.85 | 2.00                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=00111 | 1.70  | 1.85 | 2.00                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 1.75  | 1.90 | 2.05                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=01000 | 1.75  | 1.90 | 2.05                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 1.79  | 1.95 | 2.11                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=01001 | 1.79  | 1.95 | 2.11                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 1.84  | 2.00 | 2.16                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=01010 | 1.84  | 2.00 | 2.16                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 1.89  | 2.05 | 2.21                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=01011 | 1.89  | 2.05 | 2.21                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 1.93  | 2.10 | 2.27                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=01100 | 2.30  | 2.50 | 2.70                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 2.39  | 2.60 | 2.81                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=01101 | 2.39  | 2.60 | 2.81                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 2.48  | 2.70 | 2.92                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=01110 | 2.48  | 2.70 | 2.92                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 2.58  | 2.80 | 3.02                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=01111 | 2.58  | 2.80 | 3.02                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 2.67  | 2.90 | 3.13                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=10000 | 2.67  | 2.90 | 3.13                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 2.76  | 3.00 | 3.24                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=10001 | 2.76  | 3.00 | 3.24                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 2.85  | 3.10 | 3.35                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=10010 | 2.85  | 3.10 | 3.35                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 2.94  | 3.20 | 3.46                                   | V    | When voltage rises |
| Detected voltage            | VDL               | SVHI=10011 | 2.94  | 3.20 | 3.46                                   | V    | When voltage drops |
| Released voltage            | VDH               |            | 3.04  | 3.30 | 3.56                                   | V    | When voltage rises |
| LVD stabilization wait time | T <sub>LVDW</sub> | -          | -     | -    | 8160 × t <sub>CYCP</sub> <sup>69</sup> | μs   |                    |
| LVD detection delay time    | T <sub>LVDL</sub> | -          | -     | -    | 200                                    | μs   |                    |

<sup>69</sup> t<sub>CYCP</sub> represents the APB1 bus clock cycle time.

## 11.8 Flash Memory Write/Erase Characteristics

(V<sub>CC</sub>=1.65 V to 3.6 V, T<sub>A</sub>=- 40°C to +105°C)

| Parameter                    |              | Value <sup>70</sup> |     |      | Unit | Remarks   |
|------------------------------|--------------|---------------------|-----|------|------|---|
|                              |              | Min                 | Typ | Max  |      |   |
| Sector erase time            | Large sector | -                   | 1.1 | 2.7  | s    | The sector erase time includes the time of writing prior to internal erase. |
|                              | Small sector | -                   | 0.3 | 0.9  |      |   |
| Halfword (16-bit) write time |              | -                   | 30  | 528  | μs   | The halfword (16-bit) write time excludes the system-level overhead.        |
| Chip erase time              |              | -                   | 4.5 | 11.7 | s    | The chip erase time includes the time of writing prior to internal erase.   |

### Write/Erase Cycle and Data Hold Time

| Write/Erase Cycle | Data Hold Time (Year) | Remarks  |
|-------------------|-----------------------|--|
| 1,000             | 20                    | These values come from the technology qualification (using Arrhenius equation to translate high temperature acceleration test result into average temperature value at +85°C). |
| 10,000            | 10                    |  |

<sup>70</sup> The typical value is immediately after shipment, the maximum value is guarantee value under 10,000 cycle of erase/write.

**11.9 Return Time from Low-Power Consumption Mode**

**11.9.1 Return Factor: Interrupt/WKUP**

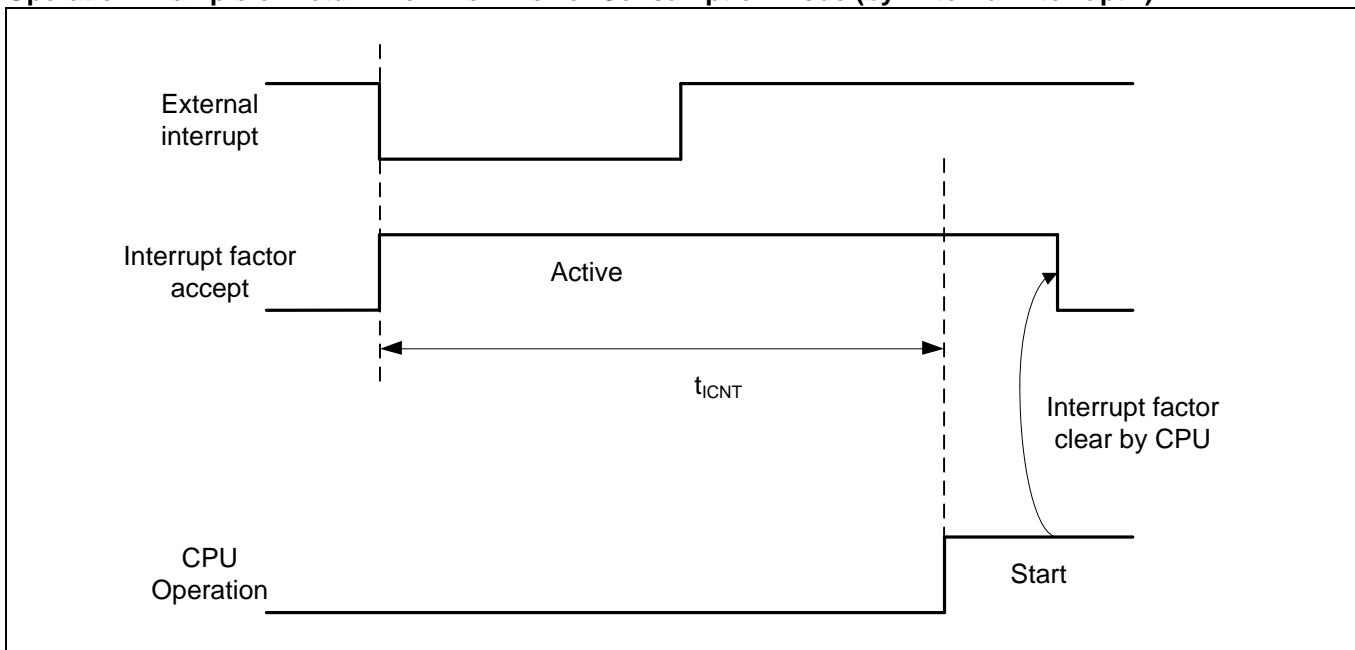
The return time from Low-Power consumption mode is indicated as follows. It is from receiving the return factor to starting the program operation.

**Return Count Time**

( $V_{CC}=1.65\text{ V to }3.6\text{ V}$ ,  $T_A=-40^\circ\text{C to }+105^\circ\text{C}$ )

| Parameter                                       |   | Symbol            | Value                             |                                   | Unit | Remarks                       |
|---|---|-------------------|-----------------------------------|-----------------------------------|------|-------------------------------|
| Current Mode                                    | Mode to return  |                   | Typ                               | Max <sup>71</sup>                 |      |                               |
| Sleep mode                                      | each Run Mode   | t <sub>ICNT</sub> | 4*HCLK                            |                                   | μs   | When High-speed CR is enabled |
| Timer mode                                      | High-speed CR Run mode<br>Main Run mode<br>PLL Run mode         |                   | 12*HCLK                           | 13*HCLK                           | μs   | When High-speed CR is enabled |
|   | Low-speed CR Run mode<br>Sub Run mode                           |                   | 34+12*HCLK                        | 72+13*HCLK                        | μs   |                               |
| Stop Mode                                       | High-speed CR Run mode<br>Low-speed CR Run mode                 |                   | 34+12*HCLK                        | 72+13*HCLK                        | μs   |                               |
|   | Main Run mode<br>Sub Run mode<br>PLL Run mode                   |                   | 34+12*HCLK<br>+t <sub>OSCWT</sub> | 72+13*HCLK<br>+t <sub>OSCWT</sub> | μs   | <sup>72</sup>                 |
| RTC mode  | High-speed CR Run mode<br>Low-speed CR Run mode<br>Sub Run mode |                   | 34+12*HCLK                        | 72+13*HCLK                        | μs   |                               |
|   | Main Run mode<br>PLL Run mode                                   |                   | 34+12*HCLK<br>+t <sub>OSCWT</sub> | 72+13*HCLK<br>+t <sub>OSCWT</sub> | μs   | <sup>72</sup>                 |
| Deep Standby RTC mode<br>Deep Standby Stop mode | High-speed CR Run mode  |                   | 43                                | 281                               | μs   |                               |

**Operation Example of Return from Low-Power Consumption Mode (by External Interrupt<sup>73</sup>)**

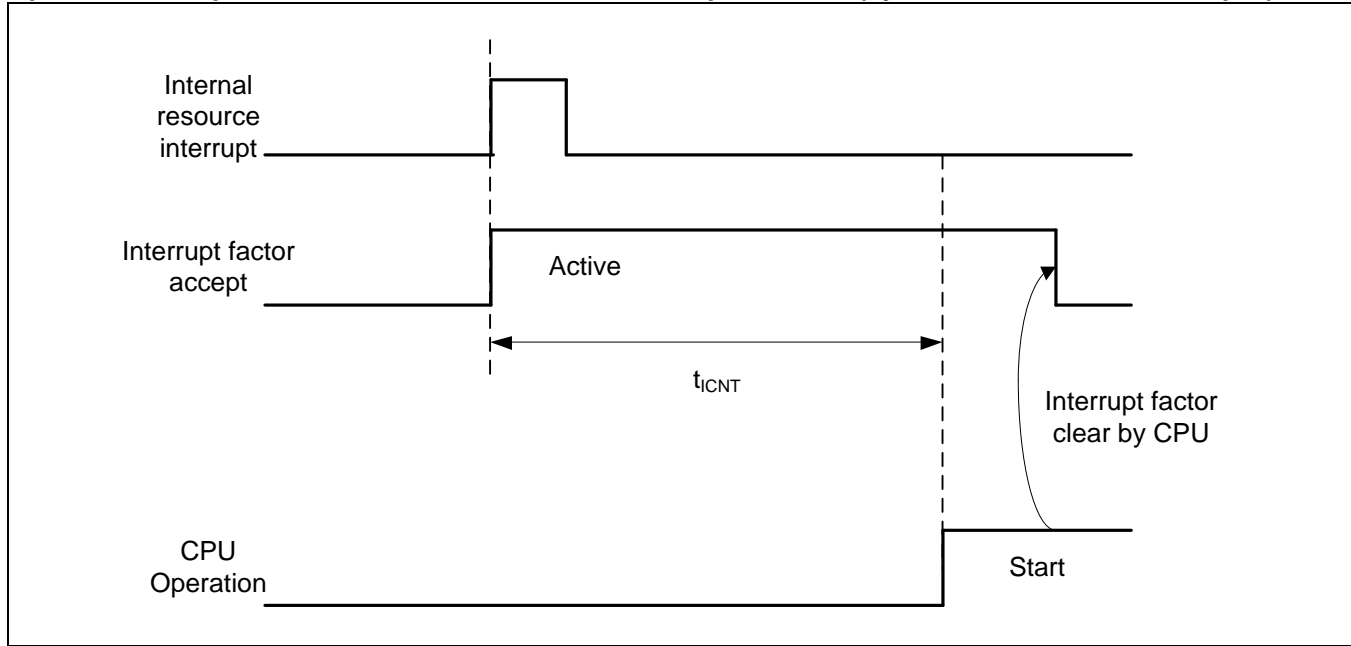


<sup>71</sup> The maximum value depends on the condition of environment.

<sup>72</sup> t<sub>OSCWT</sub>: Oscillator stabilization time.

<sup>73</sup> External interrupt is set to detecting fall edge.

Operation Example of Return from Low-Power Consumption Mode (by Internal Resource Interrupt<sup>74</sup>)



**Notes:**

- The return factor is different in each Low-Power consumption modes. See "Chapter: Low Power Consumption Mode" and "Operations of Standby Modes" in FM0+ Family Peripheral Manual.
- When interrupt recovers, the operation mode that CPU recovers depends on the state before the Low-Power consumption mode transition. See "Chapter: Low Power Consumption Mode" in "FM0+ Family Peripheral Manual".

<sup>74</sup> Internal resource interrupt is not included in return factor by the kind of Low-Power consumption mode.

**11.9.2 Return Factor: Reset**

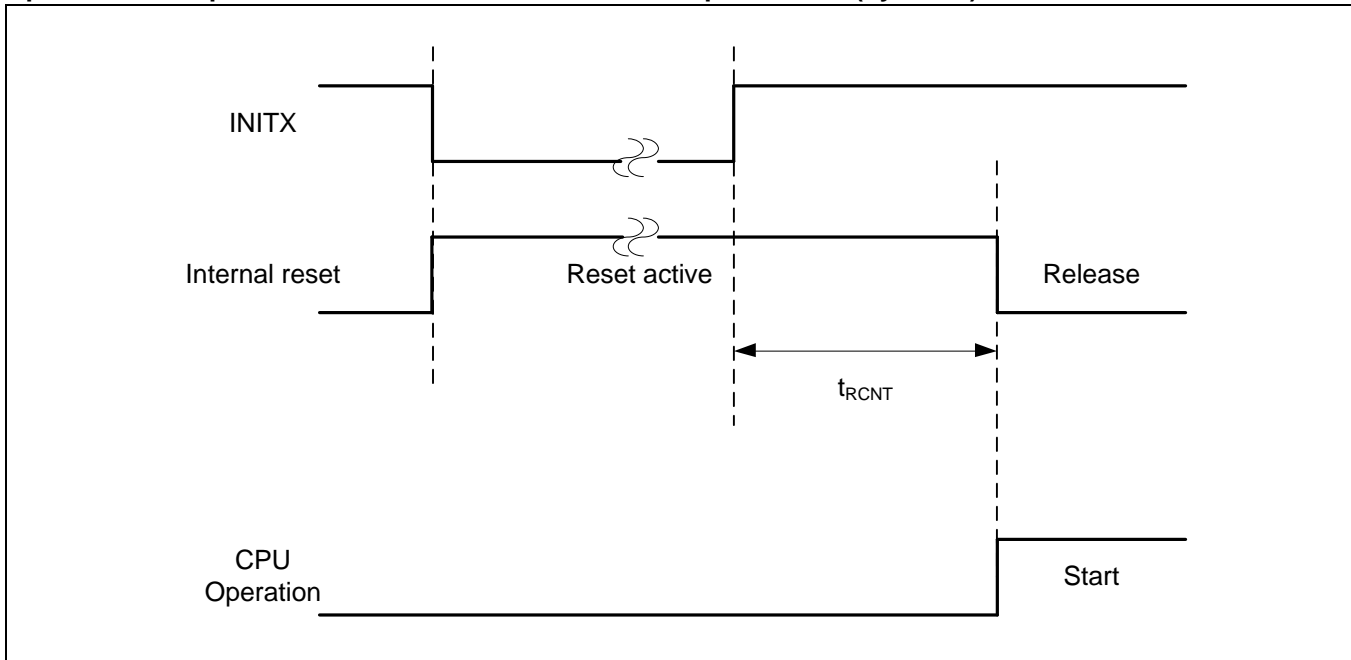
The return time from Low-Power consumption mode is indicated as follows. It is from releasing reset to starting the program operation.

**Return Count Time**

( $V_{CC}=1.65\text{ V to }3.6\text{ V}$ ,  $T_A=-40^{\circ}\text{C to }+105^{\circ}\text{C}$ )

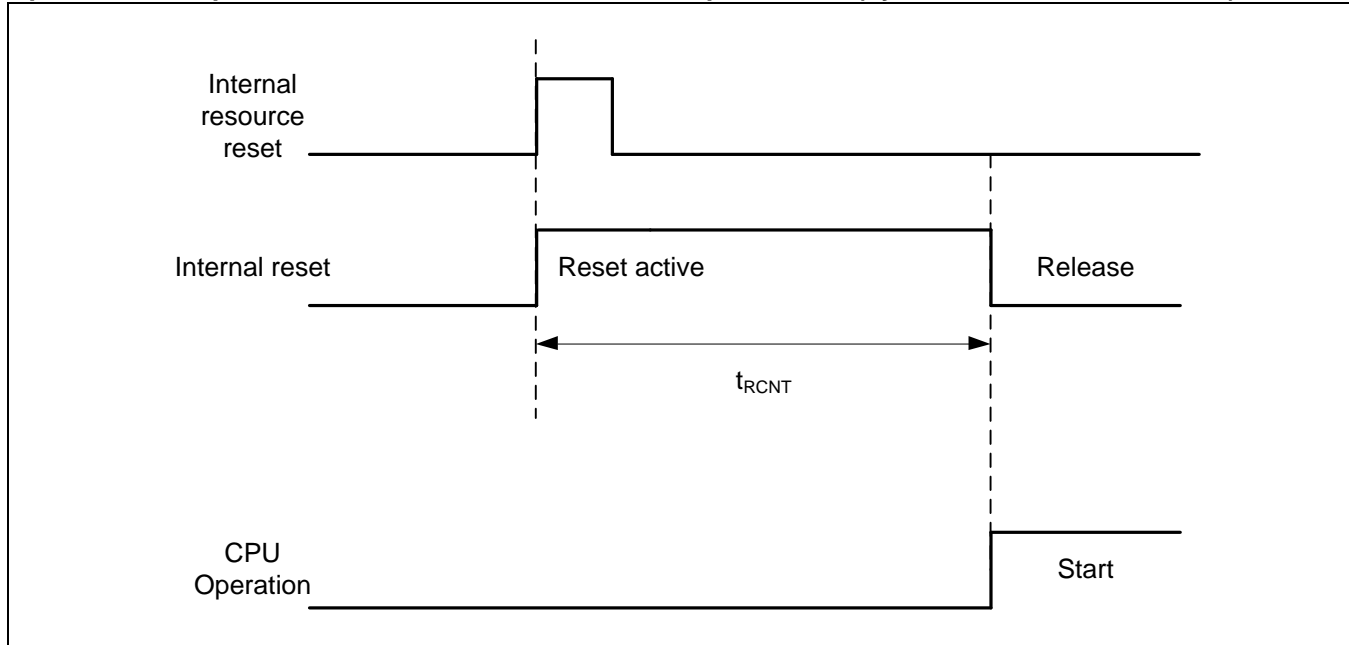
| Parameter   |                        | Symbol     | Value |                   | Unit          | Remarks                       |
|---|------------------------|------------|-------|-------------------|---------------|-------------------------------|
| Current Mode  | Mode to return         |            | Typ   | Max <sup>75</sup> |               |                               |
| High-speed CR Sleep mode<br>Main Sleep mode<br>PLL Sleep mode | High-speed CR Run mode | $t_{RCNT}$ | 20    | 22                | $\mu\text{s}$ | When High-speed CR is enabled |
| Low-speed CR Sleep mode                                       |                        |            | 50    | 106               | $\mu\text{s}$ | When High-speed CR is enabled |
| Sub Sleep mode  |                        |            | 112   | 137               | $\mu\text{s}$ | When High-speed CR is enabled |
| High-speed CR Timer mode<br>Main Timer mode<br>PLL Timer mode |                        |            | 20    | 22                | $\mu\text{s}$ | When High-speed CR is enabled |
| Low-speed CR Timer mode                                       |                        |            | 87    | 159               | $\mu\text{s}$ |                               |
| Sub Timer mode  |                        |            | 148   | 209               | $\mu\text{s}$ |                               |
| Stop mode<br>RTC mode   |                        |            | 45    | 68                | $\mu\text{s}$ |                               |
| Deep Standby RTC mode<br>Deep Standby Stop mode               |                        |            | 43    | 281               | $\mu\text{s}$ |                               |

**Operation Example of Return from Low-Power Consumption Mode (by INITX)**



<sup>75</sup> The maximum value depends on the accuracy of built-in CR.

**Operation Example of Return from Low Power Consumption Mode (by Internal Resource Reset<sup>76</sup>)**



**Notes:**

- The return factor is different in each Low-Power consumption modes. See "Chapter: Low Power Consumption Mode" and "Operations of Standby Modes" in FM0+ Family Peripheral Manual.
- When interrupt recovers, the operation mode that CPU recovery depends on the state before the Low-Power consumption mode transition. See "Chapter: Low Power Consumption Mode" in "FM0+ Family Peripheral Manual".
- The time during the power-on reset/low-voltage detection reset is excluded. See "11.4.7 Power-on Reset Timing in 11.4 AC Characteristics in 11. Electrical Characteristics" for the detail on the time during the power-on reset/low -voltage detection reset.
- When in recovery from reset, CPU changes to the high-speed CR run mode. When using the main clock or the PLL clock, it is necessary to add the main clock oscillation stabilization wait time or the main PLL clock stabilization wait time.
- The internal resource reset means the watchdog reset and the CSV reset.

<sup>76</sup> Internal resource reset is not included in return factor by the kind of Low-Power consumption mode.

**12. Ordering Information**

| Part number       | Flash [Kbyte] | SRAM [Kbyte] | USB2.0 | I <sup>2</sup> S | Package-Specific Features (see next table) | Package (Tray)                                      |
|-------------------|---------------|--------------|--------|------------------|--|---|
| S6E1C32D0AGV20000 | 128           | 16           | ✓      | ✓                | 64-pin                                     | Plastic • LQFP (0.50 mm pitch), 64 pins (LQD064-02) |
| S6E1C31D0AGV20000 | 64            | 12           | ✓      | ✓                |  |   |
| S6E1C32C0AGV20000 | 128           | 16           | ✓      | ✓                | 48-pin                                     | Plastic • LQFP (0.50 mm pitch), 48 pins (LQA048-02) |
| S6E1C31C0AGV20000 | 64            | 12           | ✓      | ✓                |  |   |
| S6E1C32B0AGP20000 | 128           | 16           | ✓      |                  | 32-pin                                     | Plastic • LQFP (0.80 mm pitch), 32 pins (LQB032)    |
| S6E1C31B0AGP20000 | 64            | 12           | ✓      |                  |  |   |
| S6E1C32D0AGN20000 | 128           | 16           | ✓      | ✓                | 64-pin                                     | Plastic • QFN64 (0.50 mm pitch), 64 pins (WNS064)   |
| S6E1C31D0AGN20000 | 64            | 12           | ✓      | ✓                |  |   |
| S6E1C32C0AGN20000 | 128           | 16           | ✓      | ✓                | 48-pin                                     | Plastic • QFN48 (0.50 mm pitch), 48 pins (WNY048)   |
| S6E1C31C0AGN20000 | 64            | 12           | ✓      | ✓                |  |   |
| S6E1C32B0AGN20000 | 128           | 16           | ✓      |                  | 32-pin                                     | Plastic • QFN32 (0.50 mm pitch), 32 pins (WNU032)   |
| S6E1C31B0AGN20000 | 64            | 12           | ✓      |                  |  |   |
| S6E1C12D0AGV20000 | 128           | 16           |        | ✓                | 64-pin                                     | Plastic • LQFP (0.50 mm pitch), 64 pins (LQD064-02) |
| S6E1C11D0AGV20000 | 64            | 12           |        | ✓                |  |   |
| S6E1C12C0AGV20000 | 128           | 16           |        | ✓                | 48-pin                                     | Plastic • LQFP (0.50 mm pitch), 48 pins (LQA048-02) |
| S6E1C11C0AGV20000 | 64            | 12           |        | ✓                |  |   |
| S6E1C12B0AGP20000 | 128           | 16           |        |                  | 32-pin                                     | Plastic • LQFP (0.80 mm pitch), 32 pins (LQB032)    |
| S6E1C11B0AGP20000 | 64            | 12           |        |                  |  |   |
| S6E1C12D0AGN20000 | 128           | 16           |        | ✓                | 64-pin                                     | Plastic • QFN64 (0.50 mm pitch), 64 pins (WNS064)   |
| S6E1C11D0AGN20000 | 64            | 12           |        | ✓                |  |   |
| S6E1C12C0AGN20000 | 128           | 16           |        | ✓                | 48-pin                                     | Plastic • QFN48 (0.50 mm pitch), 48 pins (WNY048)   |
| S6E1C11C0AGN20000 | 64            | 12           |        | ✓                |  |   |
| S6E1C12B0AGN20000 | 128           | 16           |        |                  | 32-pin                                     | Plastic • QFN32 (0.50 mm pitch), 32 pins (WNU032)   |
| S6E1C11B0AGN20000 | 64            | 12           |        |                  |  |   |

| Feature  | Package  |   |   |
|--|--|---|---|
|  | 32 LQFP<br>32 QFN  | 48 LQFP<br>48 QFN   | 64 LQFP<br>64 QFN   |
| Pin count  | 32   | 48  | 64  |
| Multi-function Serial Interface<br>(UART/CSIO/I <sup>2</sup> C/I <sup>2</sup> S) | 4 ch. (Max)<br>Ch.0/1/3 without<br>FIFO<br>Ch. 6 with FIFO | 6 ch. (Max)<br>Ch.0/1/3 without<br>FIFO<br>Ch.4/6/7 with FIFO | 6 ch. (Max)<br>Ch.0/1/3 without<br>FIFO<br>Ch.4/6/7 with FIFO |
|  | I <sup>2</sup> S: No                                       | I <sup>2</sup> S: 1 ch (Max)<br>Ch. 6 with FIFO               | I <sup>2</sup> S: 2 ch (Max)<br>Ch. 4/6 with FIFO             |
| External Interrupt   | 7 pins (Max),<br>NMI x 1                                   | 9 pins (Max),<br>NMI x 1                                      | 12 pins (Max),<br>NMI x 1                                     |
| I/O port   | 24 pins (Max)  | 38 pins (Max)   | 54 pins (Max)   |
| 12-bit A/D converter   | 6 ch. (1 unit)   | 8 ch. (1 unit)  | 8 ch. (1 unit)  |
| I <sup>2</sup> C Slave   | No   |   | 1 ch (Max)  |
| Smart Card Interface   | No   |   | 1 ch (Max)  |
| HDMI-CEC/ Remote Control<br>Receiver   | 1 ch.(Max)<br>Ch.1   | 2 ch (Max)<br>Ch.0/1  |   |

### 13. Acronyms

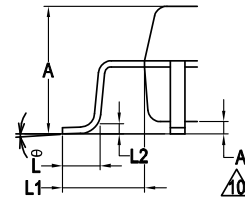
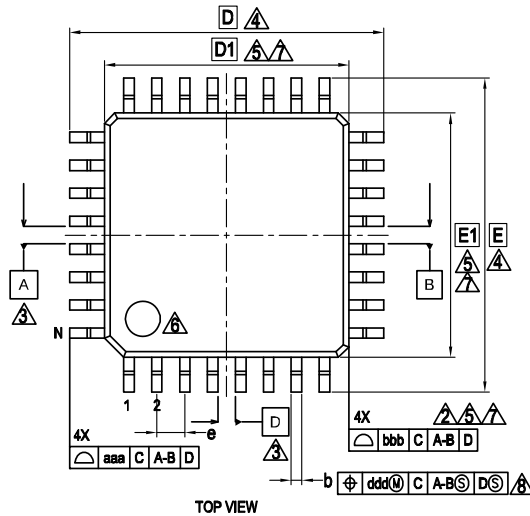
| Acronym                  | Description  |
|--------------------------|--|
| ADC                      | analog-to-digital converter  |
| ACK                      | acknowledge  |
| AHB                      | AMBA (advanced microcontroller bus architecture) high-performance bus, an ARM data transfer bus                |
| ARM <sup>®</sup>         | Advanced RISC Machine, a CPU architecture  |
| CEC                      | Consumer Electronics Control, a command and control interface over HDMI (High Definition Multimedia Interface) |
| CMOS                     | complementary metal oxide semiconductor  |
| CPU                      | central processing unit  |
| CR                       | clock and reset  |
| CRC                      | cyclic redundancy check, an error-checking protocol  |
| CSIO                     | clock synchronous serial interface   |
| CSV                      | clock supervisor   |
| CTS                      | clear to send, a flow control signal in some data communication interfaces                                     |
| DTSC                     | descriptor system data transfer controller   |
| EOM                      | end of message   |
| FIFO                     | first in, first out  |
| GPIO                     | general-purpose input/output   |
| HDMI                     | High Definition Multimedia Interface   |
| HDMI-CEC                 | High Definition Multimedia Interface - Consumer Electronics Control, see CEC                                   |
| I/F                      | interface  |
| I <sup>2</sup> C, or IIC | Inter-Integrated Circuit, a communications protocol  |
| I <sup>2</sup> S, or IIS | Inter-IC (integrated circuit) Sound, a communications protocol   |
| I/O                      | input/output, see also GPIO  |
| IRQ                      | interrupt request  |
| LIN                      | Local Interconnect Network, a communications protocol  |
| LVD                      | low-voltage detect   |
| MFS                      | multi-function serial  |



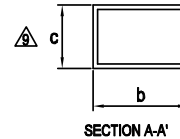
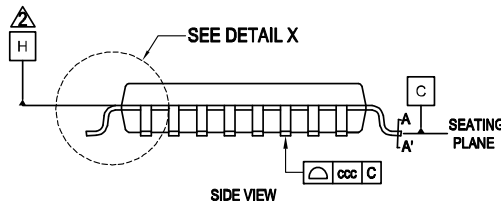
| <b>Acronym</b> | <b>Description</b>   |
|----------------|--|
| MSB            | most significant byte  |
| MTB            | micro trace buffer   |
| NMI            | non-maskable interrupt   |
| NVIC           | nested vectored interrupt controller   |
| OS             | operating system   |
| OSC            | oscillator   |
| PLL            | phase-locked loop  |
| PPG            | programmable pulse generator   |
| PWC            | pulse-width counter  |
| PWM            | pulse-width modulator  |
| RAM            | random access memory   |
| RX             | receive  |
| RTS            | request to send, a flow control signal in some data communication interfaces |
| SPI            | Serial Peripheral Interface, a communications protocol                       |
| SRAM           | static random access memory  |
| SW-DP          | serial wire debug port   |
| TX             | transmit   |
| UART           | universal asynchronous receiver transmitter                                  |
| USB            | Universal Serial Bus   |

14. Package Dimensions

LQB032 032 LEAD PLASTIC LOW PROFILE QUAD FLAT PACKAGE



DETAIL X



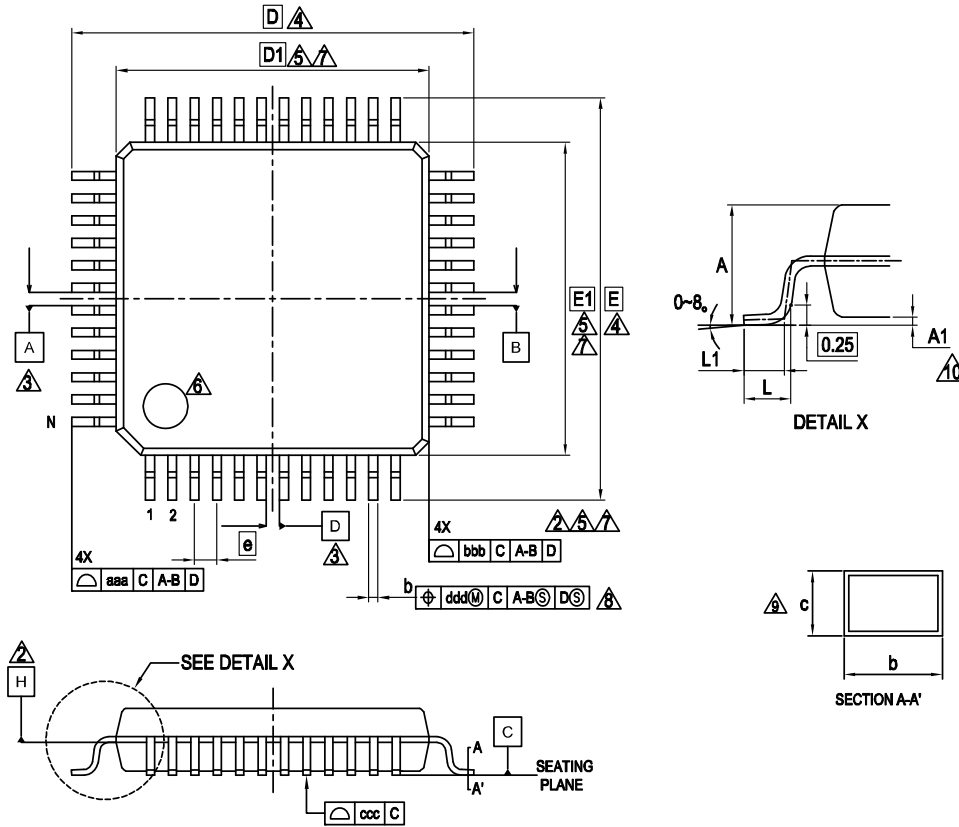
SECTION A-A'

| PACKAGE | LQB032   |      |      | SYMBOL | TOLERANCES OF FORM AND POSITION |
|---------|----------|------|------|--------|---------------------------------|
| SYMBOL  | MIN.     | NOM. | MAX. |        |                                 |
| A       | —        | —    | 1.60 | N      | 32                              |
| A1      | 0.05     | —    | 0.15 | aaa    | 0.20                            |
| b       | 0.32     | 0.35 | 0.42 | bbb    | 0.10                            |
| c       | 0.13     | —    | 0.18 | ccc    | 0.10                            |
| D       | 9.00 BSC |      |      | ddd    | 0.20                            |
| D1      | 7.00 BSC |      |      |        |                                 |
| e       | 0.80 BSC |      |      |        |                                 |
| E       | 9.00 BSC |      |      |        |                                 |
| E1      | 7.00 BSC |      |      |        |                                 |
| θ       | 0°       | —    | 7°   |        |                                 |
| L       | 0.45     | 0.60 | 0.75 |        |                                 |
| L1      | 1.00 REF |      |      |        |                                 |
| L2      | 0.25 BSC |      |      |        |                                 |

NOTES

- CONTROLLING DIMENSIONS ARE IN MILLIMETERS (mm)
- DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
- DATUMS A-B AND D TO BE DETERMINED AT DATUM PLANE H.
- TO BE DETERMINED AT SEATING PLANE C.
- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
- DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
- REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS, DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS, BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
- DIMENSION b DOES NOT INCLUDE DAMBER PROTRUSION. THE DAMBER PROTRUSION (S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
- THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
- A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

LQA048-02 , 48 Lead Plastic Low Profile Quad Flat Package

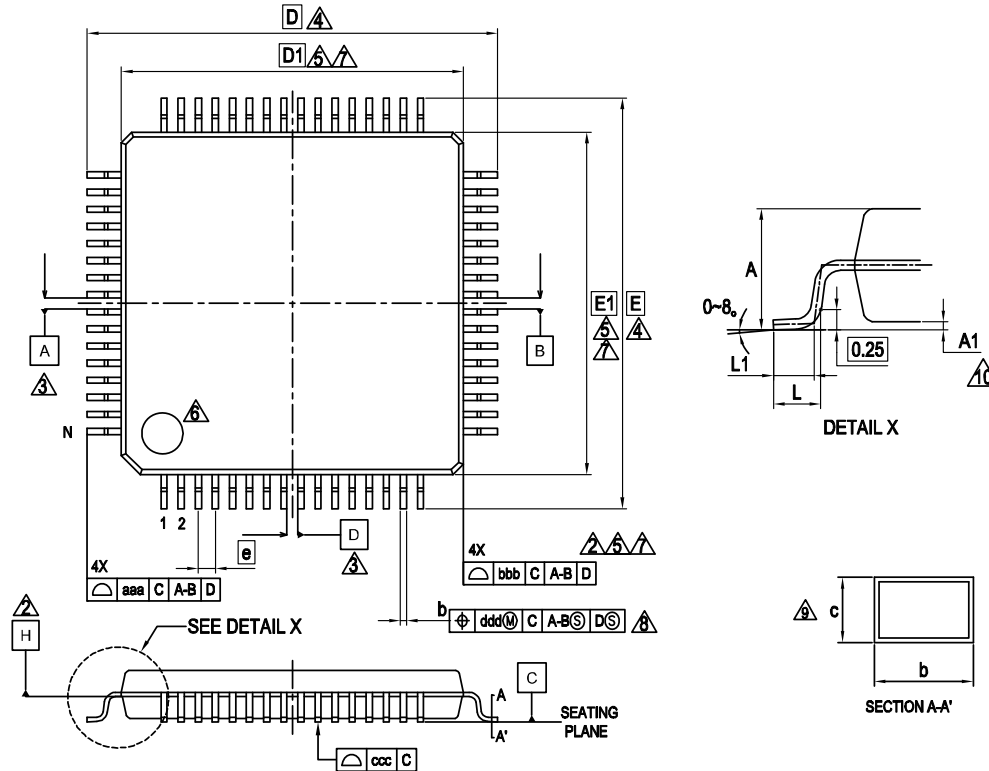


| PACKAGE | LQA048-02 |      |      |
|---------|-----------|------|------|
| SYMBOL  | MIN.      | NOM. | MAX. |
| A       | —         | —    | 1.70 |
| A1      | 0.00      | —    | 0.20 |
| b       | 0.17      | 0.22 | 0.27 |
| c       | 0.09      | —    | 0.20 |
| D       | 9.00 BSC. |      |      |
| D1      | 7.00 BSC. |      |      |
| e       | 0.50 BSC  |      |      |
| E       | 9.00 BSC. |      |      |
| E1      | 7.00 BSC. |      |      |
| L       | 0.45      | 0.60 | 0.75 |
| L1      | 0.30      | 0.50 | 0.70 |
| aaa     | —         | —    | 0.20 |
| bbb     | —         | —    | 0.10 |
| ccc     | —         | —    | 0.08 |
| ddd     | —         | —    | 0.08 |
| N       | 48        |      |      |

NOTES

- CONTROLLING DIMENSIONS ARE IN MILLIMETERS (mm)
- DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
- DATUMS A-B AND D TO BE DETERMINED AT DATUM PLANE H.
- TO BE DETERMINED AT SEATING PLANE C.
- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
- DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
- REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS, DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS. BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
- DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. THE DAMBAR PROTRUSION (S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
- THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
- A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

LQD064-02 , 64 Lead Plastic Low Profile Quad Flat Package

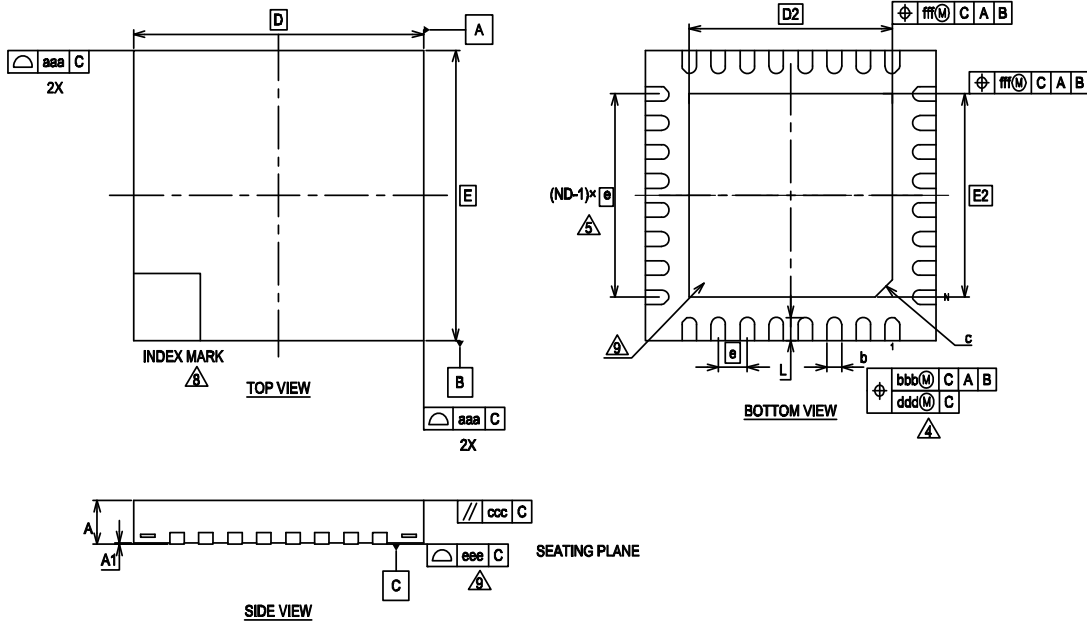


| PACKAGE | LQD64-02   |      |      |
|---------|------------|------|------|
| SYMBOL  | MIN.       | NOM. | MAX. |
| A       | —          | —    | 1.70 |
| A1      | 0.00       | —    | 0.20 |
| b       | 0.17       | 0.22 | 0.27 |
| c       | 0.09       | —    | 0.20 |
| D       | 12.00 BSC. |      |      |
| D1      | 10.00 BSC. |      |      |
| e       | 0.50 BSC   |      |      |
| E       | 12.00 BSC. |      |      |
| E1      | 10.00 BSC. |      |      |
| L       | 0.45       | 0.60 | 0.75 |
| L1      | 0.30       | 0.50 | 0.70 |
| aaa     | —          | —    | 0.20 |
| bbb     | —          | —    | 0.10 |
| ccc     | —          | —    | 0.08 |
| ddd     | —          | —    | 0.08 |
| N       | 64         |      |      |

NOTES

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (mm)
1. DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
2. DATUMS A-B AND D TO BE DETERMINED AT DATUM PLANE H.
3. TO BE DETERMINED AT SEATING PLANE C.
4. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
5. DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
6. REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS. DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS. BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
7. DIMENSION b DOES NOT INCLUDE DAMBER PROTRUSION. THE DAMBER PROTRUSION (S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
8. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
9. A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

## WNU032 VERY THIN PLASTIC QUAD FLAT NO LEAD PACKAGES



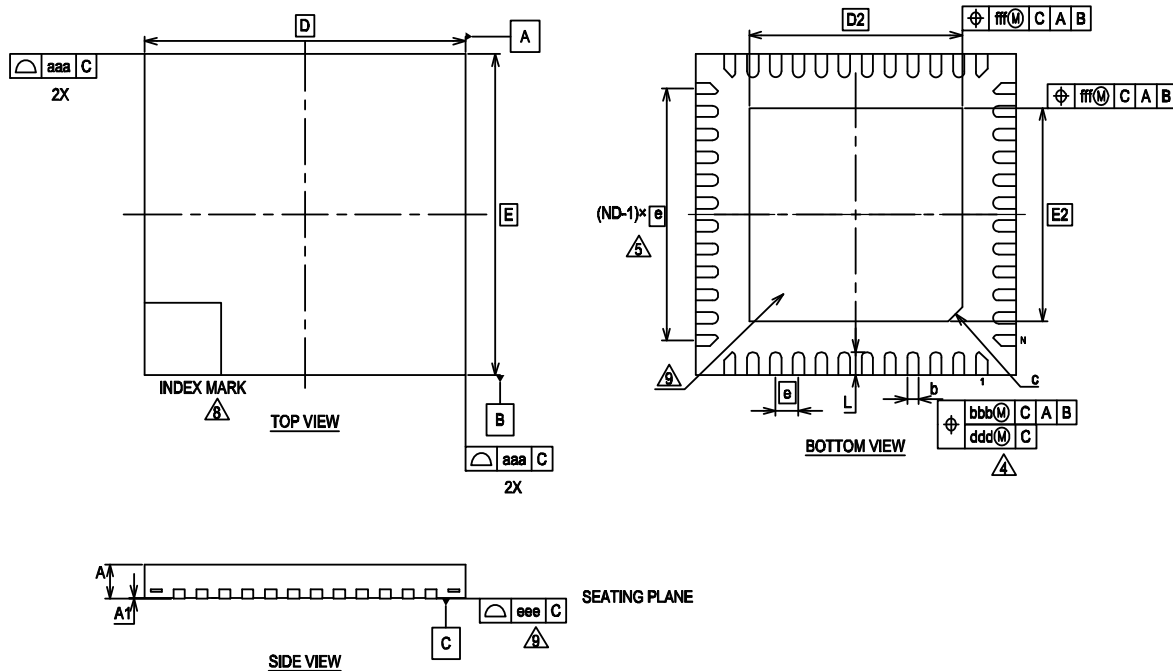
| SYMBOL | MILLIMETER |      |      | NOTE                |
|--------|------------|------|------|---------------------|
|        | MIN.       | NOM. | MAX. |                     |
| A      | —          | —    | 0.80 | PROFILE             |
| A1     | 0.00       | —    | 0.05 | TERMINAL HEIGHT     |
| D      | 5.00 BSC   |      |      | BODY SIZE           |
| E      | 5.00 BSC   |      |      | BODY SIZE           |
| b      | 0.20       | 0.25 | 0.30 | TERMINAL WIDTH      |
| D2     | 3.20 BSC   |      |      | EXPOSED PAD SIZE    |
| E2     | 3.20 BSC   |      |      | EXPOSED PAD SIZE    |
| e      | 0.50 BSC   |      |      | TERMINAL PITCH      |
| c      | 0.25 REF   |      |      | EXPOSED PAD CHAMFER |
| L      | 0.35       | 0.40 | 0.45 | TERMINAL LENGTH     |

|     |      |                |
|-----|------|----------------|
| N   | 32   | TERMINAL COUNT |
| aaa | 0.10 |                |
| bbb | 0.10 |                |
| ccc | 0.10 |                |
| ddd | 0.05 |                |
| eee | 0.08 |                |
| fff | 0.10 |                |

- DIMENSIONING AND TOLERANCING CONFORMS TO ASME Y14.5-1994.
- ALL DIMENSIONS ARE IN MILLIMETERS.
- N IS THE TOTAL NUMBER OF TERMINALS.
- DIMENSION "b" APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM TERMINAL TIP. IF THE TERMINAL HAS THE OPTIONAL RADIUS ON THE OTHER END OF THE TERMINAL, THE DIMENSION "b" SHOULD NOT BE MEASURED IN THAT RADIUS AREA.
- ND REFER TO THE NUMBER OF TERMINALS ON D OR E SIDE.
- MAX. PACKAGE WARPAGE IS 0.05mm.
- MAXIMUM ALLOWABLE BURRS IS 0.076mm IN ALL DIRECTIONS.
- PIN #1 ID ON TOP WILL BE LOCATED WITHIN INDICATED ZONE.
- BILATERAL COPLANARITY ZONE APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.

Rev. 0A

## WNY048 VERY THIN PLASTIC QUAD FLAT NO LEAD PACKAGES



| SYMBOL | MILLIMETER |      |      | NOTE                |
|--------|------------|------|------|---------------------|
|        | MIN.       | NOM. | MAX. |                     |
| A      | —          | —    | 0.80 | PROFILE             |
| A1     | 0.00       | —    | 0.05 | TERMINAL HEIGHT     |
| D      | 7.00 BSC   |      |      | BODY SIZE           |
| E      | 7.00 BSC   |      |      | BODY SIZE           |
| b      | 0.18       | 0.25 | 0.30 | TERMINAL WIDTH      |
| D2     | 4.65 BSC   |      |      | EXPOSED PAD SIZE    |
| E2     | 4.65 BSC   |      |      | EXPOSED PAD SIZE    |
| e      | 0.50 BSC   |      |      | TERMINAL PITCH      |
| c      | 0.30 REF   |      |      | EXPOSED PAD CHAMFER |
| L      | 0.45       | 0.50 | 0.55 | TERMINAL LENGTH     |
| N      | 48         |      |      | TERMINAL COUNT      |
| aaa    | 0.10       |      |      |                     |
| bbb    | 0.10       |      |      |                     |
| ddd    | 0.05       |      |      |                     |
| eee    | 0.05       |      |      |                     |
| fff    | 0.15       |      |      |                     |

1. DIMENSIONING AND TOLERANCING CONFORMS TO ASME Y14.5-1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS.
3. N IS THE TOTAL NUMBER OF TERMINALS.

**A** DIMENSION "b" APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM TERMINAL TIP. IF THE TERMINAL HAS THE OPTIONAL RADIUS ON THE OTHER END OF THE TERMINAL, THE DIMENSION "b" SHOULD NOT BE MEASURED IN THAT RADIUS AREA.

**B** ND REFER TO THE NUMBER OF TERMINALS ON D OR E SIDE.

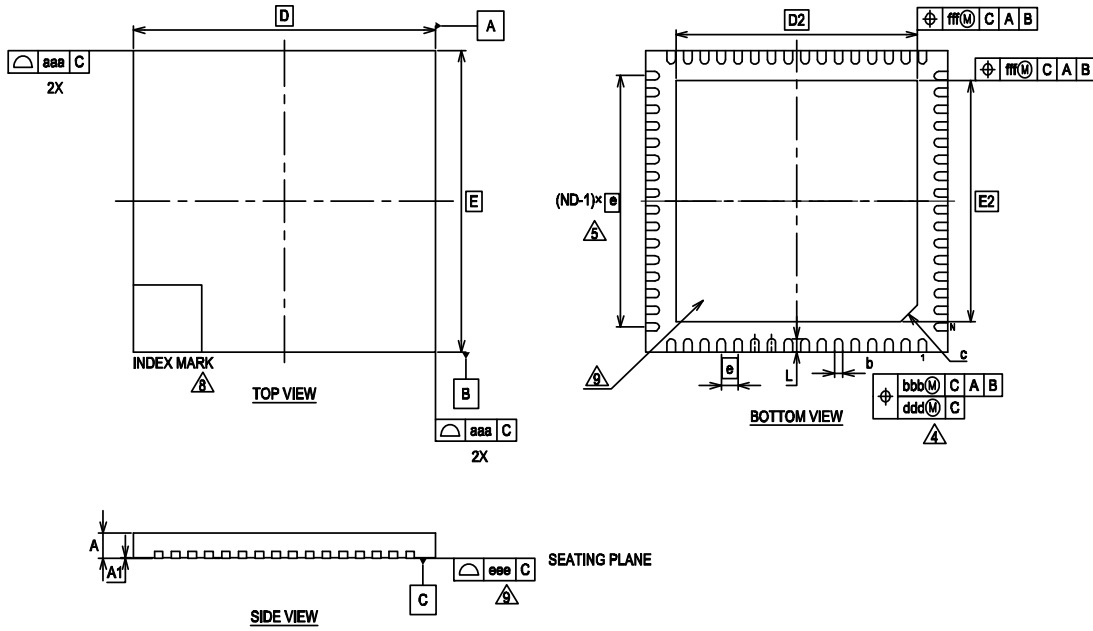
6. MAX. PACKAGE WARPAGE IS 0.05mm.

7. MAXIMUM ALLOWABLE BURRS IS 0.076mm IN ALL DIRECTIONS.

**C** PIN #1 ID ON TOP WILL BE LOCATED WITHIN INDICATED ZONE.

**D** BILATERAL COPLANARITY ZONE APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.

## WNS064 VERY THIN PLASTIC QUAD FLAT NO LEAD PACKAGES



| SYMBOL | MILLIMETER |      |      | NOTE                |
|--------|------------|------|------|---------------------|
|        | MIN.       | NOM. | MAX. |                     |
| A      | —          | —    | 0.80 | PROFILE             |
| A1     | 0.00       | —    | 0.05 | TERMINAL HEIGHT     |
| D      | 9.00 BSC   |      |      | BODY SIZE           |
| E      | 9.00 BSC   |      |      | BODY SIZE           |
| b      | 0.20       | 0.25 | 0.30 | TERMINAL WIDTH      |
| D2     | 7.20 BSC   |      |      | EXPOSED PAD SIZE    |
| E2     | 7.20 BSC   |      |      | EXPOSED PAD SIZE    |
| e      | 0.50 BSC   |      |      | TERMINAL PITCH      |
| c      | 0.50 REF   |      |      | EXPOSED PAD CHAMFER |
| L      | 0.35       | 0.40 | 0.45 | TERMINAL LENGTH     |

|     |      |                |
|-----|------|----------------|
| N   | 64   | TERMINAL COUNT |
| aaa | 0.10 |                |
| bbb | 0.10 |                |
| ddd | 0.05 |                |
| eee | 0.05 |                |
| fff | 0.15 |                |

- DIMENSIONING AND TOLERANCING CONFORMS TO ASME Y14.5-1994.
- ALL DIMENSIONS ARE IN MILLIMETERS.
- N IS THE TOTAL NUMBER OF TERMINALS.
- DIMENSION "b" APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.16 AND 0.30mm FROM TERMINAL TIP. IF THE TERMINAL HAS THE OPTIONAL RADIUS ON THE OTHER END OF THE TERMINAL, THE DIMENSION "b" SHOULD NOT BE MEASURED IN THAT RADIUS AREA.
- ND REFER TO THE NUMBER OF TERMINALS ON D OR E SIDE.
- MAX. PACKAGE WARPAGE IS 0.05mm.
- MAXIMUM ALLOWABLE BURRS IS 0.076mm IN ALL DIRECTIONS.
- PIN #1 ID ON TOP WILL BE LOCATED WITHIN INDICATED ZONE.
- BILATERAL COPLANARITY ZONE APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.

Rev. 0A

## 15. Errata

This chapter describes the errata for S6E1C product family. Details include errata trigger conditions, scope of impact, available workaround, and silicon revision applicability.

Contact your local Cypress Sales Representative if you have questions.

### 15.1 Part Numbers Affected

| Part Number  |
|--|
| S6E1C32D0AGV20000, S6E1C32C0AGV20000, S6E1C32B0AGP20000, S6E1C32D0AGN20000, S6E1C32C0AGN20000, S6E1C32B0AGN20000 |
| S6E1C31D0AGV20000, S6E1C31C0AGV20000, S6E1C31B0AGP20000, S6E1C31D0AGN20000, S6E1C31C0AGN20000, S6E1C31B0AGN20000 |
| S6E1C12D0AGV20000, S6E1C12C0AGV20000, S6E1C12B0AGP20000, S6E1C12D0AGN20000, S6E1C12C0AGN20000, S6E1C12B0AGN20000 |
| S6E1C11D0AGV20000, S6E1C11C0AGV20000, S6E1C11B0AGP20000, S6E1C11D0AGN20000, S6E1C11C0AGN20000, S6E1C11B0AGN20000 |

### 15.2 Qualification Status

Product Status: In Production – Qual.

### 15.3 Errata Summary

This table defines the errata applicability to available devices.

| Items                    | Part Number   | Silicon Revision | Fix Status                        |
|--------------------------|---------------|------------------|-----------------------------------|
| [1] AHB Bus Matrix issue | Refer to 15.1 | Rev B            | Will be fixed in the next silicon |

#### 1. AHB Bus Matrix issue

##### ■ PROBLEM DEFINITION

The AHB Bus Matrix logic has two master interfaces (CPU and DSTC) and four slave interfaces (RAM, FLASH, AHB and APB). When two master interfaces (CPU and DSTC) access the same slave interface at the same time, and when the CPU is in wait cycle, an unnecessary access occurs during the wait cycle and the expected access occurs again after the unnecessary access.

##### ■ PARAMETERS AFFECTED

N/A

##### ■ TRIGGER CONDITION(S)

CPU and DSTC access the same slave interface at the same time.

##### ■ SCOPE OF IMPACT

DSTC cannot be used.

##### ■ WORKAROUND

DSTC must not use.

##### ■ FIX STATUS

This issue will be fixed in the next silicon revision.



## Document History

**Document Title:**

**FM0+ S6E1C Series Microcontroller Datasheet: 40 MHz ARM Cortex-M0+ MCU with 35  $\mu$ A/CoreMark Score**

**Document Number: 002-00233**

| Revision | ECN     | Orig. of Change | Submission Date | Description of Change   |
|----------|---------|-----------------|-----------------|---|
| **       | 4896074 | TEKA            | 08/31/2015      | New Spec.   |
| *A       | 4955136 | TEKA            | 10/9/2015       | AC/DC characteristics updated. Typo fixed in "List of Pin Functions".   |
| *B       | 5158709 | YUKT            | 03/04/2016      | Added the frequency value of "Ta = - 10°C to + 105°C" on "11.4.3 Built-in CR Oscillation Characteristics".<br>Added the remark of "VCC < 0.2V" on "11.4.7 Power-on Reset Timing".<br>Added the measure condition of ICC on "11.3.1 Current Rating".<br>Changed the package outlines to cypress format on "13. Package Dimensions".<br>Changed the package codes to cypress codes on "3. Pin Assignment" and "12. Ordering Information".   |
| *C       | 5220682 | MBGR            | 09/07/2016      | Consolidated the C Series of Cypress MCUs into one data sheet. Minor updates to grammar. Made table footnotes consecutive. Corrected navigational aids (cross reference link colors). Added front matter to data sheet to match Cypress corporate style. Added tables to differentiate parts in <a href="#">2 Product Lineup</a> and <a href="#">2.1 Package Dependent Features</a> . Removed full multiplexed signal names from <a href="#">4 Pin Assignment</a> drawings. Added hyperlinks to <a href="#">5 List of Pin Functions</a> .<br><a href="#">10 Pin Status in Each CPU State</a> : Changed several instances of pullup register to pull up resistor.<br>Expanded <a href="#">12 Ordering Information</a> .<br>Fixed typo in <a href="#">Memory Map</a> . Updated logo. Removed WLCSP information.<br>Updated <a href="#">11.4.7 Power-on Reset Timing</a> .<br>Added <a href="#">15 Errata</a> .<br>Added <a href="#">13 Acronyms</a> . |

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